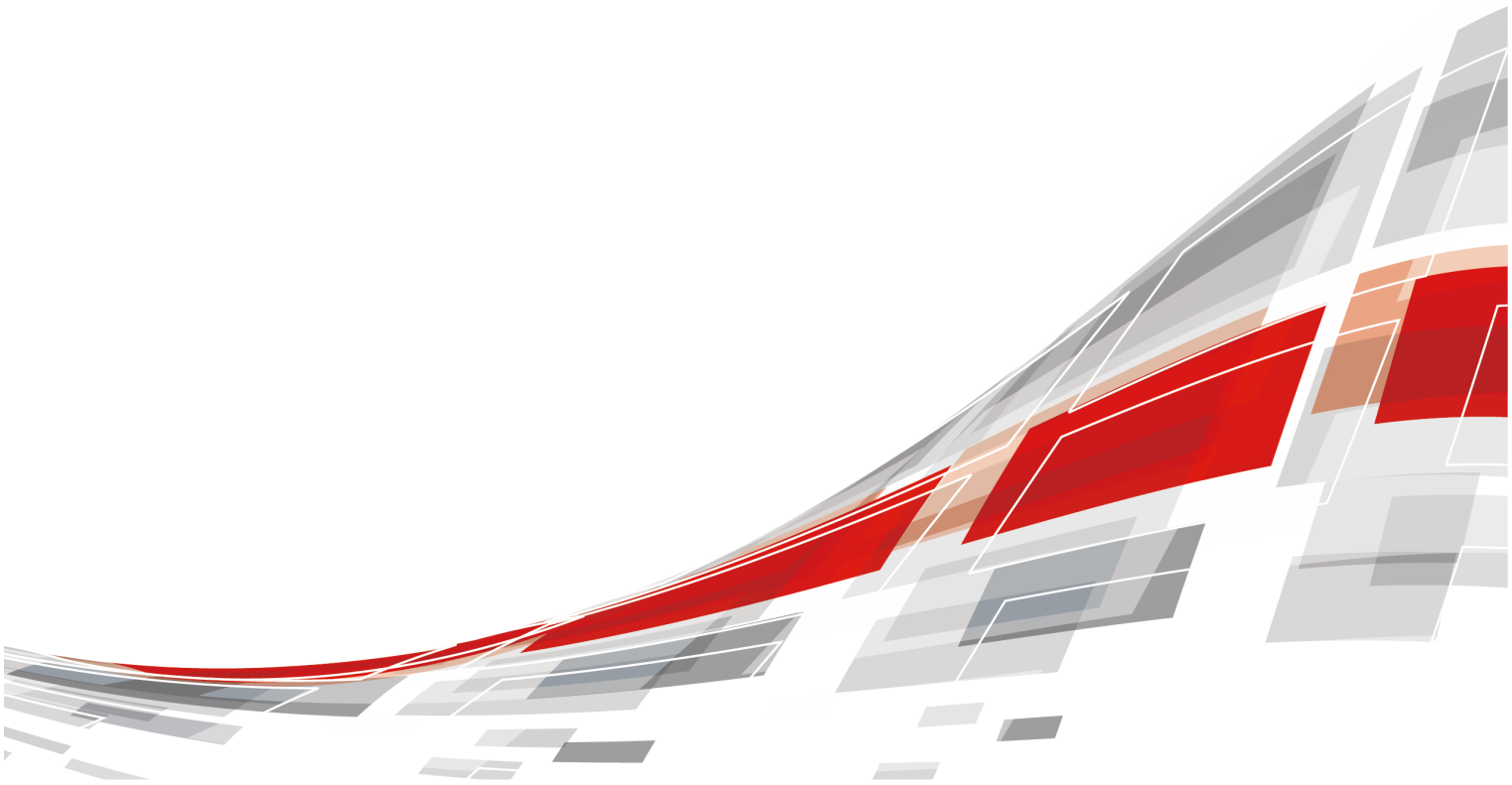
FusionServer 2158H V8 Server

Technical White Paper

Issue	01
Date	2025-05-27



XFUSION INTERNATIONAL PTE. LTD.

Trademarks and Permissions

XFUSION and other xFusion trademarks are trademarks of XFUSION INTERNATIONAL PTE. LTD. All other trademarks and trade names mentioned in this document are the property of their respective holders.

Notice

The purchased products, services and features are stipulated by the contract made between xFusion and the customer. All or part of the products, services and features described in this document may not be within the purchase scope or the usage scope. Unless otherwise specified in the contract, all statements, information, and recommendations in this document are provided "AS IS" without warranties, guarantees or representations of any kind, either express or implied.

The information in this document is subject to change without notice. Every effort has been made in the preparation of this document to ensure accuracy of the contents, but all statements, information, and recommendations in this document do not constitute a warranty of any kind, express or implied.

XFUSION INTERNATIONAL PTE. LTD.

Website: https://www.xfusion.com

About This Document

Purpose

This document describes the appearance, features, performance parameters, and hardware and software compatibility of the server, so that users can have an in-depth and detailed understanding of it.

Intended Audience

This document is intended for pre-sales engineers.

Symbolic Conventions

The symbols that may be found in this document are defined as follows:

Symbol	Description
DANGER	Indicates a hazard with a high level of risk which, if not avoided, could result in death or serious injury.
WARNING	Indicates a hazard with a medium risk which, if not avoided, could result in death or serious injury.
CAUTION	Indicates a low-level hazard which, if not avoided, could result in minor or moderate injury.
NOTICE	Indicates a potentially hazardous situation which, if not avoided, could result in device damage, data loss, device performance degradation, or other unpredictable results. NOTICE is used to address practices not related to personal injury.
NOTE	Supplements the important information in the main text. NOTE is used to address information not related to personal injury, equipment damage, and environment deterioration.

Change History

Issue	Release Date	Change Description
01	2025-05-27	This issue is the first official release.

Contents

1 Overview

FusionServer 2158H V8 (2158H V8 for short) is a new-generation 2U 1-socket rack server designed for the Internet, Internet Data Center (IDC), cloud computing, enterprise business, and telecom.

This product is ideal for IT core services, cloud computing, virtualization, high-performance computing, distributed storage, big data processing, enterprise or telecom applications, and other complex workloads.

This product features low power consumption, high scalability, high reliability, and easy management and deployment.

NOTE

- For details about the 2158H V8 nameplate, see **A.4 Nameplate**.
- The server adapter supports two generations of processors, Genoa and Turin. There are differences in the Software (BIOS/VRD firmware), so they cannot be shared. Model management distinguishes between the 2158H V8-Genoa and the 2158H V8-Turin, matching the corresponding processors, and they cannot be used interchangeably.

Figure 1-1 Server appearance (example: 12 x 3.5" drives)

2 Features

Performance

- Genoa:
  - The server supports the 4th generation of AMD EPYC™9004 series processors (Genoa).
  - A processor provides up to 128 cores and 256 threads, up to 400 W TDP, a maximum of 4.4 GHz turbo frequency, 1 MB L2 cache per core, 32 MB L3 cache (shared by eight cores), which deliver supreme processing performance.
  - Accommodates a maximum of 12 x DDR5 5600 MT/s registered dual-inline memory modules (RDIMMs), delivering up to 1152 GB total memory capacity (calculated using the maximum capacity of a single memory module: 96 GB). The memory modules feature high speed and availability.
- Turin:
  - The server supports the 5th generation of AMD EPYC™9005 series processors (Turin).
  - A processor provides up to 192 cores and 384 threads, up to 500 W TDP, a maximum of 5 GHz turbo frequency, 1 MB L2 cache per core, and 32 MB L3 cache shared among 8 cores, which deliver supreme processing performance.
  - Accommodates a maximum of 12 x DDR5 6400 MT/s registered dual-inline memory modules (RDIMMs), which deliver up to 1.5 TB total memory capacity (calculated based on a maximum of 128 GB capacity per DDR5 memory module). The memory modules feature high speed and availability.

Scalability

- Flexible drive configurations cater to a variety of business requirements and ensure high elasticity and scalability of storage resources.
- Supports a maximum of 24 x 2.5" front drives.
- Supports a maximum of 16 x 2.5" NVMe U.2 drives, improving storage density and I/O performance.
- Supports a maximum of ten standard PCIe x16 slots, four of which supports PCIe 5.0.

- Supports two FLEX I/O cards (adaptive to OCP 3.0 NIC) and GE/10GE/25GE NICs.
- Supports two M.2 SSDs, enabling quick start of OS drives and improving maintenance flexibility.

Availability and Serviceability

- Carrier-class components with process expertise ensure high system reliability and availability.
- The server uses hot-swappable SAS/SATA drives. SAS/SATA drives support RAID 0, 1, 1E, 10, 5, 50, 6, and 60, depending on the RAID controller card used. It also uses a supercapacitor to protect the RAID cache data against power failures.
- The panel provides a UID/Healthy LED indicator and a fault diagnosis LED, enabling technical personnel to quickly locate components that have failed or are at risk of failure, thereby simplifying maintenance tasks, accelerating problem resolution, and enhancing system availability.
- The mounting ear provides the iBMC direct connect management port to support local iBMC O&M, improving O&M efficiency.
- A server provides two hot-swappable PSUs in 1+1 redundancy mode and four or six hot-swappable fan modules in *N*+1 redundancy mode, improving system availability.
- The intelligent Baseboard Management Controller (iBMC) can continuously monitor system parameters, trigger alarms, and take recovery measures to minimize shutdown.

Manageability and Security

- The built-in iBMC monitors server operating status and provides remote management.
- Supports BIOS menu passwords to ensure the security of system startup and system management.
- Supports the Network Controller Sideband Interface (NC-SI) feature that allows a network port to provide functions of both a management network port and a service network port. The NC-SI feature can be enabled or disabled through the iBMC or BIOS. The NC-SI feature is disabled by default.

  NOTE

  The service network port of the NC-SI feature supports the following configurations:

  - It can be bound to any network port of the server's OCP 3.0 NIC or other standard PCIe NICs that support the NC-SI function.
  - It allows users to enable or disable the virtual local area network ID (VLAN ID) and configure the VLAN ID. The VLAN ID is **0** and disabled by default.
  - It supports IPv4 and IPv6 addresses, and allows users to configure the IP address, subnet mask, default gateway, or prefix length of an IPv6 address.
- The integrated Unified Extensible Firmware Interface (UEFI) improves setup, configuration, and update efficiency and simplifies fault clearance.
- Supports the lockable server front bezel to ensure local data security.
- Supports chassis cover opening detection to enhance physical security.

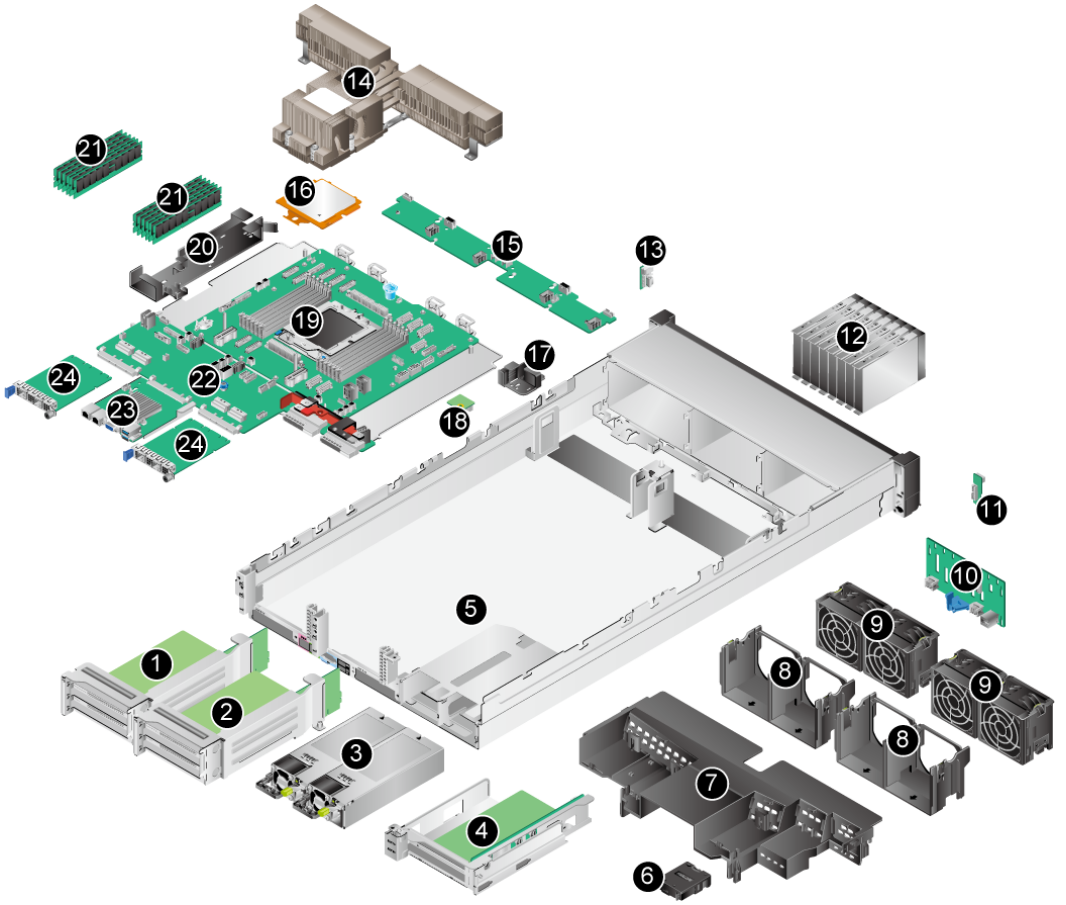
- Supports secure boot based on the chip-level Root of Trust (RoT) and provides the level-by-level verification function starting from the hardware trusted root, building a complete secure boot chain.
- Supports the trusted platform module (TPM) and trusted password module (TCM) to provide advanced encryption functions, such as digital signature and remote authentication.
- Meets the following requirements in NIST SP 800-147B:
  – The BIOS firmware digital signature update mechanism is supported. During the upgrade, the digital signature is verified to prevent unauthorized BIOS firmware upgrade.
  – The flash security protection mechanism is supported to prevent unauthorized modification of the flash in the OS.

Energy Efficiency

- Provides 80 Plus Platinum/Titanium PSUs with different energy efficiency levels. The efficiency of the PSUs reaches 96% when the load is 50%.
- Supports active/standby power supply and high-voltage DC power supply to improve the efficiency of the power supply system.
- Efficient Voltage Regulator Down (VRD) power supplies for boards minimize the energy loss from DC power conversion.
- Area-based Proportional-Integral-Derivative (PID) intelligent fan speed adjustment and intelligent CPU frequency scaling optimize heat dissipation and reduce overall system power consumption.
- The improved thermal design with energy-efficient fans ensures optimal heat dissipation and reduces system power consumption.
- The server is protected with power capping and power control measures.
- Staggered spinup of drives reduces the server boot power consumption.

3 Physical Structure

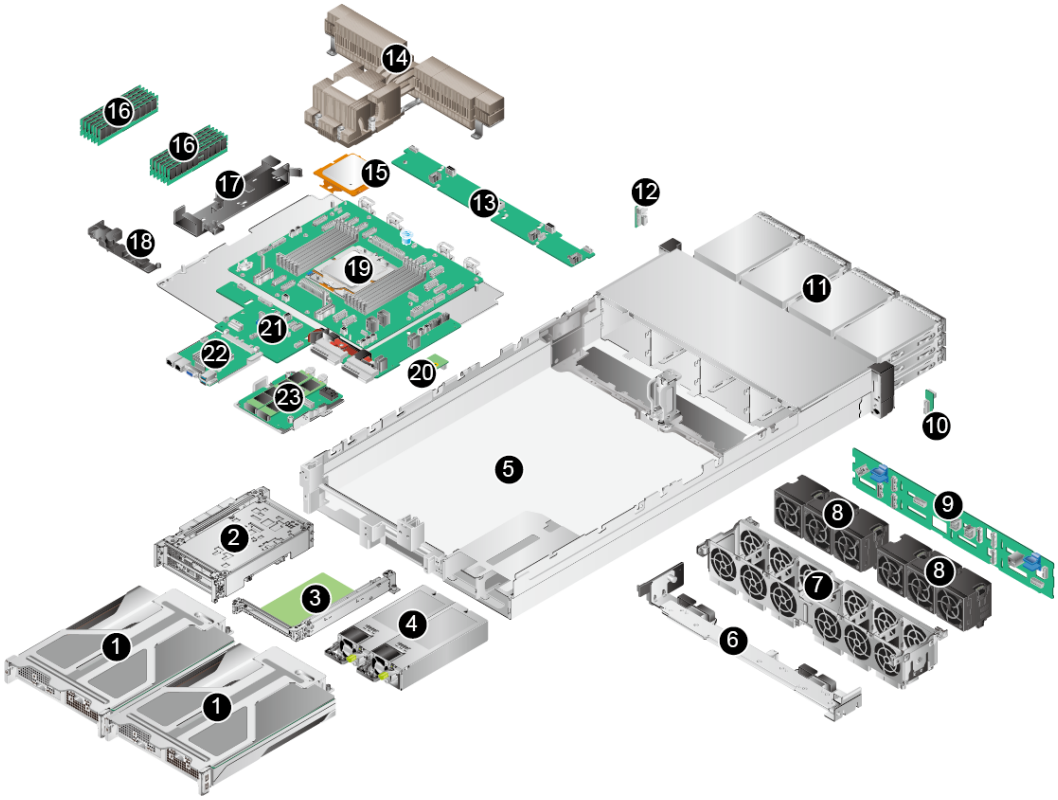
Figure 3-1 Physical structure of general-purpose server model



1	I/O module 1	2	I/O module 2
3	PSUs	4	I/O module 3
5	Chassis	6	Supercapacitor holder
7	Air duct	8	Fan module bracket

9	Fan module	10	Front-Drive backplane
11	Left mounting ear plate	12	Front drive
13	Right mounting ear plate	14	Processor heat sink
15	Fan Board	16	Processor
17	Cable management arm	18	TPM/TCM
19	Mainboard	20	Cable management arm
21	Memory	22	I/O expansion board
23	BMC card	24	OCP 3.0 NIC

Figure 3-2 Physical structure of the 4-GPU model

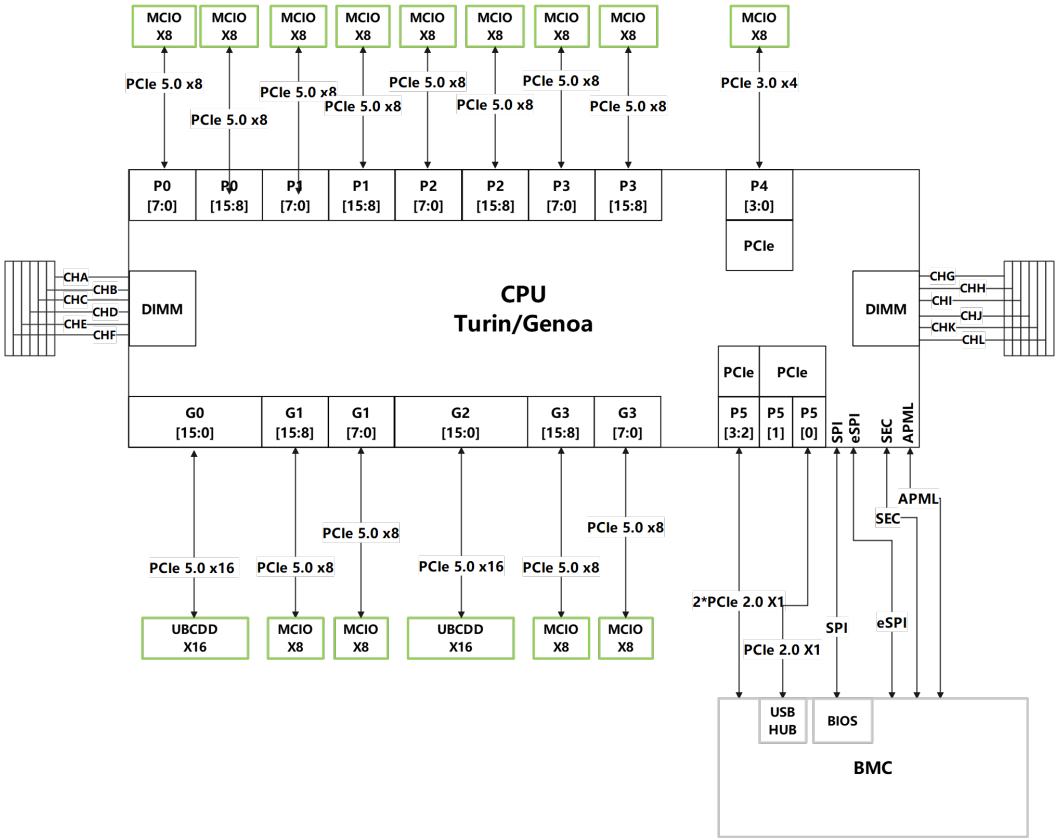


1	GPU module	2	I/O module 1
3	I/O module 2	4	PSUs
5	Chassis	6	GPU beam
7	Fan module bracket	8	Fan module
9	Front-Drive backplane	10	Left mounting ear plate
11	Front drive	12	Right mounting ear plate

13	Fan Board	14	Processor heat sink
15	Processor	16	Memory
17	Cable management arm	18	Cable management arm
19	Mainboard	20	TPM/TCM
21	I/O expansion board	22	BMC card
23	M.2 SSD	-	-

4 Logic Structure

Figure 4-1 Logic structure



- The server supports either one 4th generation AMD EPYC™ processor (Genoa) or one 5th generation AMD EPYC™ processor (Turin). It supports 12 DDR5 DIMMs.
- The PCIe bus resources of the processor are connected to the PCIe riser card through PCBs or cables. Different PCIe riser cards support PCIe slots of different specifications. The general model supports two OCP 3.0 NICs.

  NOTE

  OCP 3.0 network adapters are not supported on the 4GPU models yet.

- The BMC card integrates the BMC management chip and provides external video graphic array (VGA), management network port, and serial port.

5 Hardware Description

NOTE

For details about the optional components, consult the local sales representative or see "Search Parts" in the compatibility list on the technical support website.

5.1 Front Panel

5.1.1 Appearance

- 8 x 2.5" drive configuration

Figure 5-1 Front panel

1	Drive	2	Slide-out label plate (with an SN label)

- 8 x 3.5" drive configuration

Figure 5-2 Front panel of a general-purpose server

1	Drive	2	Slide-out label plate (with an SN label)

Figure 5-3 Front panel of a server with four GPUs

1	Drive	2	Slide-out label plate (with an SN label)

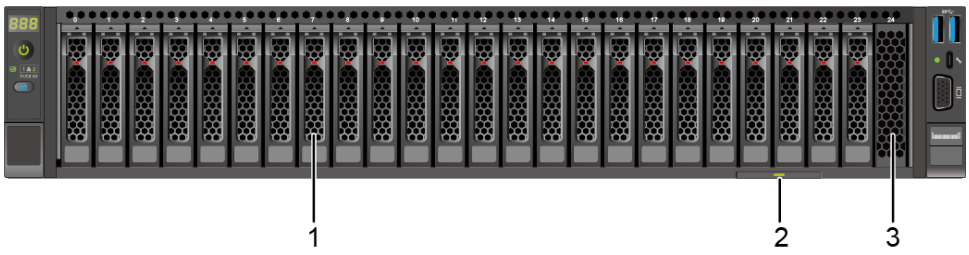
- 12 x 3.5" drive configuration

Figure 5-4 Front panel

1	Drive	2	Slide-out label plate (with an SN label)

- 24 x 2.5" drive configuration

Figure 5-5 Front panel



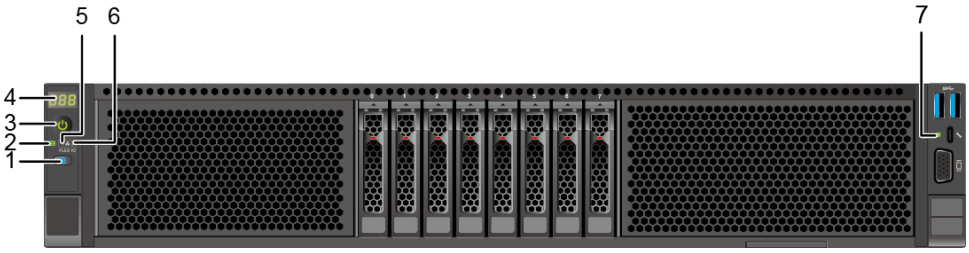
1	Drive	2	Slide-out label plate (with an SN label)
3	Drive slot filler panel **NOTE** Drives cannot be installed in the slot.	-	-

5.1.2 Indicators and Buttons

Indicator and Button Positions

- 8 x 2.5" drive configuration

Figure 5-6 Indicators and buttons on the front panel



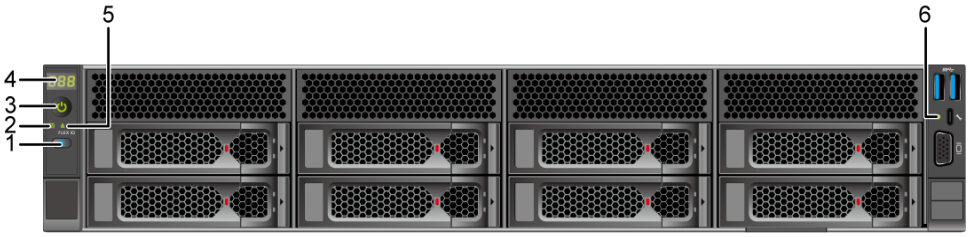
1	UID button/indicator	2	Health status indicator
3	Power button/indicator	4	Fault diagnosis LED
5	FlexIO card 1 presence indicator	6	FlexIO card 2 presence indicator
7	iBMC direct connect management port indicator	-	-

- 8 x 3.5" drive configuration

Figure 5-7 Indicators and buttons on the front panel of the general-purpose servers

1	UID button/indicator	2	Health status indicator
3	Power button/indicator	4	Fault diagnosis LED
5	FlexIO card 1 presence indicator	6	FlexIO card 2 presence indicator
7	iBMC direct connect management port indicator	-	-

Figure 5-8 Indicators and buttons on the front panel of the 4-GPU model



1	UID button/indicator	2	Health status indicator
3	Power button/indicator	4	Fault diagnosis LED
5	FlexIO card presence indicator **NOTE** Reserved design, unavailable currently.	6	iBMC direct connect management port indicator

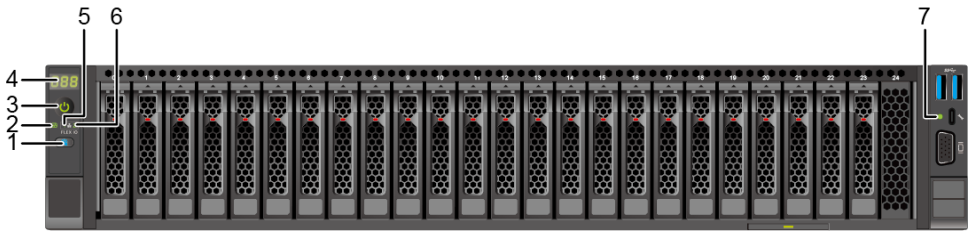
- 12 x 3.5" drive configuration

Figure 5-9 Indicators and buttons on the front panel

1	UID button/indicator	2	Health status indicator
3	Power button/indicator	4	Fault diagnosis LED
5	FlexIO card 1 presence indicator	6	FlexIO card 2 presence indicator
7	iBMC direct connect management port indicator	-	-

- 24 x 2.5" drive configuration

Figure 5-10 Indicators and buttons on the front panel



1	UID button/indicator	2	Health status indicator
3	Power button/indicator	4	Fault diagnosis LED
5	FlexIO card 1 presence indicator	6	FlexIO card 2 presence indicator
7	iBMC direct connect management port indicator	-	-

Indicator and Button Description

Table 5-1 Indicators and buttons on the front panel

Sign	Indicators and Buttons	Description
888	Fault diagnosis LED	• ---: The device is operating properly. • Error code: A component is faulty. **NOTE** If multiple error codes are generated at the same time, the error codes are displayed in a loop. Each error code is displayed for 5 seconds. For details about fault codes, see the *iBMC Alarm Handling*.

Sign	Indicators and Buttons	Description
	Health status indicator	● Off: The device is powered off or faulty. ● Blinking red at 1 Hz: A major alarm has been generated on the system. ● Blinking red at 5 Hz: A critical alarm has been generated on the system. ● Steady green: The device is operating properly.
	FlexIO card presence indicator	Indicates whether the FlexIO card is detected. ● Off: The FlexIO card is not detected. ● Blinking green at 0.5 Hz: The FlexIO card is detected but is not powered on. ● Blinking green at 2 Hz: The FlexIO card is detected and has just been inserted. ● Steady green: The FlexIO card is detected and the power supply is normal.
	Power button/ indicator	Power indicator: ● Off: The device is powered off. ● Steady green: The device is powered on. ● Blinking yellow: The iBMC is starting. The power button is locked and cannot be pressed. The iBMC is started in about 1 minute, and then the power indicator turns steady yellow. ● Steady yellow: The device is in the standby state. Power button: ● When the device is powered on, you can press this button to gracefully shut down the OS. **NOTE** For different OSs, you may need to shut down the OS as prompted. ● When the device is powered on, you can hold down this button for 6 seconds to forcibly power off the device. ● When the power indicator is steady yellow, you can press this button to power on the device.

Sign	Indicators and Buttons	Description
	UID button/ indicator	The UID button/indicator helps identify and locate a device. UID indicator: ● Off: The device is not being located. ● Blinking or steady blue: The device is being located. UID button: ● You can control the UID indicator status by pressing the UID button or using the iBMC. ● You can press this button to turn on or off the UID indicator. ● You can press and hold down this button for 4 to 6 seconds to reset the iBMC.
	iBMC direct connect management port indicator	Indicates the status when the iBMC direct connect management port connects to a terminal (local PC or Android mobile phone): ● Off: No terminal is connected. ● Blinking green at short intervals for 3 seconds and then off: The port is disabled. ● Steady green: The terminal is connected. Indicates the status when the iBMC direct connect management port connects to a USB device: ● Blinking red at long intervals: The job fails or an error is reported when the job is complete. ● Blinking green at short intervals: The job is being executed. ● Blinking green at short intervals for 3 seconds and then off: The port is disabled. ● Steady green: The server configuration file is being copied from the USB device or the job is successfully completed.

5.1.3 Ports

Port Positions

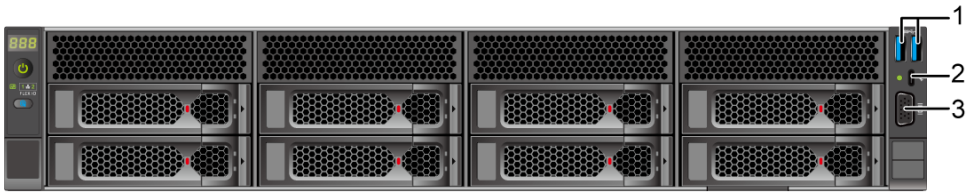
- 8 x 2.5" drive configuration

Figure 5-11 Ports on the front panel

1	USB 3.0 port	2	iBMC direct connect management port
3	VGA port	-	-

- 8 x 3.5" drive configuration

Figure 5-12 Ports on the front panel of the general model



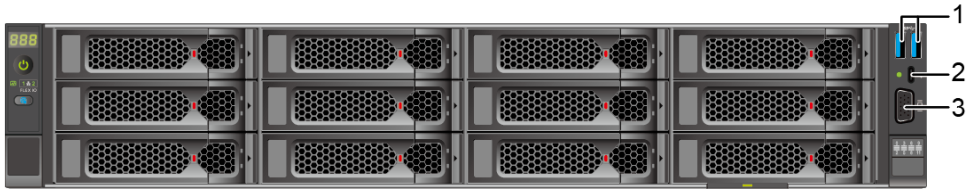
1	USB 3.0 port	2	iBMC direct connect management port
3	VGA port	-	-

Figure 5-13 Ports on the front panel of the 4-GPU model

1	USB 3.0 port	2	iBMC direct connect management port
3	VGA port	-	-

- 12 x 3.5" drive configuration

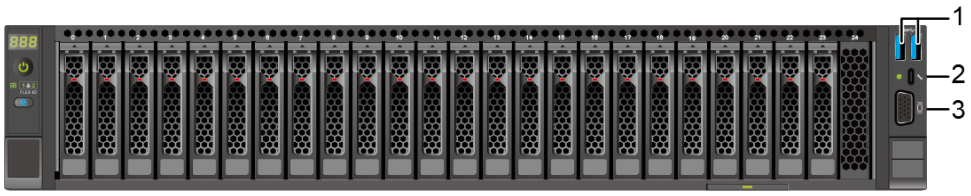
Figure 5-14 Ports on the front panel



1	USB 3.0 port	2	iBMC direct connect management port
3	VGA port	-	-

- 24 x 2.5" drive configuration

Figure 5-15 Ports on the front panel



1	USB 3.0 port	2	iBMC direct connect management port
3	VGA port	-	-

Port Description

Table 5-2 Ports on the front panel

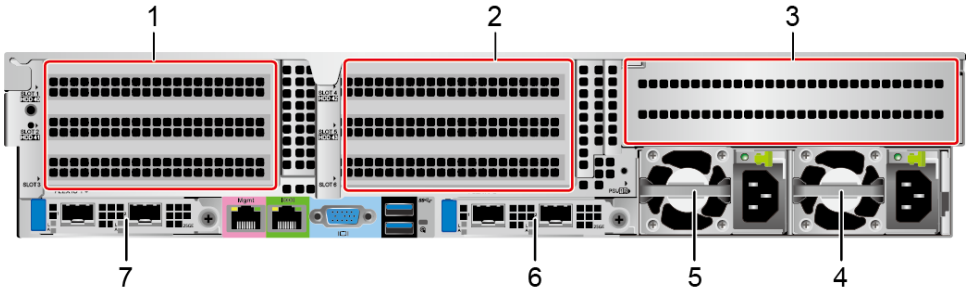
Name	Type	Quantity	Description
iBMC direct connect management port	USB Type-C **NOTE** The USB 2.0 protocol is supported.	1	Used to connect to a local PC or mobile phone using a USB Type-C cable to monitor and manage the system. **NOTE** Only local PCs running Windows 10 and mobile phones running Android are supported. ● To log in to the iBMC from a local PC, enter **https:**//*IP address of the iBMC management network port* in the address box of the browser on the local PC. Used to connect to a USB device. **NOTICE** ● Before connecting an external USB device, ensure that the USB device functions properly; otherwise, it may adversely impact the server. ● For details about how to connect a USB device to the iBMC direct connect management port, see the *iBMC User Guide*.
USB port	USB 3.0	1	Used to connect to a USB 3.0 device. **NOTICE** ● Before connecting an external USB device, ensure that the USB device functions properly; otherwise, it may adversely impact the server. ● The USB 3.0 port can be used to supply power to low-power peripherals. However, the USB 3.0 port must comply with the USB specifications. To run advanced peripherals, such as external CD/DVD drives, an external power supply is required.

5.2 Rear Panel

5.2.1 Appearance

- Server with drive modules or PCIe riser modules on the rear panel

Figure 5-16 Rear panel



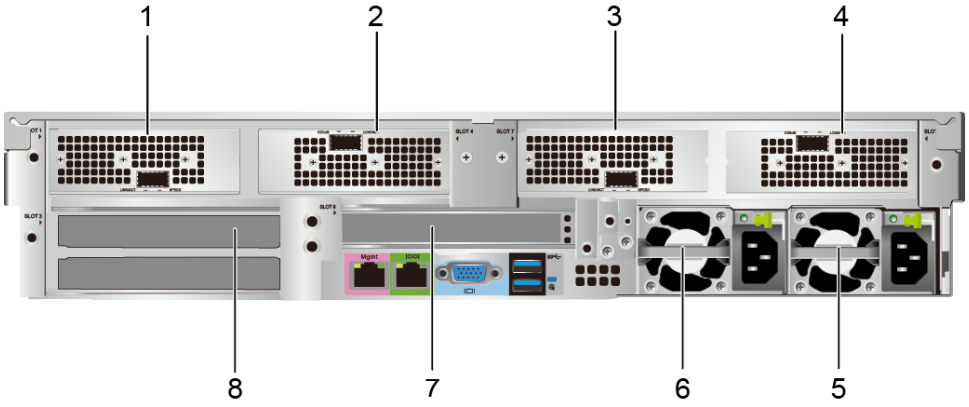
1	I/O module 1	2	I/O module 2
3	I/O module 3	4	PSU 2
5	PSU 1	6	(Optional) FlexIO card 2 **NOTE** The FlexIO card slot supports only OCP 3.0 NICs.
7	(Optional) FlexIO card 1 **NOTE** The FlexIO card slot supports only OCP 3.0 NICs.	-	-

NOTE

- I/O module 1 can be a PCIe riser module, or 2 x 2.5" rear drives and one PCIe riser module.
- I/O module 2 can only be a PCIe riser module.
- I/O module 3 can be a PCIe riser module or a 4 x 2.5" rear-drive module.
- For details about the OCP 3.0 NIC, see **5.6.1 OCP 3.0 NICs**.
- The figure is for reference only. The actual configuration may vary.

- 4-GPU model

Figure 5-17 Rear panel



1	Slot 1	2	Slot 4
3	Slot 7	4	Slot 9
5	PSU 2	6	PSU 1
7	Slot 6	8	Slot 3

NOTE

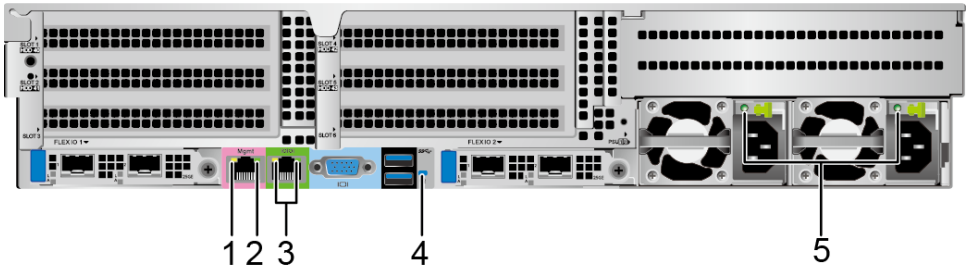
The figure is for reference only. The actual configuration may vary.

5.2.2 Indicators and Buttons

Indicator Positions

- Server with drive modules or PCIe riser modules on the rear panel

Figure 5-18 Indicators on the rear panel

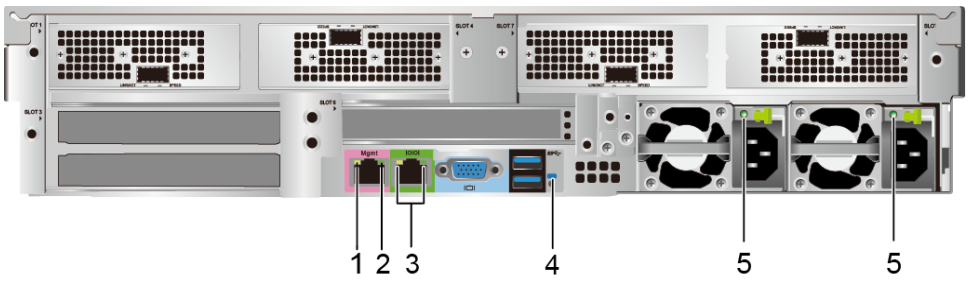


1	Data transmission status indicator of the management network port	2	Connection status indicator of the management network port

3	Serial port indicator **NOTE** Reserved and unavailable currently.	4	UID indicator
5	PSU indicators	-	-

- 4-GPU model

Figure 5-19 Indicators on the rear panel



1	Data transmission status indicator of the management network port	2	Connection status indicator of the management network port
3	Serial port indicator **NOTE** Reserved and unavailable currently.	4	UID indicator
5	PSU indicator	-	-

Indicator Description

Table 5-3 Indicators on the rear panel

Sign	Indicator	Description
-	Data transmission status indicator of the management network port	• Off: No data is being transmitted. • Blinking yellow: Data is being transmitted.
-	Connection status indicator of the management network port	• Off: The network is not connected. • Steady green: The network port is properly connected.

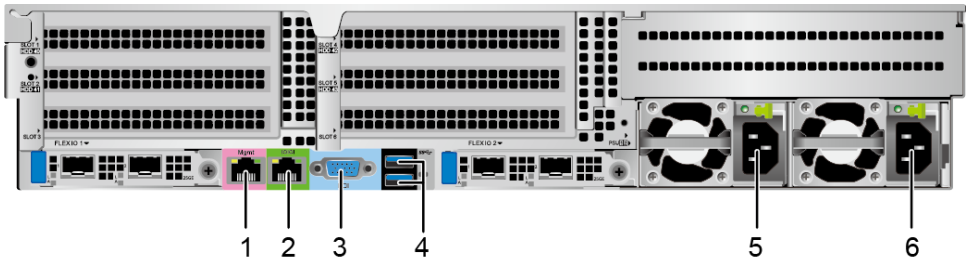
Sign	Indicator	Description
-	PSU indicator	● Off: No power is supplied. ● Blinking green at 1 Hz: – The input is normal and the power supply enters SV12 mode. – The input is overvoltage or undervoltage. – The PSU is in deep hibernation mode. ● Blinking green at 4 Hz: The firmware is being upgraded online. ● Steady green: The input and output are normal. ● Steady orange: The input is normal but there is no output. **NOTE** The possible causes of no output are as follows: ● Power supply overtemperature protection ● Power output overcurrent or short-circuit ● Output overvoltage ● Short-circuit protection ● Device failure (excluding failure of all devices)
	UID indicator	The UID indicator helps identify and locate a device. ● Off: The device is not being located. ● Blinking or steady blue: The device is being located. **NOTE** You can control the UID indicator status by pressing the UID button or using the iBMC.

5.2.3 Ports

Port Positions

- Server with drive modules or PCIe riser modules on the rear panel

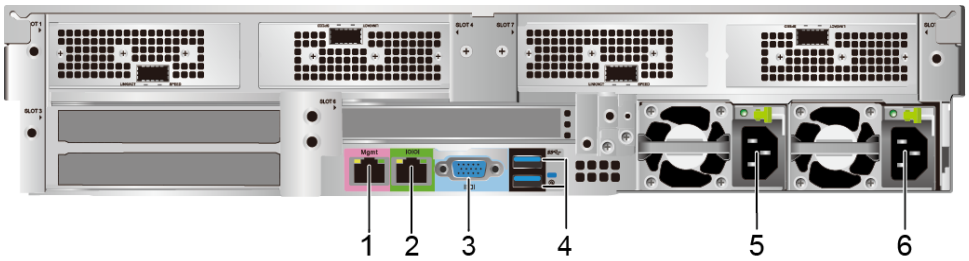
Figure 5-20 Ports on the rear panel



1	Management network port	2	Serial port
3	VGA port	4	USB 3.0 port
5	Socket for PSU 1	6	Socket for PSU 2

- 4-GPU model

Figure 5-21 Ports on the rear panel



1	Management network port	2	Serial port
3	VGA port	4	USB 3.0 port
5	Socket for PSU 1	6	Socket for PSU 2

Port Description

Table 5-4 Ports on the rear panel

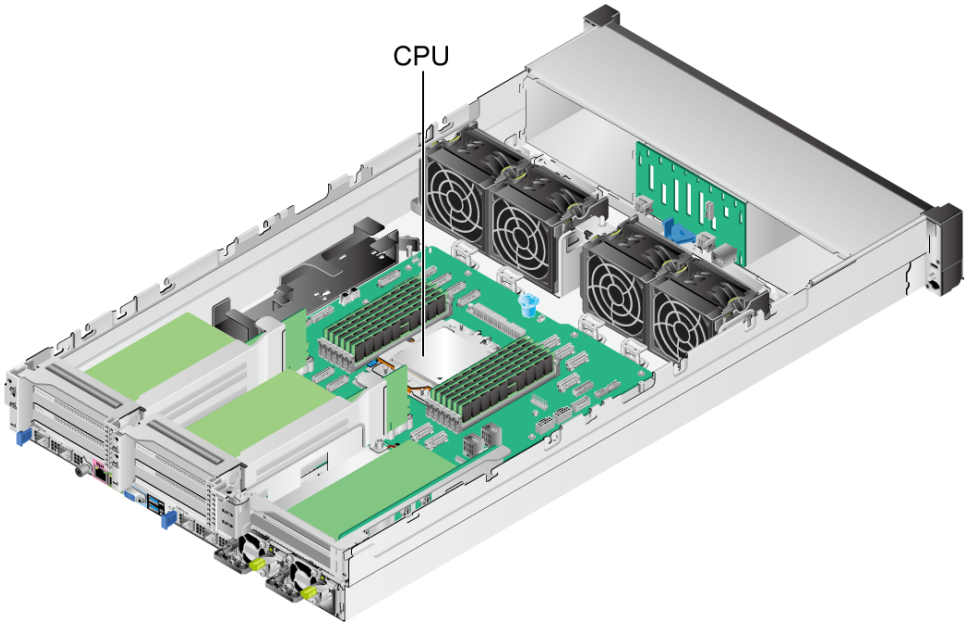
Name	Type	Quantity	Description
Management network port	RJ45	1	iBMC management network port, which is used to manage the server. **NOTE** ● The management network port is a GE port that supports 100 Mbit/s and 1000 Mbit/s auto-negotiation. ● The iBMC management network port cannot be connected to a PoE-powered device (such as a PoE switch with the PoE function enabled). Forcible interconnection may cause link communication problems or damage to the management network port.
Serial port	RJ45	1	A port used for debugging. By default, it serves as the OS serial port. You can also set it as the iBMC serial port on the iBMC CLI. **NOTE** The port is a 3-wire serial communication port, and its default baud rate is 115,200 bit/s.
VGA port	DB15	1	Used to connect a display terminal, such as a monitor or KVM.

Name	Type	Quantity	Description
USB port	USB 3.0	2	Used to connect to a USB 3.0 device. **NOTICE** ● The maximum current is 1.3 A for an external USB device. ● Before connecting an external USB device, ensure that the USB device functions properly; otherwise, it may adversely impact the server. ● The USB 3.0 port can be used to supply power to low-power peripherals. However, the USB 3.0 port must comply with the USB specifications. To run advanced peripherals, such as external CD/DVD drives, an external power supply is required.
PSU socket	-	2	Used to connect to a power distribution unit (PDU) through a power cable. You can select the PSUs as required. **NOTE** When determining the PSUs, ensure that the rated power of the PSUs is greater than that of the server.

5.3 Processors

Only a single Genoa processor or a single Turin processor configuration is supported.

Figure 5-22 Positions of the processors



NOTE

The server adapter supports two generations of processors, Genoa and Turin. There are differences in the software (BIOS/VRD firmware), so they cannot be shared. Model management distinguishes between the 2158H V8-Genoa and the 2158H V8-Turin, matching the corresponding processors, and they cannot be used interchangeably.

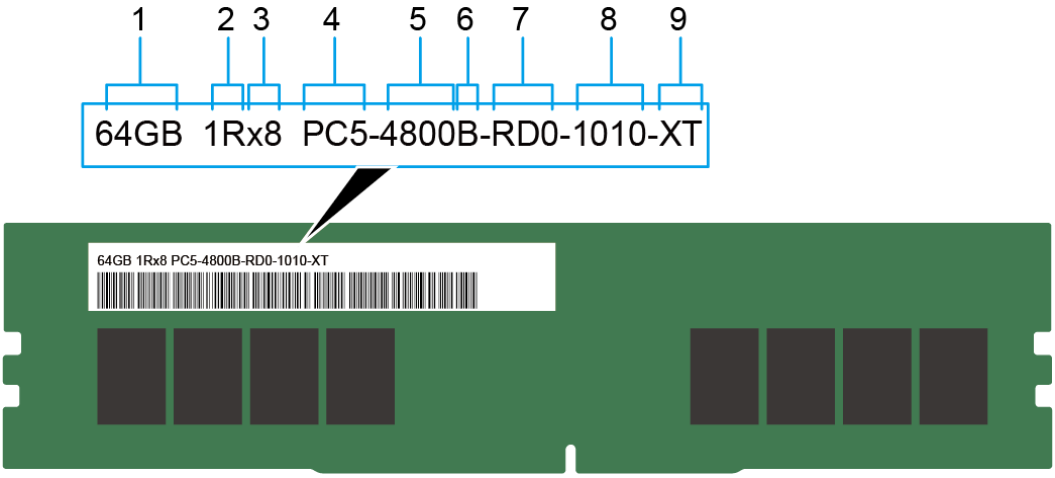
5.4 Memory

5.4.1 DDR5 Memory

5.4.1.1 Memory Identifier

You can determine the memory module properties based on the label attached to the memory module and the following figures and tables.

Figure 5-23 Memory identifier



No.	Description	Example
1	Capacity	• 32 GB • 64 GB
2	rank(s)	• 1R = Single rank • 2R = Dual rank
3	Data width on the DRAM	• x4: 4-bit • x8: 8-bit
4	Type of the memory interface	• PC5 = DDR5
5	Maximum memory speed	• 6400 MT/s
6	Memory Delay Parameter (CL-nRCD-nRP)	• A = 34-34-34 • B = 40-40-40 • C = 42-42-42
7	DIMM type	• RD0: Reference design for version RDIMM D0
8	SPD Version	• 10: SPD version • 10: SPD versions from Byte 192 to Byte 447
9	Temperature class	• Extended temperature grade (XT): 0°C to 95°C (32°F to 203°F) • Normal temperature grade (NT): 0°C to 85°C (32°F to 185°F)

5.4.1.2 Memory Subsystem Architecture

The server provides 12 memory interfaces. Each processor integrates 12 memory channels.

Install the memory modules in the primary memory channels first. If the primary memory channel is not populated, the memory modules in secondary memory channels cannot be used.

Table 5-5 Memory channels

CPU	Channel	Memory Slot
CPU	DIMMA0	DIMM000(A0)
	DIMMB0	DIMM010(B0)
	DIMMC0	DIMM020(C0)
	DIMMD0	DIMM030(D0)
	DIMME0	DIMM040(E0)
	DIMMF0	DIMM050(F0)
	DIMMG0	DIMM060(G0)
	DIMMH0	DIMM070(H0)
	DIMMI0	DIMM080(I0)
	DIMMJ0	DIMM090(J0)
	DIMMK0	DIMM0A0(K0)
	DIMML0	DIMM0B0(L0)

5.4.1.3 Memory Compatibility

Observe the following rules when configuring DDR5 memory modules:

NOTICE

- A server must use DDR5 memory modules of the same part number (P/N code), and the memory speed is the lower one of the following two speed values:
  - Memory speed supported by a CPU
  - Maximum operating speed of a memory module
- The DDR5 memory modules of different types (RDIMM and RDIMM-3DS) and specifications (capacity, bit width, rank, and height) cannot be used together.
- For details about the optional components, consult the local sales representative or see "Search Parts" in the compatibility list on the technical support website.

- The server supports 4th generation AMD EPYC™ Genoa processors or all series Turin processors. All CPU models support the same maximum memory capacity.
- The calculation formula of total memory capacity supported is as follows: the total memory capacity equals the capacity sum of all DDR5 memory modules.
- The maximum number of memory modules supported depends on the memory module type and number of ranks.

Table 5-6 DDR5 memory parameters

Parameter		Specifications					
Capacity of a DDR5 memory (GB)		32	64	96	128	64	96
Processor type		Turin	Turin	Turin	Turin	Genoa	Genoa
Type		RDIMM	RDIMM	RDIMM	RDIMM	RDIMM	RDIMM
Rated speed (MT/s)		6400	6400	6400	6400	5600	5600
Operating voltage (V)		1.1	1.1	1.1	1.1	1.1	1.1
Maximum number of DDR5 DIMMs of a server		12	12	12	12	12	12
Maximum DDR5 memory capacity of the server (GB)		384	768	1152	1536	768	1152
Actual rate (MT/s)	1DPC[a]	6400	6400	6400	6400	4800	4800

- a: DIMM per channel (DPC) indicates the number of memory modules per channel.
- The information listed in this table is for reference only. For details, consult the local sales representatives.

5.4.1.4 DIMM Installation Rules

Observe the following rules when configuring DDR5 memory modules:

- At least one DDR5 memory module must be configured.
- The memory modules configured must be DDR5 RDIMMs.
- The memory modules must be configured with the same number of ranks.
- Install filler memory modules in vacant slots.

5.4.1.5 Positions of the Memory Modules

A server supports up to 12 DDR5 memory modules.

Observe the memory module installation rules when configuring memory modules. For details, see the memory configuration guide on the technical support website.

Figure 5-24 Positions of the memory modules

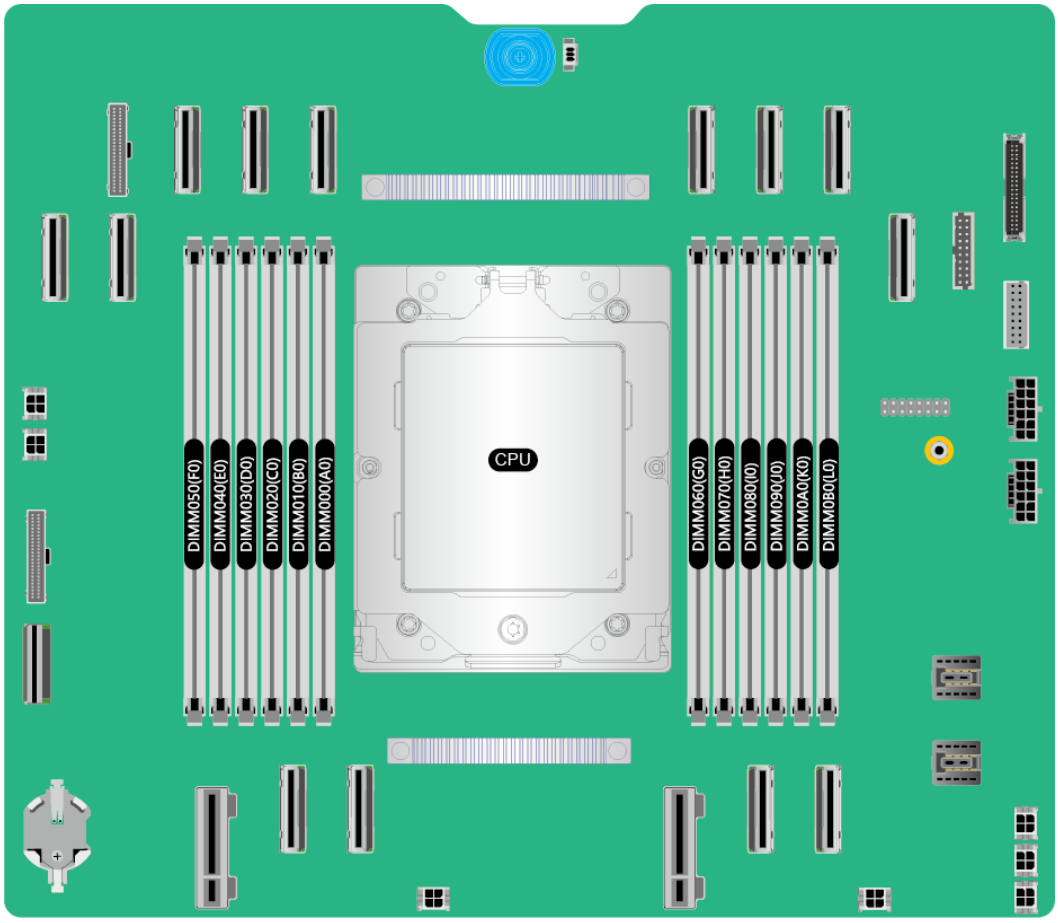


Table 5-7 DDR5 memory modules installation guidelines

Processor	Channel	DIMM Slot	Number of Memory Modules						
			1	2	4	6	8	10	12
CPU	DIMMA0	DIMM000(A0)	●	●	●	●	●	●	●

	DIMMB0	DIMM010 (B0)	X	X	X	●	●	●	●
	DIMMC0	DIMM020(C0)	X	X	●	●	●	●	●
	DIMMD0	DIMM030(D0)	X	X	X	X	X	●	●
	DIMME0	DIMM040(E0)	X	X	X	X	●	●	●
	DIMMF0	DIMM050(F0)	X	X	X	X	X	X	●
	DIMMG0	DIMM060(G0)	X	●	●	●	●	●	●
	DIMMH0	DIMM070(H0)	X	X	X	●	●	●	●
	DIMMI0	DIMM080(I0)	X	X	●	●	●	●	●
	DIMMJ0	DIMM090(J0)	X	X	X	X	X	●	●
	DIMMK0	DIMM0A0(K0)	X	X	X	X	●	●	●
	DIMML0	DIMM0B0(L0)	X	X	X	X	X	X	●
Note: ● indicates an installation position, and X indicates an empty slot.									

5.4.1.6 Memory Protection Technologies

- ECC
- Error Check and Scrub (ECS)
- UECC Retry
- Address/Command Parity with Replay
- Write Data CRC with Replay
- Read Data CRC with Replay
- Patrol Scrubber
- Redirect Scrubber
- Thermal Throttling
- Post-Package Repair

5.5 Storage

5.5.1 Drive Configuration and Drive Numbering Format Modification

5.5.1.1 Configuring the Genoa Processor

5.5.1.1.1 8 x 2.5" drive enclosure - supporting 8x NVMe

Drive Configurations

NOTE

Delivered chassis encipher and model:

- Domestic: 0231YEAD (2158H V8-S8NNC02).
- Overseas: 0231YEAE (2158H V8-S8NNF02).

Table 5-8 Drive Configurations

Configuration	Front Drive	Rear Drive	Built-in Drive	Drive Management Mode
Drive configuration 1	• Front drive (8 x 2.5"): – Slots 0 to 7 support only SATA/ NVMe drives.	-	M.2 SSD[a]	• SATA drive: CPU pass-through • NVMe drive: CPU pass-through • M.2 SSD: CPU pass-through

Configuration	Front Drive	Rear Drive	Built-in Drive	Drive Management Mode
Drive configuration 2	• Front drive (8 x 2.5"): – Slots 0 to 7 support SAS/ SATA/ NVMe drives.	-	M.2 SSD[a]	• SAS/ SATA drive: 1 x PCIe plug-in RAID controller card[b] The PCIe plug-in RAID controller card is installed in slot 3 by default. • NVMe drive: CPU pass-through • M.2 SSD: CPU pass-through
a: The built-in M.2 adapter cards do not support RAID functionality. b: Currently, only the 9540-8i (3808) or 9560-8i (3908) RAID controller cards are supported in this configuration, installed in Slot 3.				

Drive Number

NOTICE

- The drive numbers identified by the RAID controller card vary depending on the cabling of the RAID controller card. This section uses the drive numbers identified by a RAID controller card that adopts the default cabling described in "Internal Cabling" in the *Maintenance and Server Guide*.
- The drive numbers that are not listed correspond to the drive numbers displayed on the iBMC WebUI and those identified by the RAID controller card. For example, if the physical drive number is 0, the drive number displayed on the iBMC WebUI is **Disk0**, and that identified by the RAID controller card is **0**.

- The drive numbering for "Drive Configuration 1" and "Drive Configuration 2" in Table 5-8

Figure 5-25 Drive Number

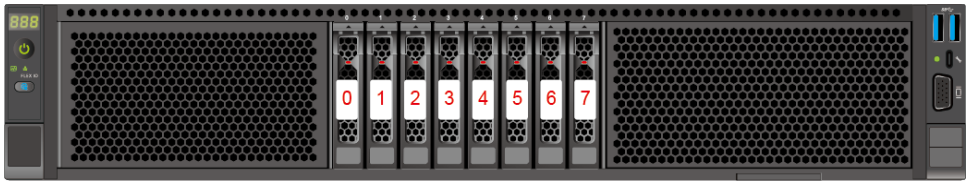


Table 5-9 Drive Number

Drive Number	Drive Number Displayed on the iBMC WebUI	Drive Number Identified by the RAID Controller Card
0	0	0Note
1	1	1Note
2	2	2Note
3	3	3Note
4	4	4Note
5	5	5Note
6	6	6Note
7	7	7Note
Note: If the slot is configured with a SAS/SATA drive, the PCIe plug-in RAID controller card can manage the drive and allocate a number to the drive.		

5.5.1.1.2 12 x 3.5" drive enclosure - supports 4 x NVMe

NOTE

Delivered the chassis encipher and model:

- Domestic: 0231YEAF (2158H V8-B12MNC01).
- Overseas: 0231YEAG (2158H V8-B12MNF01).

Drive Configurations

Table 5-10 Drive Configurations

Configuration	Front Drive	Rear Drive	Built-in Drive	Drive Management Mode
Drive configuration 1	• Front drives (12 x 3.5"): – Slots 0 to 7 support only SATA drives. – Slots 8 to 11 support only SATA/ NVMe drives.	• I/O module 1: (2 x 2.5"[a]) – Slots 40 and 41 support only SATA drives. • I/O module 3 (4 x 2.5"): – Slots 44 to 47 support only NVMe drives.	M.2 SSD[b]	• SATA drive: CPU pass-through • NVMe drive: CPU pass-through • M.2 SSD: PCIe-SATA
Drive configuration 2	• Front drives (12 x 3.5"): – Slots 0 to 7 support only SAS/ SATA drives. – Slots 8 to 11 support SAS, SATA, and NVMe drives.	• I/O module 1: (2 x 2.5"[a]) – Slots 40 and 41 support only SAS/ SATA drives. • I/O module 3 (4 x 2.5"): – Slots 44 to 47 support only NVMe drives.	M.2 SSD[b]	• SAS/SATA drives: 1 x PCIe plug-in RAID controller card[c] The PCIe plug-in RAID controller card is installed in slot 3 by default. • NVMe drive: CPU pass-through • M.2 SSD: CPU pass-through

Configuration	Front Drive	Rear Drive	Built-in Drive	Drive Management Mode
Drive configuration 3	• Front drives (12 x 3.5"): – Slots 0 to 7 support only SAS/SATA drives. – Slots 8 to 11 support only SAS/SATA/NVMe drives.	• I/O module 3 (4 x 2.5"): – Slots 44 to 47 support only SAS/SATA drives.	M.2 SSD[b]	• SAS/SATA drives: 1 x PCIe plug-in RAID controller card[c] The PCIe plug-in RAID controller card is installed in slot 3 by default. • NVMe drive: CPU pass-through • M.2 SSD: CPU pass-through
• a: I/O module 1 (2 x 2.5") is configured with rear 2 x 2.5" drives and a PCIe riser module. • b: The built-in M.2 adapter cards do not support RAID functionality. • a: The current configuration supports only the 9560-16i (3916) PCIe plug-in RAID controller card, installed in slot 3.				

Drive Numbering

NOTICE

The drive numbers identified by the RAID controller card vary depending on the cabling of the RAID controller card. This section uses the drive numbers identified by a RAID controller card that adopts the default cabling described in "Internal Cabling" in the server *Maintenance and Service Guide*.

- The drive numbers for "Drive Configuration 1" in **Table 5-10**

Figure 5-26 Drive Number

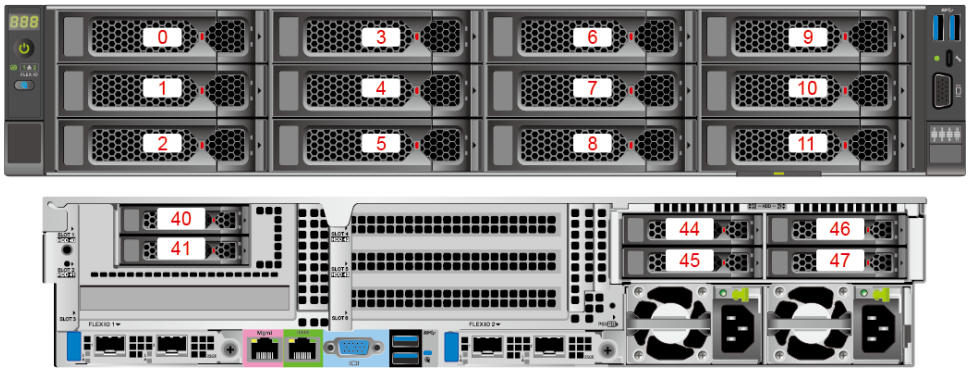


Table 5-11 Drive Number

Drive Number	Drive Number Displayed on the iBMC WebUI
0	0
1	1
2	2
3	3
4	4
5	5
6	6
7	7
8	8
9	9
10	10
11	11
40	40
41	41
44	44
45	45
46	46
47	47

- The drive numbers for "Drive Configuration 2" in **Table 5-10**

Figure 5-27 Drive numbering (I/O module 1 configured with 2.5" drives)

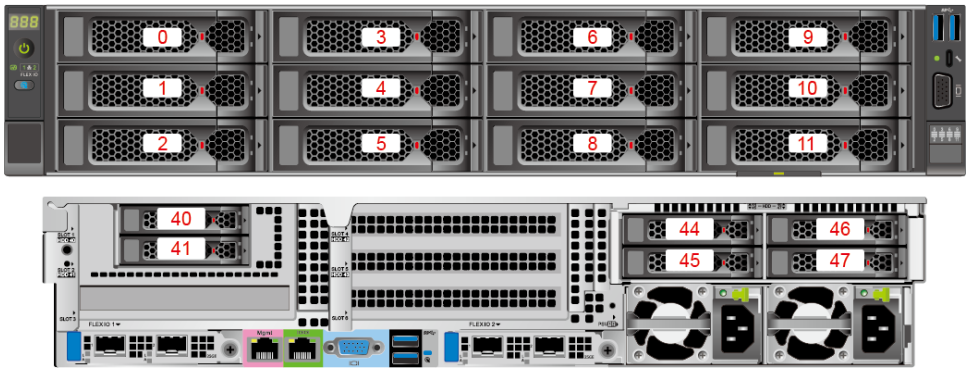


Table 5-12 Drive Number

Drive Number	Drive Number Displayed on the iBMC WebUI	Drive Number Identified by the RAID Controller Card
0	0	0[Note]
1	1	1[Note]
2	2	2[Note]
3	3	3[Note]
4	4	4[Note]
5	5	5[Note]
6	6	6[Note]
7	7	7[Note]
8	8	8[Note]
9	9	9[Note]
10	10	10[Note]
11	11	11[Note]
40	40	40[Note]
41	41	41[Note]
44	44	-
45	45	-
46	46	-
47	47	-

Drive Number	Drive Number Displayed on the iBMC WebUI	Drive Number Identified by the RAID Controller Card
Note: If the slot is configured with a SAS/SATA drive, the PCIe plug-in RAID controller card can manage the drive and allocate a number to the drive.		

- The drive numbers for "Drive Configuration 3" in **Table 5-10**

Figure 5-28 Drive Number

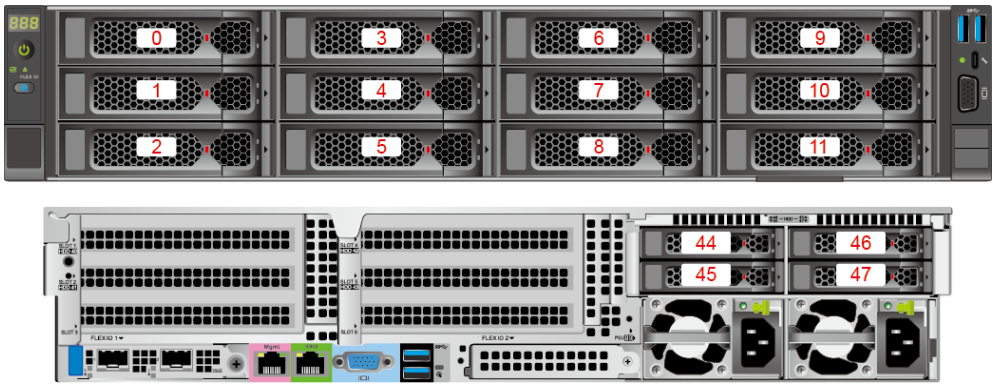


Table 5-13 Drive Number

Drive Number	Drive Number Displayed on the iBMC WebUI	Drive Number Identified by the RAID Controller Card
0	0	0Note
1	1	1Note
2	2	2Note
3	3	3Note
4	4	4Note
5	5	5Note
6	6	6Note
7	7	7Note
8	8	8Note
9	9	9Note
10	10	10Note
11	11	11Note
44	44	44 Note

Drive Number	Drive Number Displayed on the iBMC WebUI	Drive Number Identified by the RAID Controller Card
45	45	45 Note
46	46	46 Note
47	47	47 Note
Note: If the slot is configured with a SAS/SATA drive, the PCIe plug-in RAID controller card can manage the drive and allocate a number to the drive.		

5.5.1.1.3 24 x 2.5" drive enclosure - supporting 16 x NVMe drives

NOTE

Delivered the chassis encipher and model:

- Domestic: 0231YEAH (2158H V8-S24MNC01).
- Overseas: 0231YEAJ (2158H V8-S24MNF01).

Drive Configurations

Table 5-14 Drive Configurations

Configuration	Front Drive	Rear Drive	Built-in Drive	Drive Management Mode
Drive configuration 1	• Front drives (24 x 2.5"): – Slots 0 to 3 support only SATA drives. – Slots 4 to 11 support only NVMe drives. – Slots 12 to 15 support only SATA drives. – Slots 16 to 23 support only NVMe drives.	-	M.2 SSD[a]	• SATA drive: CPU pass-through • NVMe drive: CPU pass-through • M.2 SSD: CPU pass-through

Configuration	Front Drive	Rear Drive	Built-in Drive	Drive Management Mode
Drive configuration 2	• Front drives (24 x 2.5"): – Slots 0 to 3 support only SAS/SATA drives. – Slots 4 to 11 support only NVMe drives. – Slots 12 to 15 support only SAS/SATA drives. – Slots 16 to 23 support only NVMe drives.	-	M.2 SSD[a]	• SAS/SATA drive: 1 x PCIe plug-in RAID controller card[b] The PCIe plug-in RAID controller card is installed in slot 2 by default. • NVMe drive: CPU pass-through • M.2 SSD: CPU pass-through
b: The built-in M.2 adapter cards do not support RAID functionality. b: Currently, only the 9540-8i (3808) or 9560-8i (3908) RAID controller cards are supported in this configuration, installed in Slot 2.				

Drive Number

NOTICE

The drive numbers identified by the RAID controller card vary depending on the cabling of the RAID controller card. This section uses the drive numbers identified by a RAID controller card that adopts the default cabling described in "Internal Cabling" in the server *Maintenance and Service Guide*.

- The drive numbering for "Drive Configuration 1" and "Drive Configuration 2" in **Table 5-14**

Figure 5-29 Drive Number

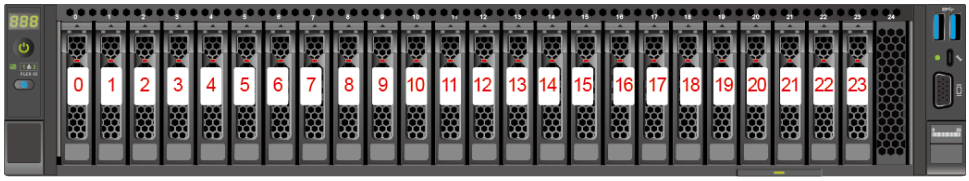


Table 5-15 Drive Number

Drive Number	Drive Number Displayed on the iBMC WebUI	Drive Number Identified by the RAID Controller Card
0	0	0Note
1	1	1Note
2	2	2Note
3	3	3Note
4	4	-
5	5	-
6	6	-
7	7	-
8	8	-
9	9	-
10	10	-
11	11	-
12	12	12Note
13	13	13Note
14	14	14Note
15	15	15Note
16	16	-
17	17	-
18	18	-
19	19	-
20	20	-
21	21	-

Drive Number	Drive Number Displayed on the iBMC WebUI	Drive Number Identified by the RAID Controller Card
22	22	-
23	23	-

5.5.1.2 Configuring the Turin processor

5.5.1.2.1 8 x 2.5" drive enclosure - supporting 8x NVMe

NOTE

Delivered the chassis encipher and model:

- Domestic: 0231YDRR (2158H V8-S8NNC01).
- Overseas: 0231YDYN (2158H V8-S8NNF01).

Drive Configurations

Table 5-16 Drive Configurations

Configuration	Front Drive	Rear Drive	Built-in Drive	Drive Management Mode
Drive configuration 1	• Front drive (8 x 2.5"): – Slots 0 to 7 support only SATA/ NVMe drives.	• I/O module 3 (4 x 2.5"): – Slots 44 to 47 support only NVMe drives.	M.2 SSD[a]	• SATA drive: CPU pass-through • NVMe drive: CPU pass-through • M.2 SSD: CPU pass-through

Configuration	Front Drive	Rear Drive	Built-in Drive	Drive Management Mode
Drive configuration 2	• Front drive (8 x 2.5"): – Slots 0 to 7 support SAS/ SATA/ NVMe drives.	• I/O module 3 (4 x 2.5"): – Slots 44 to 47 support only NVMe drives.	M.2 SSD[a]	• SAS/SATA drive: 1 x PCIe plug-in RAID controller card[b] The PCIe plug-in RAID controller card is installed in slot 3 or slot 2 by default. • NVMe drive: CPU pass-through • M.2 SSD: CPU pass-through
b: The built-in M.2 adapter cards do not support RAID functionality. b: Currently, only the 9540-8i (3808) or 9560-8i (3908) RAID controller cards are supported in this configuration, installed in Slot 3 or Slot 2.				

Drive Number

NOTICE

The drive numbers identified by the RAID controller card vary depending on the cabling of the RAID controller card. This section uses the drive numbers identified by a RAID controller card that adopts the default cabling described in "Internal Cabling" in the server *Maintenance and Service Guide*.

- The drive numbers for "Drive Configuration 1" and "Drive Configuration 2" in **Table 5-16**

Figure 5-30 Drive Number

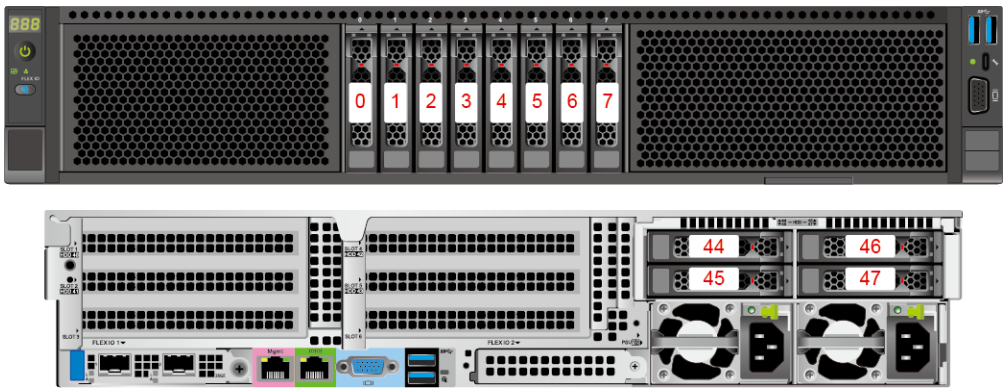


Table 5-17 Drive Number

Drive Number	Drive Number Displayed on the iBMC WebUI	Drive Number Identified by the RAID Controller Card
0	0	0Note
1	1	1Note
2	2	2Note
3	3	3Note
4	4	4Note
5	5	5Note
6	6	6Note
7	7	7Note
44	44	-
45	45	-
46	46	-
47	47	-
Note: If the slot is configured with a SAS/SATA drive, the PCIe plug-in RAID controller card can manage the drive and allocate a number to the drive.		

5.5.1.2.2 8 x 2.5" drive pass-through chassis

NOTE

Delivered the chassis encipher and model:

- Domestic: 0231YDYR (2158H V8-S8ANC01).
- Overseas: 0231YDYS (2158H V8-S8ANF01).

Drive Configurations

Table 5-18 Drive Configurations

Configuration	Front Drive	Rear Drive	Built-in Drive	Drive Management Mode
Drive configuration 1	• Front drive (8 x 2.5"): – Slots 0 to 7 support only SATA drives.	• I/O module 3 (4 x 2.5"): – Slots 44 to 47 support only NVMe drives.	M.2 SSD[a]	• SATA drive: CPU pass-through • NVMe drive: CPU pass-through • M.2 SSD: CPU pass-through
Drive configuration 2	• Front drive (8 x 2.5"): – Slots 0 to 7 support only SAS/ SATA drives.	• I/O module 3 (4 x 2.5"): – Slots 44 to 47 support only NVMe drives.	M.2 SSD[a]	• SAS/SATA drive: 1 x PCIe plug-in RAID controller card[b] The PCIe plug-in RAID controller card is installed in slot 3 or slot 2 by default. • NVMe drive: CPU pass-through • M.2 SSD: CPU pass-through
b: The built-in M.2 adapter cards do not support RAID functionality. b: Currently, only the 9540-8i (3808) or 9560-8i (3908) RAID controller cards are supported in this configuration, installed in Slot 3 or Slot 2.				

Drive Number

NOTICE

The drive numbers identified by the RAID controller card vary depending on the cabling of the RAID controller card. This section uses the drive numbers identified by a RAID controller card that adopts the default cabling described in "Internal Cabling" in the server *Maintenance and Service Guide*.

- The drive numbers for "Drive Configuration 1" and "Drive Configuration 2" in **Table 5-18**

Figure 5-31 Drive Number

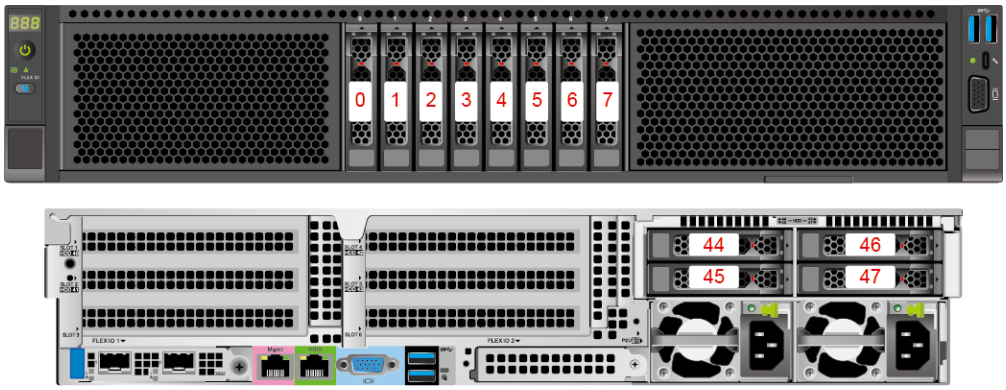


Table 5-19 Drive Number

Drive Number	Drive Number Displayed on the iBMC WebUI	Drive Number Identified by the RAID Controller Card
0	0	0[Note]
1	1	1[Note]
2	2	2[Note]
3	3	3[Note]
4	4	4[Note]
5	5	5[Note]
6	6	6[Note]
7	7	7[Note]
44	44	-
45	45	-
46	46	-

Drive Number	Drive Number Displayed on the iBMC WebUI	Drive Number Identified by the RAID Controller Card
47	47	-
Note: If the slot is configured with a SAS/SATA drive, the PCIe plug-in RAID controller card can manage the drive and allocate a number to the drive.		

5.5.1.2.3 8 x 2.5" drive enclosure - supporting 2 x NVMe

NOTE

Delivered the chassis encipher and model:

- Domestic: 0231YDYP (2158H V8-S8MNC01).
- Overseas: 0231YDYQ (2158H V8-S8MNF01).

Drive Configurations

Table 5-20 Drive Configurations

Configuration	Front Drive	Rear Drive	Built-in Drive	Drive Management Mode
Drive configuration 1	• Front drive (8 x 2.5"): – Slots 0 to 1 support only SATA/ NVMe drives. – Slots 2 to 7 support only SATA drives.	• I/O module 3 (4 x 2.5"): – Slots 44 to 47 support only NVMe drives.	M.2 SSD[a]	• SATA drive: CPU pass-through • NVMe drive: CPU pass-through • M.2 SSD: CPU pass-through

Configuration	Front Drive	Rear Drive	Built-in Drive	Drive Management Mode
Drive configuration 2	• Front drive (8 x 2.5"): – Slots 0 to 1 support only SATA/ NVMe drives. – Slots 2 to 7 support only SAS/ SATA drives.	• I/O module 3 (4 x 2.5"): – Slots 44 to 47 support only NVMe drives.	M.2 SSD[a]	• SAS/SATA drive: 1 x PCIe plug-in RAID controller card[b] The PCIe plug-in RAID controller card is installed in slot 3 or slot 2 by default. • NVMe drive: CPU pass-through • M.2 SSD: CPU pass-through
b: The built-in M.2 adapter cards do not support RAID functionality. b: Currently, only the 9540-8i (3808) or 9560-8i (3908) RAID controller cards are supported in this configuration, installed in Slot 3 or Slot 2.				

Drive Number

NOTICE

The drive numbers identified by the RAID controller card vary depending on the cabling of the RAID controller card. This section uses the drive numbers identified by a RAID controller card that adopts the default cabling described in "Internal Cabling" in the server *Maintenance and Service Guide*.

- The drive number for "Drive Configuration 1" and "Drive Configuration 2" in **Table 5-20**

Figure 5-32 Drive Number

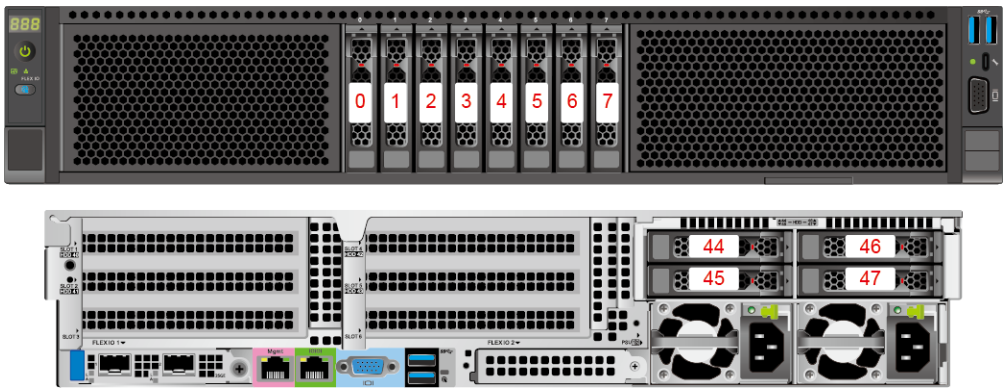


Table 5-21 Drive Number

Drive Number	Drive Number Displayed on the iBMC WebUI	Drive Number Identified by the RAID Controller Card
0	0	0Note
1	1	1Note
2	2	2Note
3	3	3Note
4	4	4Note
5	5	5Note
6	6	6Note
7	7	7Note
44	44	-
45	45	-
46	46	-
47	47	-
Note: If the slot is configured with a SAS/SATA drive, the PCIe plug-in RAID controller card can manage the drive and allocate a number to the drive.		

5.5.1.2.4 8 x 2.5" drive enclosure - supporting 8 x NVMe

NOTE

Delivered the chassis encipher and model:

- Domestic: 0231YDYW (2158H V8-B8NNC01).
- Overseas: 0231YDYV (2158H V8-B8NNF01).

Drive Configurations

Table 5-22 Drive Configurations

Configuration	Front Drive	Rear Drive	Built-in Drive	Drive Management Mode
Drive configuration 1	• Front drives (8 x 3.5"): – Slots 0 to 7 support only SATA/ NVMe drives.	• I/O module 3 (4 x 2.5"): – Slots 44 to 47 support only NVMe drives.	M.2 SSD[a]	• SATA drive: CPU pass-through • NVMe drive: CPU pass-through • M.2 SSD: CPU pass-through
Drive configuration 2	• Front drives (8 x 3.5"): – Slots 0 to 7 support SAS/ SATA/ NVMe drives.	• I/O module 3 (4 x 2.5"): – Slots 44 to 47 support only NVMe drives.	M.2 SSD[a]	• SAS/ SATA drive: 1 x PCIe plug-in RAID controller card[b] The PCIe plug-in RAID controller card is installed in slot 3 or slot 2 by default. • NVMe drive: CPU pass-through • M.2 SSD: CPU pass-through

Configuration	Front Drive	Rear Drive	Built-in Drive	Drive Management Mode
b: The built-in M.2 adapter cards do not support RAID functionality. b: Currently, only the 9540-8i (3808) or 9560-8i (3908) RAID controller cards are supported in this configuration, installed in Slot 3 or Slot 2.				

Drive Number

NOTICE

The drive numbers identified by the RAID controller card vary depending on the cabling of the RAID controller card. This section uses the drive numbers identified by a RAID controller card that adopts the default cabling described in "Internal Cabling" in the server *Maintenance and Service Guide*.

- The drive numbers in "Drive Configuration 1" and "Drive Configuration 2" in the **Table Drive Configurations**.

Figure 5-33 Drive Number

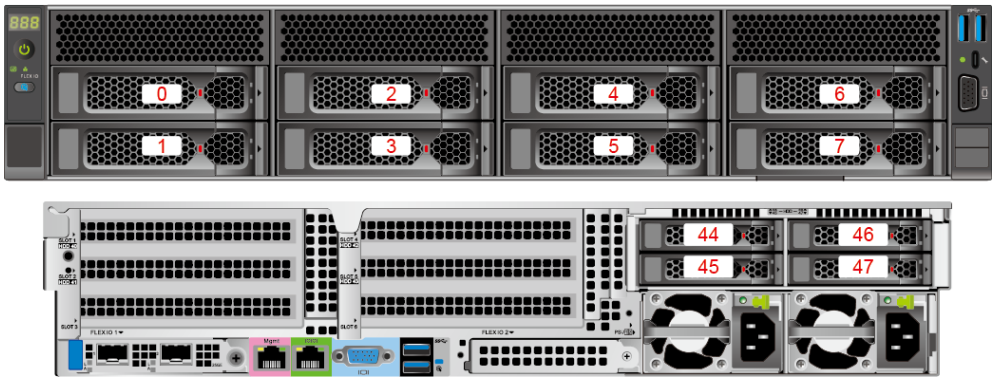


Table 5-23 Drive Number

Drive Number	Drive Number Displayed on the iBMC WebUI	Drive Number Identified by the RAID Controller Card
0	0	0[Note]
1	1	1[Note]
2	2	2[Note]
3	3	3[Note]
4	4	4[Note]

Drive Number	Drive Number Displayed on the iBMC WebUI	Drive Number Identified by the RAID Controller Card
5	5	5Note
6	6	6Note
7	7	7Note
44	44	-
45	45	-
46	46	-
47	47	-
Note: If the slot is configured with a SAS/SATA drive, the PCIe plug-in RAID controller card can manage the drive and allocate a number to the drive.		

5.5.1.2.5 8 x 3,5" drive enclosure - supporting 4 x NVMe drives and 4 GPUs

NOTE

Delivered the chassis encipher and model:

- Domestic: 0231YEAB (2158H V8-B8NNC03).
- Overseas: 0231YEAC (2158H V8-B8NNF03).

Drive Configurations

Table 5-24 Drive Configurations

Configuration	Front Drive	Rear Drive	Built-in Drive	Drive Management Mode
Drive configuration 1	• Front drives (8 x 3.5"): – Slots 0 to 3 support only SATA drives. – Slots 4 to 7 support only SATA/ NVMe drives.	-	M.2 SSD[a]	• SATA drive: CPU pass-through • NVMe drive: CPU pass-through • M.2 SSD: PCIe-SATA

Configuration	Front Drive	Rear Drive	Built-in Drive	Drive Management Mode
b: The built-in M.2 adapter cards do not support RAID functionality. b: Currently, only the 9540-8i (3808) or 9560-8i (3908) RAID controller cards are supported in this configuration, installed in Slot 3.				

Drive Number

NOTICE

The drive numbers identified by the RAID controller card vary depending on the cabling of the RAID controller card. This section uses the drive numbers identified by a RAID controller card that adopts the default cabling described in "Internal Cabling" in the server *Maintenance and Service Guide*.

- The drive number for "Drive Configuration 1" and "Drive Configuration 2" in Table 5-24

Figure 5-34 Drive Number

Table 5-25 Drive Number

Drive Number	Drive Number Displayed on the iBMC WebUI	Drive Number Identified by the RAID Controller Card
0	0	0Note
1	1	1Note
2	2	2Note
3	3	3Note
4	4	4Note
5	5	5Note
6	6	6Note
7	7	7Note

Drive Number	Drive Number Displayed on the iBMC WebUI	Drive Number Identified by the RAID Controller Card
Note: If the slot is configured with a SAS/SATA drive, the PCIe plug-in RAID controller card can manage the drive and allocate a number to the drive.		

5.5.1.2.6 12 x 3.5" drive enclosure - supports 4 x NVMe drives

NOTE

Delivered the chassis encipher and model:

- Domestic: 0231YDYT (2158H V8-B12ANC01).
- Overseas: 0231YDYU (2158H V8-B12ANF01).

Drive Configurations

Table 5-26 Drive Configurations

Configuration	Front Drive	Rear Drive	Built-in Drive	Drive Management Mode
Drive configuration 1	• Front drives (12 x 3.5"): – Slots 0 to 7 support only SATA drives. – Slots 8 to 11 support SAS, SATA, and NVMe drives.	• I/O module 1: (2 x 2.5"[a]) – Slots 40 and 41 support only SATA drives. • I/O module 3 (4 x 2.5"): – Slots 44 to 47 support only NVMe drives.	M.2 SSD[b]	• SATA drive: CPU pass-through • NVMe drive: CPU pass-through • M.2 SSD: – I/O Module 1 configured with drive module: PCIe-SATA – I/O Module without HDD Module: CPU pass-through

Configuration	Front Drive	Rear Drive	Built-in Drive	Drive Management Mode
Drive configuration 2	• Front drives (12 x 3.5"): – Slots 0 to 7 support only SAS/ SATA drives. – Slots 8 to 11 support only SAS/ SATA/ NVMe drives.	• I/O module 1: (2 x 2.5"[a]) – Slots 40 and 41 support only SAS/ SATA drives. • I/O module 3 (4 x 2.5"): – Slots 40 to 47 support only NVMe drives.	M.2 SSD[b]	• SAS/SATA drives: 1 x PCIe plug-in RAID controller card[c] The PCIe plug-in RAID controller card is installed in slot 3 or slot 2 by default. • NVMe drive: CPU pass-through • M.2 SSD: CPU pass-through
• a: I/O module 1 (2 x 2.5") is configured with rear 2 x 2.5" drives and a PCIe riser module. • b: The built-in M.2 adapter cards do not support RAID functionality. • c: Currently, only the 9560-16i (3916) RAID controller card is supported, installed in Slot 3 or Slot 2.				

Drive Number

NOTICE

The drive numbers identified by the RAID controller card vary depending on the cabling of the RAID controller card. This section uses the drive numbers identified by a RAID controller card that adopts the default cabling described in "Internal Cabling" in the server *Maintenance and Service Guide*.

- The drive number for "Drive Configuration 1" and "Drive Configuration 2" in **Table 5-26**

Figure 5-35 Drive Number

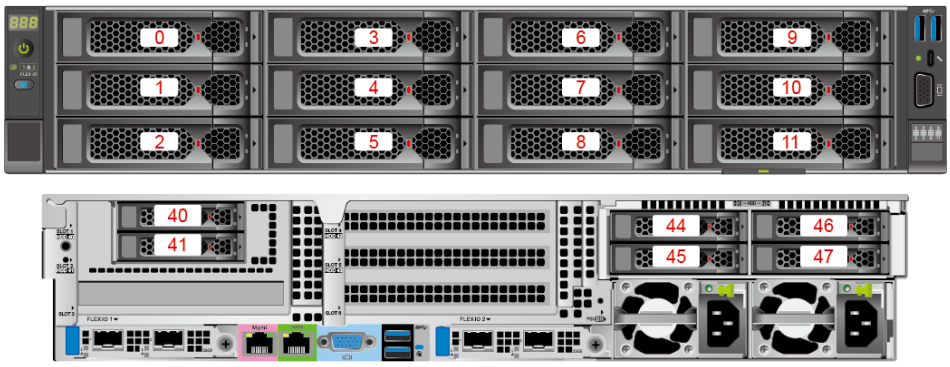


Table 5-27 Drive Number

Drive Number	Drive Number Displayed on the iBMC WebUI	Drive Number Identified by the RAID Controller Card
0	0	0[Note]
1	1	1[Note]
2	2	2[Note]
3	3	3[Note]
4	4	4[Note]
5	5	5[Note]
6	6	6[Note]
7	7	7[Note]
8	8	8[Note]
9	9	9[Note]
10	10	10[Note]
11	11	11[Note]
40	40	40[Note]
41	41	41[Note]
44	44	-
45	45	-
46	46	-
47	47	-

5.5.1.2.7 12 x 3.5" drive enclosure - supports 4 x NVMe drives

NOTE

Delivered the chassis encipher and model:

- Domestic: 0231YDSC (2158H V8-B12NNC02).
- Overseas: 0231YDYX (22158H V8-B12NNF01).

Drive Configurations

Table 5-28 Drive Configurations

Configuration	Front Drive	Rear Drive	Built-in Drive	Drive Management Mode
Drive configuration 1	• Front drives (12 x 3.5"): – Slots 0 to 11 support only SATA/ NVMe drives.	• I/O module 3 (4 x 2.5"): – Slots 44 to 47 support only NVMe drives.	M.2 SSD[a]	• SATA drive: CPU pass-through • NVMe drive: CPU pass-through • M.2 SSD: CPU pass-through
Drive configuration 2	• Front drives (12 x 3.5"): – Slots 0 to 11 support only SATA/ NVMe drives.	• I/O module 3 (4 x 2.5"): – Slots 40 to 47 support only NVMe drives.	M.2 SSD[a]	• SAS/SATA drive: 1 x PCIe plug-in RAID controller card[b] The PCIe plug-in RAID controller card is installed in slot 2 by default. • NVMe drive: CPU pass-through • M.2 SSD: CPU pass-through

Configuration	Front Drive	Rear Drive	Built-in Drive	Drive Management Mode
• b: The built-in M.2 adapter cards do not support RAID function. • b: The current configuration supports only the standard 9560-16i (3916) RAID controller card installed in slot 2.				

Drive Number

- The drive number for "Drive Configuration 1" and "Drive Configuration 2" in **Table 5-28**

Figure 5-36 Drive Number

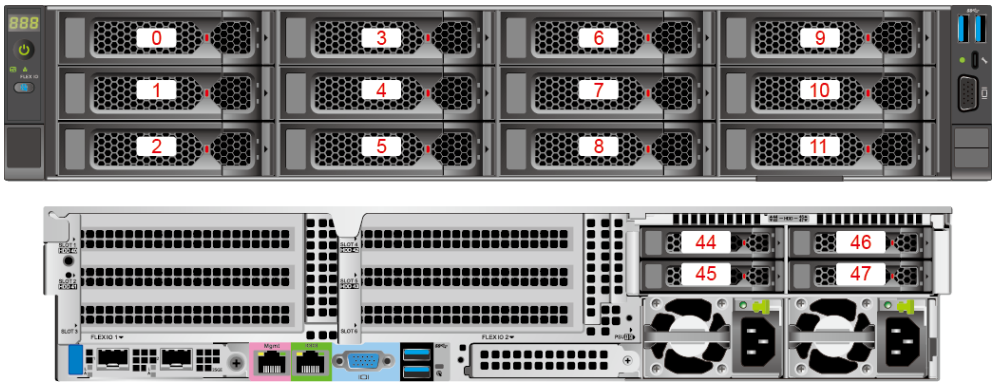


Table 5-29 Drive Number

Drive Number	Drive Number Displayed on the iBMC WebUI	Drive Number Identified by the RAID Controller Card
0	0	0Note
1	1	1Note
2	2	2Note
3	3	3Note
4	4	4Note
5	5	5Note
6	6	6Note
7	7	7Note
8	8	8Note

Drive Number	Drive Number Displayed on the iBMC WebUI	Drive Number Identified by the RAID Controller Card
9	9	9[Note]
10	10	10[Note]
11	11	11[Note]
44	44	-
45	45	-
46	46	-
47	47	-

5.5.2 Drive Indicators

SAS/SATA Drive Indicators

Figure 5-37 SAS/SATA drive indicators

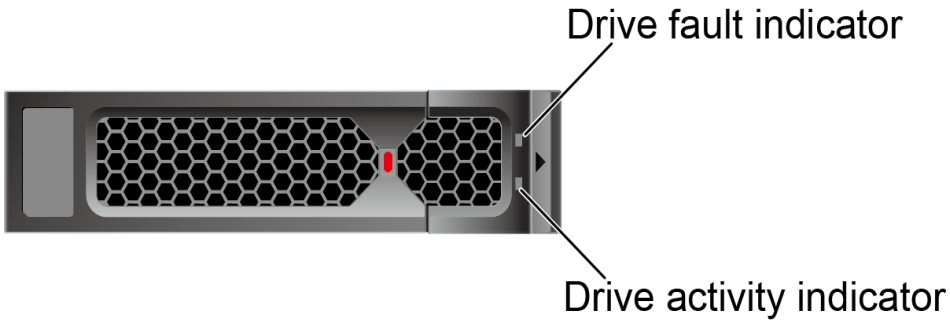


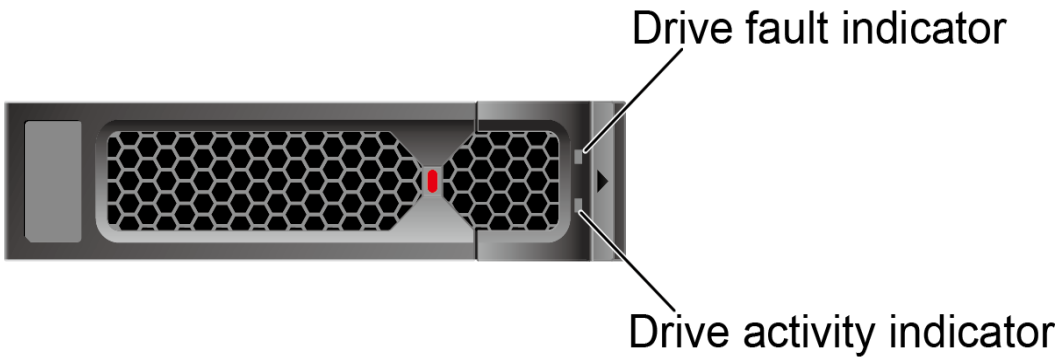
Table 5-30 SAS/SATA drive indicators

Active Indicator (Green)	Fault Indicator (Red/Blue)	Description
Off	Off	The drive is not detected.
Steady on	Off	The drive is detected.
Blinking at 4 Hz	Off	Data is being read or written properly, or data on the primary drive is being rebuilt.
Steady on	Blinking blue at 4 Hz	The drive is being located.

Active Indicator (Green)	Fault Indicator (Red/Blue)	Description
Blinking at 1 Hz	Blinking red at 1 Hz synchronously	Data on the secondary drive is being rebuilt.
Off	Red steady on	A member drive in the RAID array is removed.
Steady on	Red steady on	The drive is faulty.

NVMe Drive Indicator

Figure 5-38 NVMe drive indicator



- If the VMD function is enabled and the latest VMD driver is installed, the NVMe drives support surprise hot swap.

Table 5-31 NVMe drive indicator description (VMD function enabled)

Activity Indicator (Green)	Fault Indicator (Red/Blue)	Description
Off	Off	The NVMe drive is not detected.
Steady on	Off	The NVMe drive is detected and operating properly.
Blinking at 4 Hz	Off	Data is being read from or written to the NVMe drive.
Steady on/ blinking	Blinking blue at 4 Hz	The NVMe drive is being located.
Blinking at 1 Hz	Blinking red at 1 Hz synchronously	Data on the NVMe secondary drive is being rebuilt.
Steady on/Off	Red steady on	The NVMe drive is faulty.

- If the VMD function is disabled, the NVMe drives support only orderly hot swap.

Table 5-32 NVMe drive indicator description (VMD function disabled)

Activity Indicator (Green)	Fault Indicator (Red/Blue)	Description
Off	Off	The NVMe drive is not detected.
Steady on	Off	The NVMe drive is detected and operating properly.
Blinking at 4 Hz	Off	Data is being read from or written to the NVMe drive.
Steady on/ blinking	Blinking blue at 4 Hz	The NVMe drive is being located.
Off	Blinking red at 0.5 Hz	The NVMe drive has completed the hot swap process and is removable.
Off	Blinking red at 2 Hz	The NVMe drive is being hot-swapped.
Steady on/Off	Red steady on	The NVMe drive is faulty.

5.5.3 RAID Controller Card

The RAID controller card supports RAID configuration, RAID level migration, and drive roaming.

- For details about the RAID controller card, see the server *RAID Controller Card User Guide*.

5.6 Network

5.6.1 OCP 3.0 NICs

OCP 3.0 NICs provide network expansion capabilities.

- The FlexIO slot supports an OCP 3.0 NIC, which can be configured as required.
- For details about OCP 3.0 NICs, see the *OCP 3.0 NIC User Guide*.

5.7 I/O Expansion

5.7.1 PCIe Module

PCIe cards provide ease of expandability and connection.

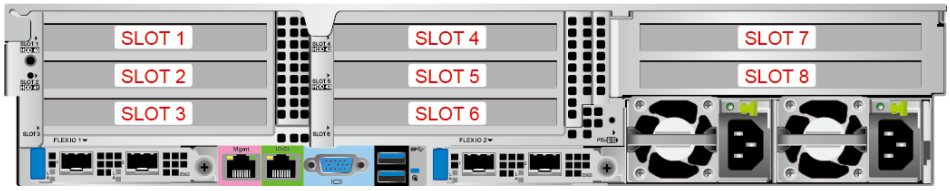
- The server supports a maximum of six standard PCIe expansion slots.
- When IB cards are used to build an IB network, ensure that the IPoIB modes of the IB cards at both ends of the network connection are the same. For details, contact technical support.

5.7.2 PCIe Slots

Positions of PCIe Slots

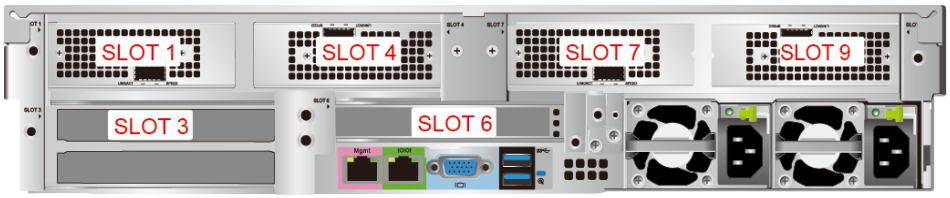
- Server with drive modules or PCIe riser modules on the rear panel

Figure 5-39 PCIe slots



  - I/O module 1 provides slots 1, 2, and 3. If the module with 2 x 2.5" rear drives and one PCIe riser card is used, slots 1 and 2 are unavailable.
  - I/O module 2 provides slots 4, 5, and 6.
  - I/O module 3 provides slots 7 and 8.
- 4-GPU model

Figure 5-40 PCIe Slots

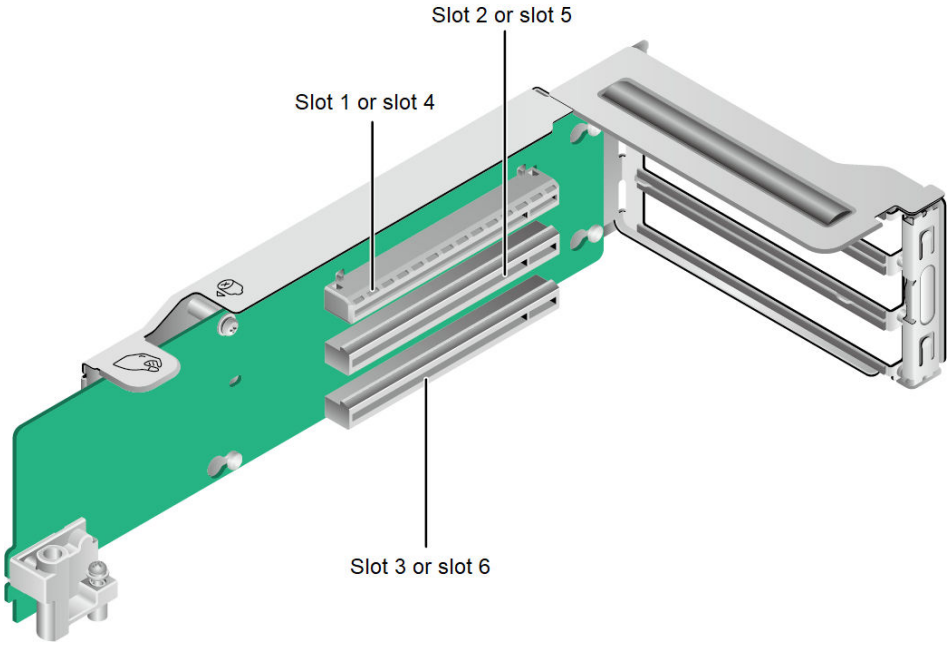


  - The GPU riser module provides slots 1, 4, 7, and 9.
  - I/O module 1 provides slot 3.
  - I/O module 2 provides slot 6.

PCIe Riser Cards (Applicable to the Server with a Drive Module or a PCIe Riser Module on the Rear Panel)

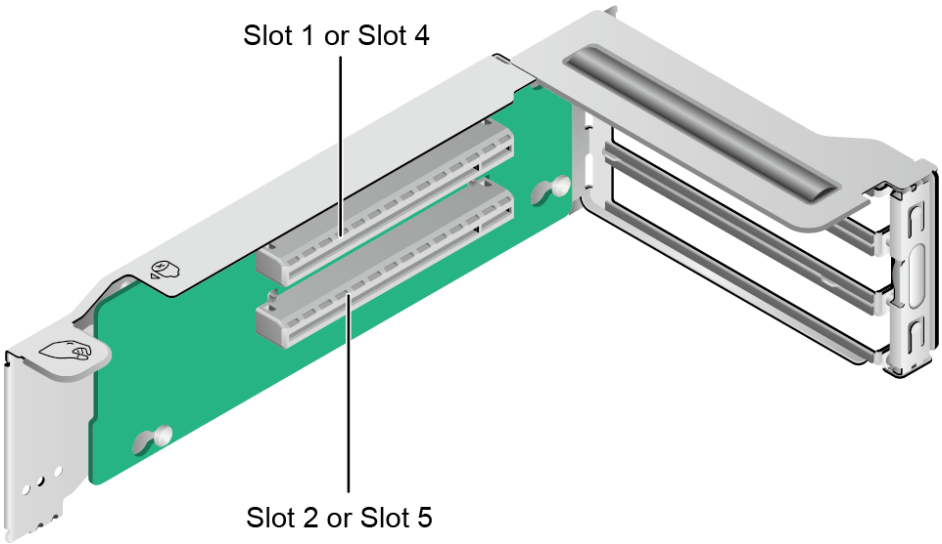
- PCIe riser card 1 of I/O module 1/2
  - Provides PCIe slots 1, 2, and 3 when installed in I/O module 1.
  - Provides PCIe slots 4, 5, and 6 when installed in I/O module 2.

Figure 5-41 PCIe riser card 1 (BC1M09PRUB)



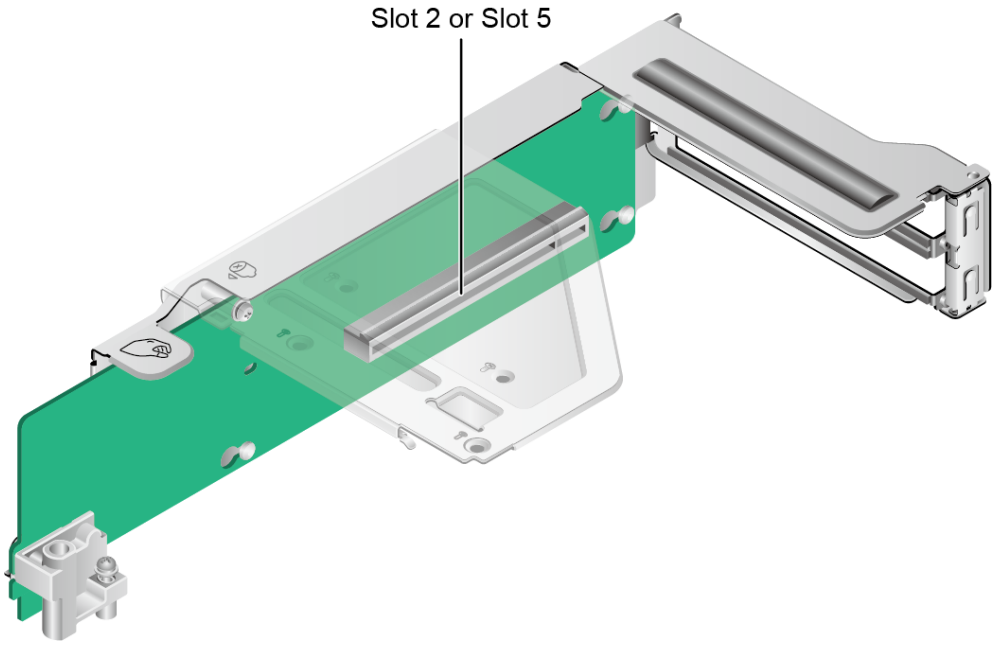
- PCIe riser card 2 of I/O module 1/2 (BC1M06PRUC)
  - Provides PCIe slots 1 and 2 when installed in I/O module 1.
  - Provides PCIe slots 4 and 5 when installed in I/O module 2.

Figure 5-42 PCIe riser card 2 (BC1M06PRUC)



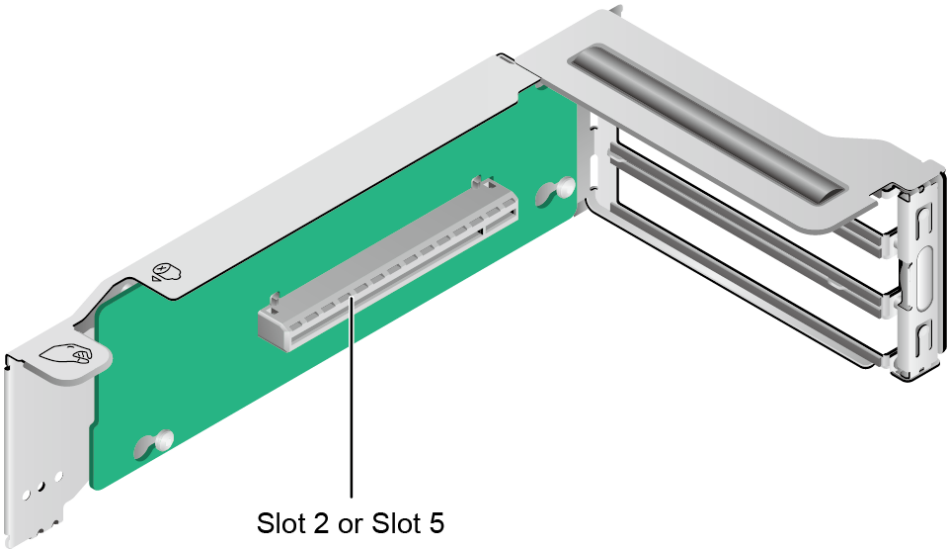
- PCIe riser card 3 of I/O module 1/2 (BC1M04PRUE)
  - Provides PCIe slot 2 when installed in I/O module 1.
  - Provides PCIe slot 5 when installed in I/O module 2.

Figure 5-43 PCIe riser card 3 (BC1M04PRUE)



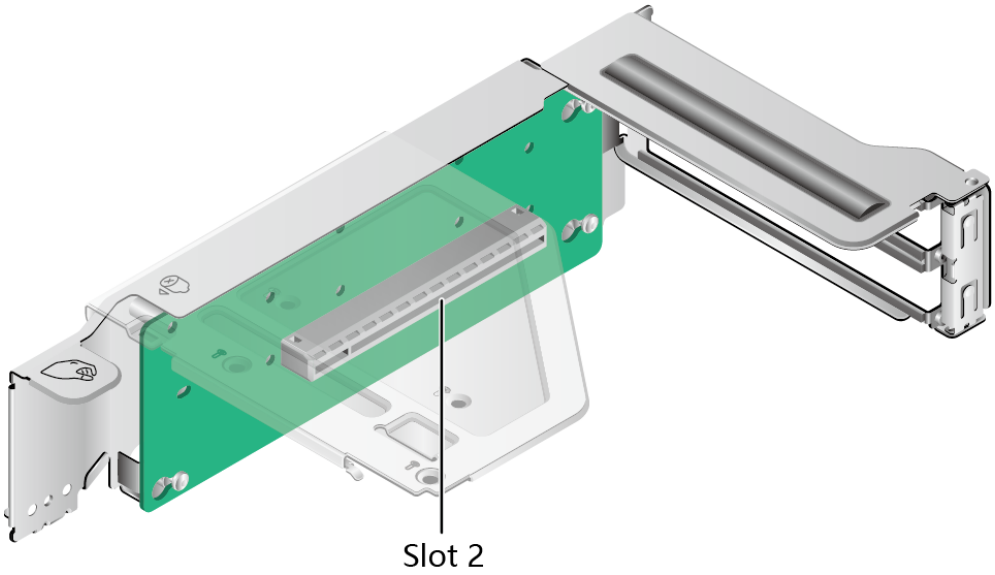
- PCIe riser card 4 of I/O module 1/2 (BC1M01PRUCC)
  - Provides PCIe slots 2 when installed in I/O module 1.
  - Provides PCIe slots 5 when installed in I/O module 2.

Figure 5-44 PCIe Riser card 4 (BC1M01PRUCC)



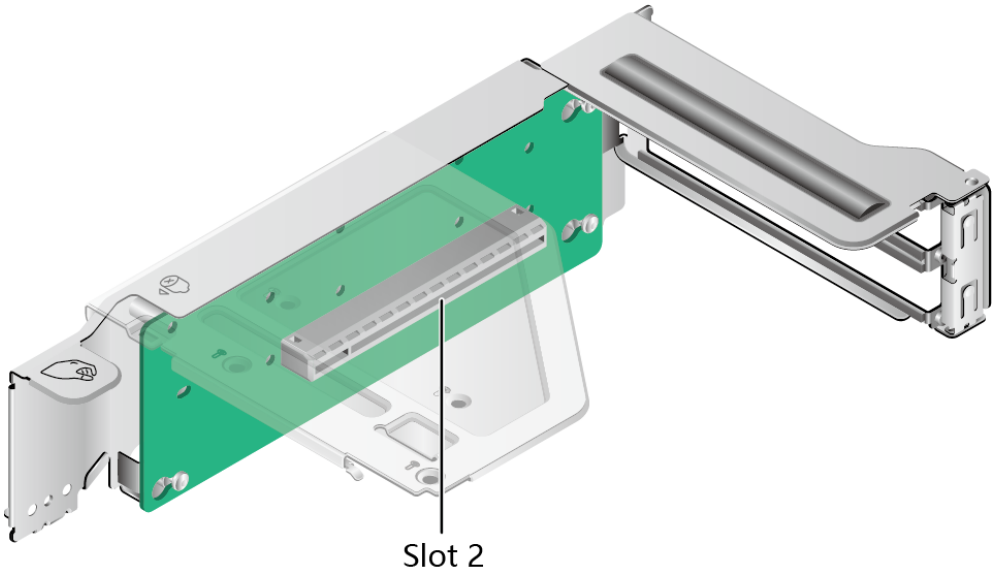
- PCIe riser card 5 of I/O module 1 (BC1M01PRUCB)
  Provides PCIe slot 2 when installed in I/O module 1.

Figure 5-45 PCIe Riser card 5 (BC1M01PRUCB)



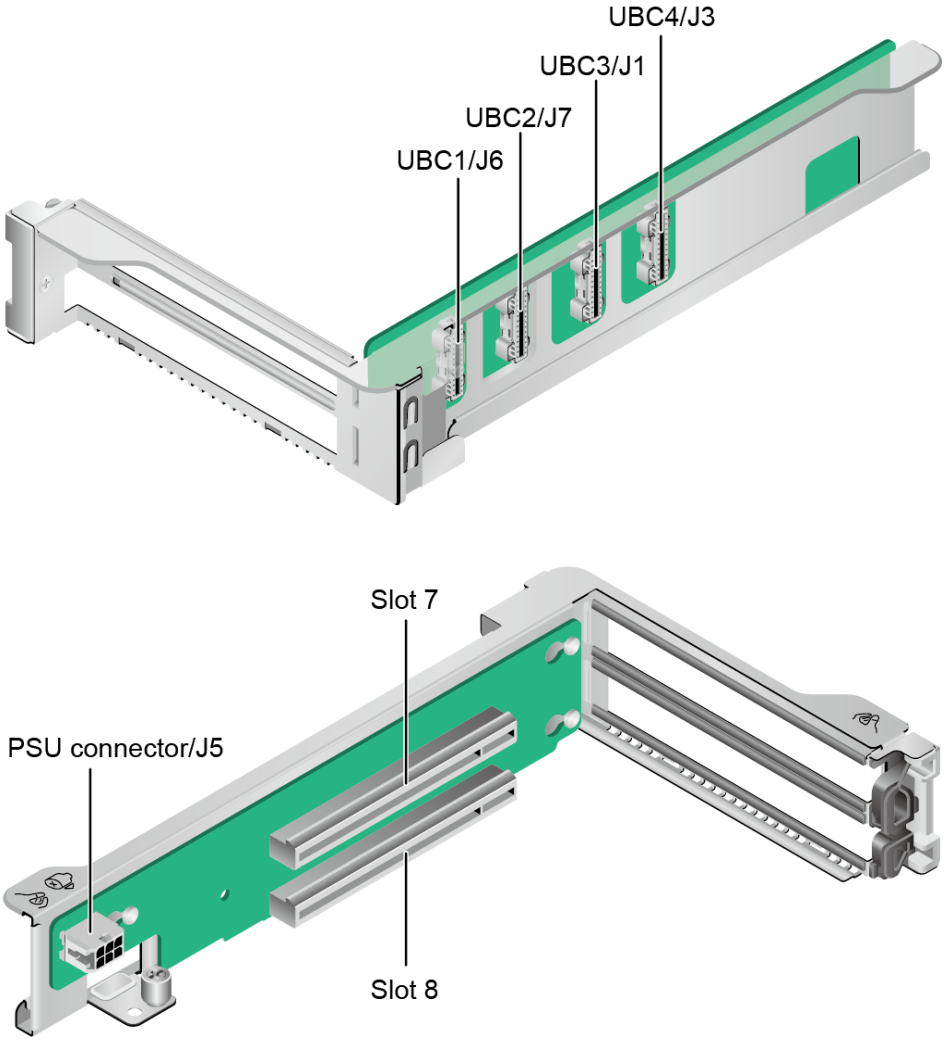
- PCIe riser card 6 on I/O module 1 (BC1M02PRUCC)
  Provides PCIe slot 2 when installed in I/O module 1.

Figure 5-46 PCIe riser card 6 (BC1M02PRUCC)



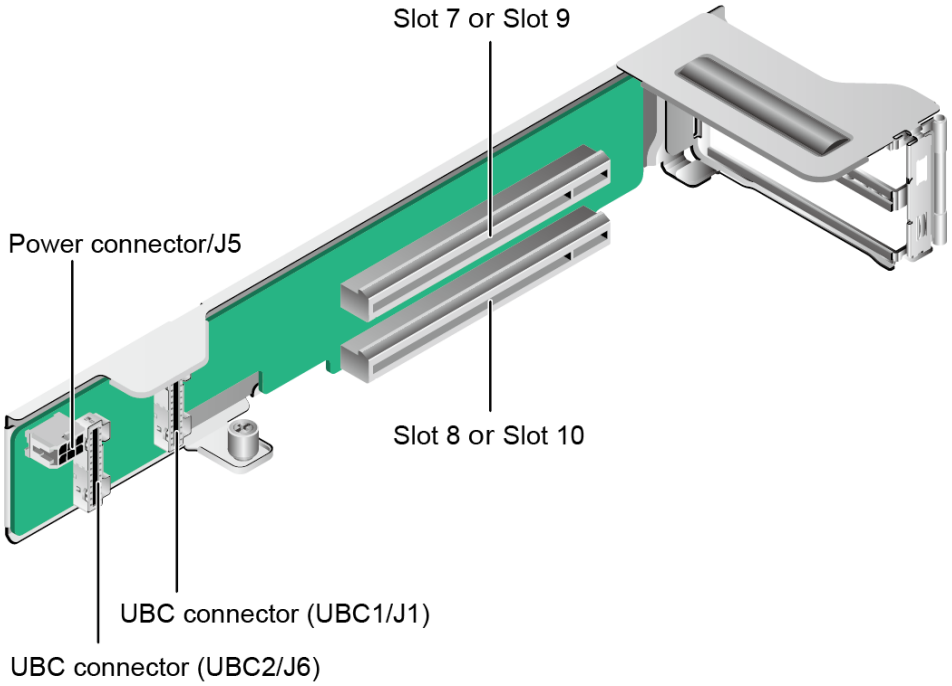
- PCIe riser card 1 of I/O module 3 (BC1M10PRUF)
  Provides PCIe slots 7 and 8 when installed in I/O module 3.

Figure 5-47 PCIe Riser card 1 (BC1M10PRUF)



- PCIe riser card 2 of I/O module 3 (BC1M11PRUI)
  Provides slots 7, 8, 9, and 10 when installed in I/O module 3.

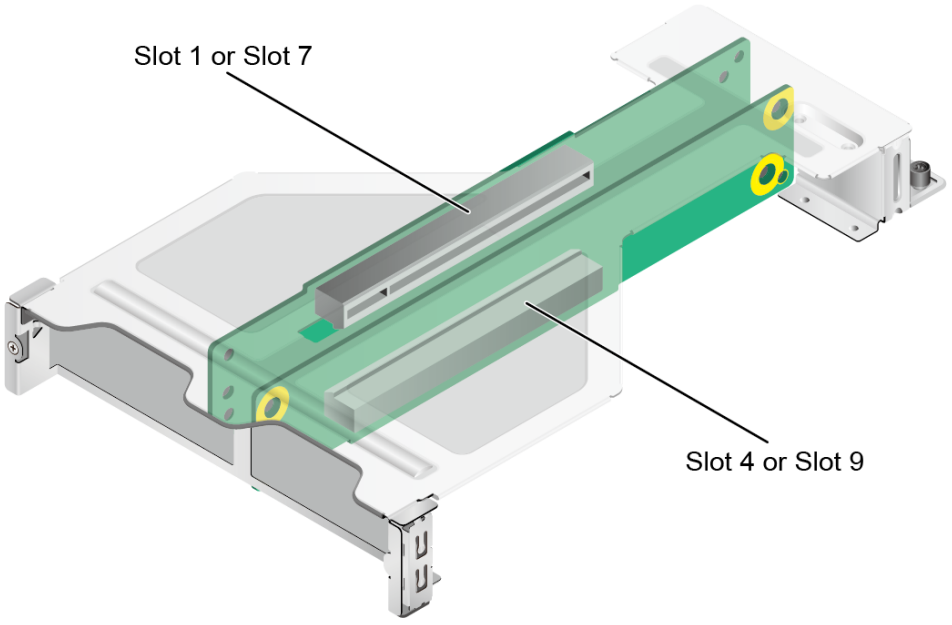
Figure 5-48 PCIe riser module 2 (BC1M11PRUI)



PCIe riser card (applicable to 4-GPU models)

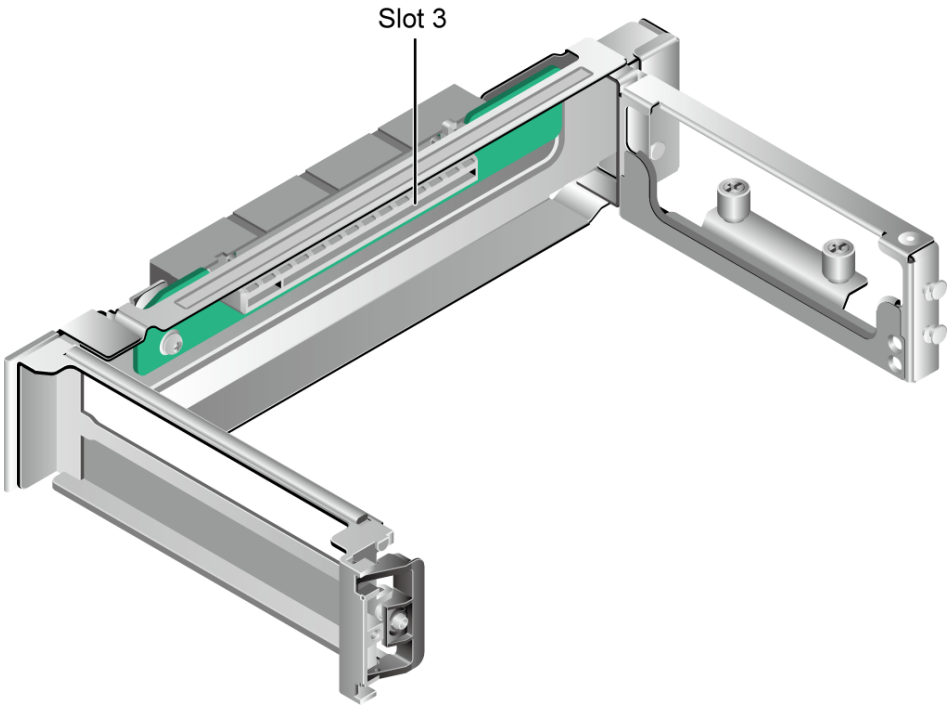
- The PCIe Riser card of the rear GPU module provides PCIe slots 1, 4, 7, and 9.

Figure 5-49 PCIe Riser Card



- PCIe riser card of I/O module 1 provides slot 3 for PCIe. It supports either one PCIe riser card or one DPU riser card.

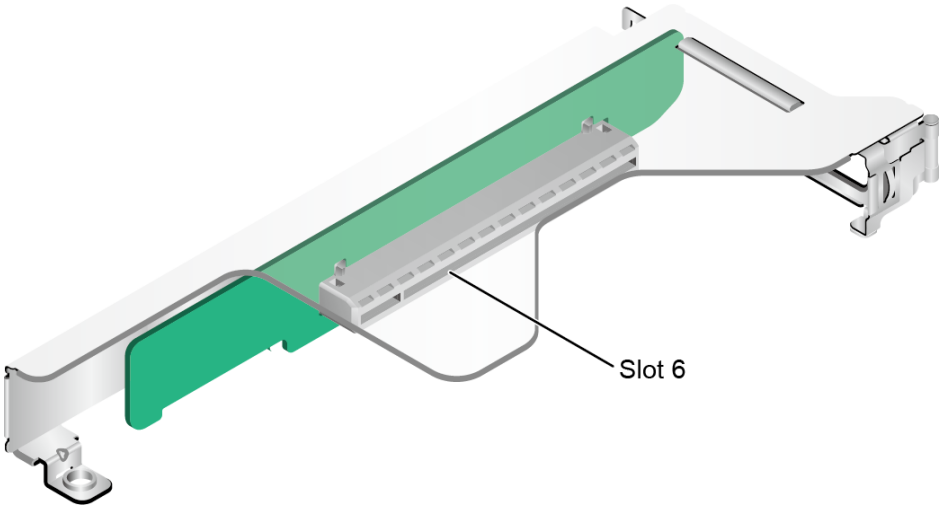
Figure 5-50 PCIe Riser module (BC1M01PRUWB)



- The PCIe riser card of the I/O module 2 provides PCIe slot 6, supporting both hard and soft connection (Hard connection: The slot is directly connected to the mainboard's high-speed I/O interface via MCIO directly in CEM (card electromechanical) form. For details about soft connection, see the Internal Cabling section of the server *Maintenance and Service Guide*.
  - PCIe riser card 1 of I/O module 2 (BC1M04PRUK)

    Provides PCIe slot 6 when installed in I/O module 2.

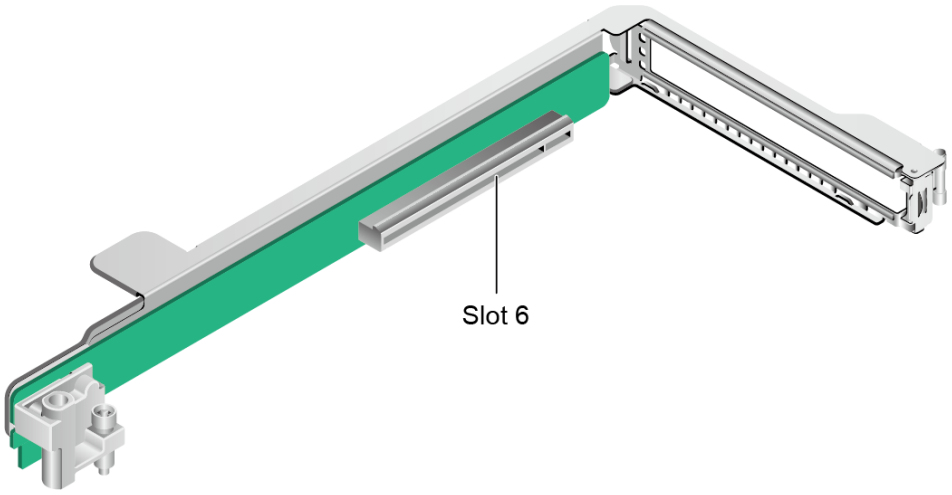
    Figure 5-51 PCIe riser card 5 (BC1M04PRUK)



  - PCIe riser card 2 of I/O module 2 (BC1M01PRUD)

    Provides PCIe slot 6 when installed in I/O module 2.

Figure 5-52 PCIe riser card 6 (BC1M01PRUD)



5.7.3 PCIe Slot Description

NOTE

The PCIe port numbers in table 1 correspond to CPUs. For details about the PCIe port number displayed on the BIOS screen, see the Genoa platform BIOS parameter reference of the server.

Server with Drive Modules or PCIe Riser Modules on the Rear Panel

Table 5-33 PCIe slots

PCIe Riser Card	PCIe Riser Card Installation Position	PCIe Slot on the PCIe Riser Card	PCIe Slot or Port Description	PCIe Port Number	Port Number in the BIOS	PCIe Devices Supported by the PCIe Slot or Port
PCIe riser card 1 of I/O module 1/2	I/O module 1	Slot 1	PCIe 5.0 x 16[a](x16)[b]	G0 Port	-	FHHL
		Slot 2	PCIe 4.0 x16 (x8)	G1 Port-A	-	FHHL
		Slot 3	PCIe 4.0 x16 (x8)	G1 Port-B	-	FHHL
	I/O module 2	Slot 4	PCIe 4.0 x16 (x16)	G3 Port	-	FHHL
		Slot 5	PCIe 4.0 x16 (x8)	G2 Port-A	-	FHHL
		Slot 6	PCIe 4.0 x16 (x8)	G2 Port-B	-	FHHL

PCIe Riser Card	PCIe Riser Card Installation Position	PCIe Slot on the PCIe Riser Card	PCIe Slot or Port Description	PCIe Port Number	Port Number in the BIOS	PCIe Devices Supported by the PCIe Slot or Port
PCIe riser card 2 of I/O module 1/2	I/O module 1	Slot 1	PCIe 5.0 x16 (x16)	G0 Port	-	FHFL
		Slot 2	PCIe 5.0 x16 (x16)	G1 Port	-	FHFL
	I/O module 2	Slot 4	PCIe 5.0 x16 (x16)	G3 Port	-	FHFL
		Slot 5	PCIe 5.0 x16 (x16)	G2 Port	-	FHFL
PCIe riser card 3 of I/O module 1/2	I/O module 1	Slot 2	PCIe4.0 x16 (x16)	G1 Port	-	FHHL
	I/O module 2	Slot 5	PCIe4.0 x16 (x16)	G2 Port	-	FHHL
PCIe riser card 4 of I/O module 1/2	I/O module 1	Slot 2	PCIe 5.0 x16 (x16)	G1 Port	-	FHFL
	I/O module 2	Slot 5	PCIe 5.0 x16 (x16)	G2 Port	-	FHFL
PCIe riser card 5 of I/O module 1	I/O module 1	Slot 2	PCIe 5.0 x16 (x16)	G2 Port	-	FHHL
PCIe riser card 6 of I/O module1	I/O module 1	Slot 2	PCIe 5.0 x16 (x16)	G2 Port	-	FHHL
PCIe riser card 1 of I/O module 3	I/O module 3	Slot 7	PCIe 4.0 x16 (x16)	P2 Port	-	FHHL
		Slot 8	PCIe 4.0 x16 (x16)	P3 Port	-	FHHL
PCIe riser card 2 of I/O module 3	I/O module 3	Slot 7	PCIe 4.0 x16 (x8)	P2 Port-A	-	HHHL
		Slot 8	PCIe 4.0 x16 (x8)	P2 Port-B	-	HHHL
		Slot 9	PCIe 4.0 x16 (x8)	P3 Port-A	-	HHHL

PCIe Riser Card	PCIe Riser Card Installation Position	PCIe Slot on the PCIe Riser Card	PCIe Slot or Port Description	PCIe Port Number	Port Number in the BIOS	PCIe Devices Supported by the PCIe Slot or Port
		Slot 10	PCIe 4.0 x16 (x8)	P3 Port-B	-	HHHL
-	-	FlexIO card 1	PCIe 4.0 x16 (x8 and x16[c])	G0 Port-A	-	OCP 3.0 specifications
-	-	FlexIO card 2	PCIe 4.0 x16 (x8 and x16[c])	G0 Port-B	-	OCP 3.0 specifications

- a: **PCIe 5.0** refers to the PCIe of the fifth generation, and **x16** refers to the physical slot width.
- b: The **x16** in brackets indicates that the link bandwidth is x16.
- c: The default link bandwidth of FlexIO card 1 is x8. The link bandwidth can be extended to x16 using cables.
- The PCIe x16 slots are compatible with PCIe x16, PCIe x8, PCIe x4, and PCIe x1 cards. The bandwidth of the PCIe slot cannot be less than that of the inserted PCIe card.
- The full-height full-length (FHFL) PCIe slots are compatible with FHFL PCIe cards, full-height half-length (FHHL) PCIe cards, and half-height half-length (HHHL) PCIe cards.
- The FHHL PCIe slots are compatible with FHHL PCIe cards and HHHL PCIe cards.
- The maximum power supply of each PCIe slot is 75 W.

Server with Four GPUs on the Rear Panel

Table 5-34 PCIe slots

PCIe Riser Card	PCIe Riser Card Installation Position	PCIe Slot on the PCIe Riser Card	PCIe Slot or Port Description	PCIe Port Number	Port Number in the BIOS	PCIe Devices Supported by the PCIe Slot or Port
PCIe riser card 1 of the rear GPU module	Rear GPU module	Slot 1/slot 4	PCIe 5.0 x16[a] (x16)[b]	P0 Port/P1 Port	-	FHFL

PCIe Riser Card	PCIe Riser Card Installation Position	PCIe Slot on the PCIe Riser Card	PCIe Slot or Port Description	PCIe Port Number	Port Number in the BIOS	PCIe Devices Supported by the PCIe Slot or Port
PCIe riser card 2 of the rear GPU module	Rear GPU module	Slot 7/slot 9	PCIe 5.0 x16 (x16)	P2 Port/ P3 Port	-	FHFL
PCIe Riser module (BC1M01PRUWB)	I/O module 1	Slot 3	PCIe 5.0 x16 (x16)	G1 Port	-	FHFL
PCIe riser card 1 of I/O module 2 (BC1M04PRUK)	I/O module 2	Slot 6	PCIe 5.0 x16 (x16)	G2 Port	-	FHFL

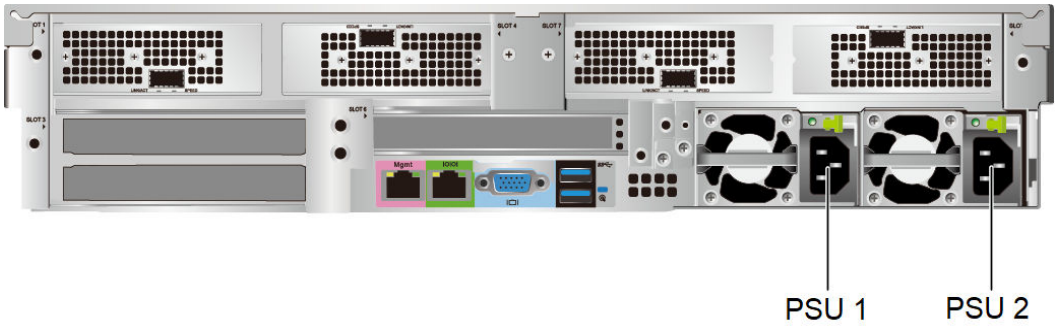
- a: **PCIe 5.0** refers to the PCIe of the fifth generation, and **x16** refers to the physical slot width.
- b: The **x16** in brackets indicates that the link bandwidth is x16.
- The PCIe x16 slots are compatible with PCIe x16, PCIe x8, PCIe x4, and PCIe x1 cards. The bandwidth of the PCIe slot cannot be less than that of the inserted PCIe card.
- The full-height full-length (FHFL) PCIe slots are compatible with FHFL PCIe cards, full-height half-length (FHHL) PCIe cards, and half-height half-length (HHHL) PCIe cards.
- The FHHL PCIe slots are compatible with FHHL PCIe cards and HHHL PCIe cards.
- The maximum power supply of each PCIe slot is 75 W.

5.8 PSUs

- The server supports one or two PSUs.
- Supports AC or DC PSUs.
- The server supports hot swap.
- When two PSUs are configured, 1+1 redundancy is supported.
- PSUs of the same P/N code must be used in a server.
- Short-circuit protection is provided, and bipolar fuses are provided for PSUs that support dual live wire input.

- If the DC power supply is used, purchase the DC power supply that meets the requirements of the safety standards or the DC power supply that has passed the CCC certification.

Figure 5-53 Positions of PSUs (Example: 4-GPU model)



5.9 Fan Modules

- The server supports four or six fan modules.
  - The server supports four 8038 or 8056 fan modules.
  - The server supports six 6065 fan modules.
- For details about fan module configuration rules, see **Table 5-36**.

Table 5-35 Configuring the rules for the Genoa processor fan module type

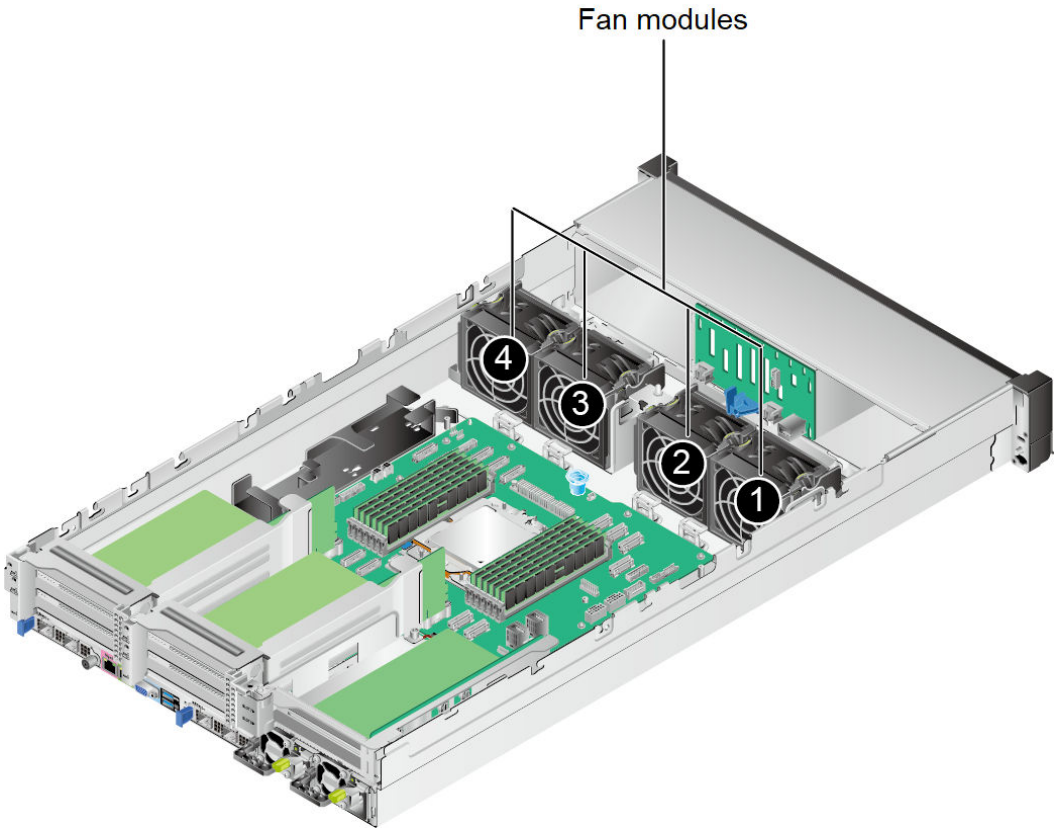
Configuration	8 x 2.5" Drive Configuration	8 x 3.5" Drive Configuration	12 x 3.5" Drive Configuration	24 x 3.5" Drive Configuration
General-purpose model	8038	-	8038[a]	8038
			8056[b]	8056
a: Configuration rules: Rear and internal drive modules are not supported. When memory is no larger than 96 GB, 25 GB or lower network cards/OCP cards are supported. b: Configuration rules: Supports configuring drives on Rear IO Module 1 and IO Module 3, and configuring 100 GB network cards/OCP cards. Built-in drives are not supported.				

Table 5-36 Turin processor fan module configuration rules

Configuration	8 x 2.5" drive configuration	8 x 3.5" Drive Configuration	12 x 3.5" Drive Configuration	24 x 3.5" drive configuration
General-purpose model	8038	6056	8038/8056a or 6056	-
			8056[b]	
GPU Model	-	6056	-	-
a: Configuration rules: Rear and internal drive modules are not supported. Configuration of network cards/OCP cards with 25 GB or lower is supported. b: Configuration rules: Support for configuring drives in rear IO Module 1 and IO Module 3, do not support systems without built-in drives, and support for configuring 100G network cards/OCP cards.				

- Supports hot swap.
- Supports N+1 redundancy. The server runs properly when one fan fails.
- Supports intelligent fan speed adjustment.
- Fan modules of the same part number (P/N code) must be used in a server.

Figure 5-54 Positions of fan modules (example: 8038 fan module)



5.10 Board

5.10.1 Mainboard Components

NOTE

- The mainboard, I/O expansion board, and iBMC card are installed on the same backplate. The I/O expansion board and iBMC card are not provided as separate spare parts, but are bundled with the mainboard as a spare part.
- Genoa models only support Genoa platform mainboards and CPUs, while Turin models only support Turin platform mainboards and CPUs. The mixed use is not supported due to software incompatibility.

Figure 5-55 Common model mainboard components

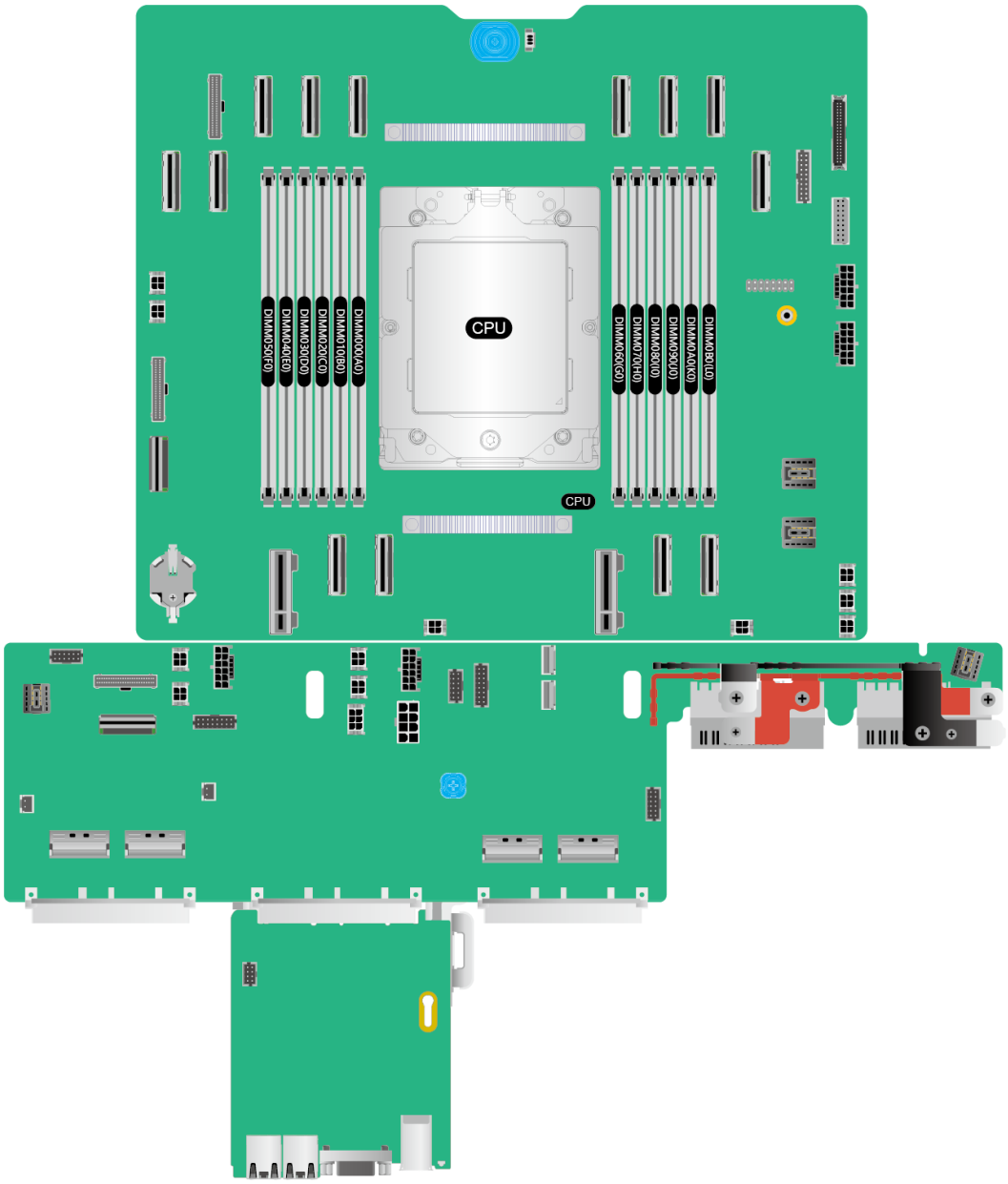
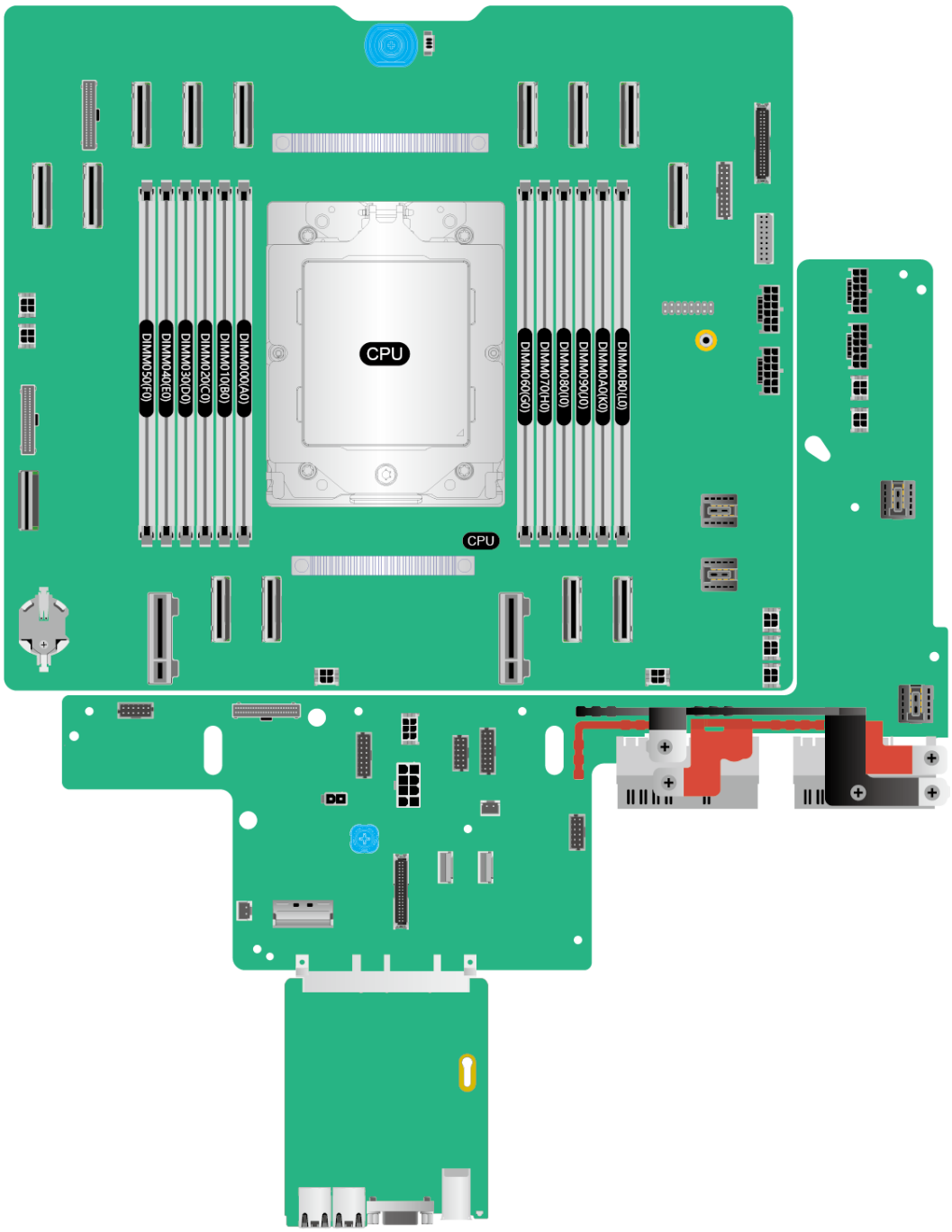
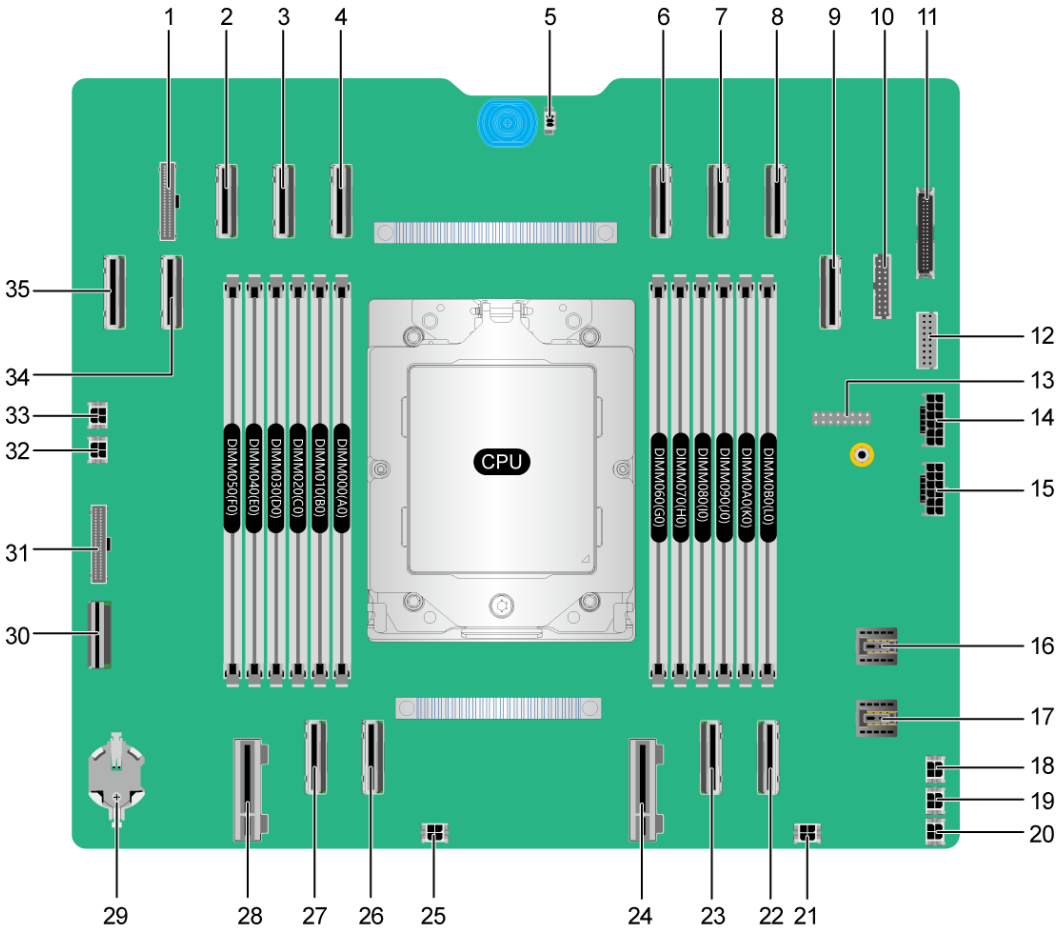


Figure 5-56 GPU Model mainboard component



5.10.1.1 Mainboard

Figure 5-57 Mainboard



1	Right mounting ear connector (R_EAR BOARD/J74)	2	High-speed I/O connector (MCIO 1-1/J141)
3	High-speed I/O connector (MCIO 2-2/J27)	4	High-speed I/O connector (MCIO 2-1/J29)
5	Intrusion sensor connector (INTRUDER CONN/J11)	6	High-speed I/O connector (MCIO 2-4/J30)
7	High-speed I/O connector (MCIO 2-3/J31)	8	High-speed I/O connector (MCIO 1-4/J3)
9	High-speed I/O connector (MCIO 1-3/J2)	10	Left mounting ear connector (L_EAR BOARD/J158)
11	Front-drive backplane signal connector (HDD CONN/J151)	12	RAID & M.2 mezzanine card signal connector (RAID&M.2 CONN/J159)

13	TPM/TCM connector (J63)	14	Built-in drive module power connector (GPU3 PWR/ J153)
15	Rear I/O module 3 power connector (GPU3 PWR/ J152)	16	Mainboard power supply connector 2 (IO BOARD PWR2/J142)
17	Mainboard power supply connector 1 (IO BOARD PWR1/J110)	18	I/O 3 power supply connector (IO3 PWR/J156)
19	I/O 3 power supply connector (IO3 PWR/ 155)	20	I/O 3 power supply connector (IO3 PWR/J154)
21	I/O 2 power supply connector (IO2 PWR/J150)	22	High-speed I/O connector (MCIO 2-8-1/J148)
23	High-speed I/O connector (MCIO 2-8-0/J147)	24	High-speed I/O connector (UBCDD 2-7/J8)
25	I/O 1 power supply connector (IO1 PWR/J149)	26	High-speed I/O connector (MCIO 1-8-0/J145)
27	High-speed I/O connector (MCIO 1-8-1/J146)	28	High-speed I/O connector (UBCDD 1-7/J36)
29	Cell battery holder (J75)	30	I/O expansion board signal connector 1 (I/O BOARD SIGNAL1/J143)
31	I/O expansion board signal connector 2 (I/O BOARD SIGNAL2/J144)	32	I/O 3 power supply connector (IO3 PWR RSVD/J160)
33	I/O 3 power supply connector (IO3 PWR RSVD/J161)	34	High-speed I/O connector (MCIO 1-2/J5)
35	High-speed I/O connector (MCIO 0/J140)	-	-

5.10.1.2 I/O Expansion Board

Figure 5-58 I/O expansion board of the general-purpose model

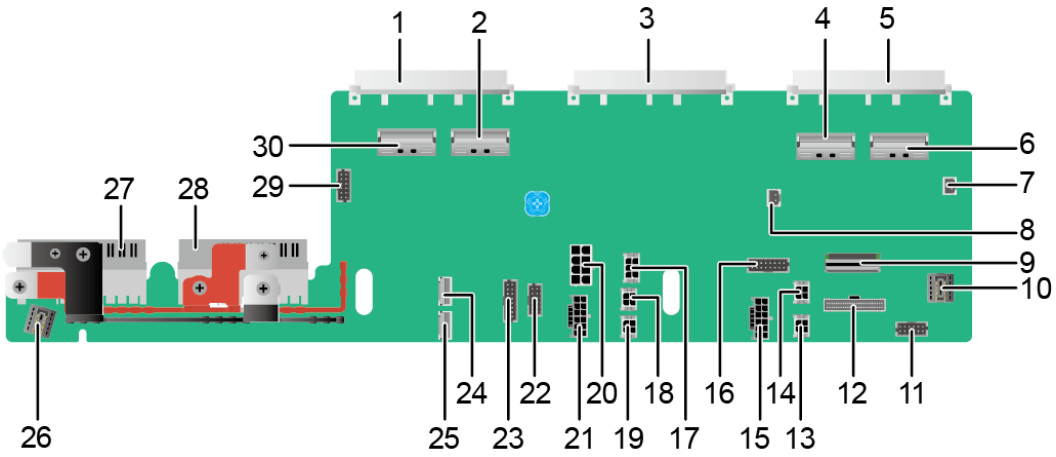


Table 5-37 Ports

1	OCP 3.0 NIC 1 connector (OCP2 CONN/J244)	2	OCP 2 high byte MCIO connector (Flex IO2 MCIO2/ J243)
3	BMC card connector (BMC CONN/J10)	4	OCP 1 low byte MCIO connector (FlexIO1 MCIO1/J138)
5	OCP 3.0 NIC 1 connector (OCP1 CONN/J1)	6	OCP 1 high-order 8 bits MCIO connector (Flex IO1 MCIO2/ J139)
7	Leakage detection connector (LIQUID DET/J246)	8	Leakage detection present connector (LIQUID PRSNT/J245)
9	Slimline signal connector between boards (MB SIGNAL1/ J50)	10	Fan board power connector (FAN PWR/J76)
11	Fan board low-speed connector (FAN BOARD/J15)	12	50-pin signal connector between boards (MB SIGNAL2/J51)
13	I/O 1 75 W standard card power connector (IO1 PWR2/J248)	14	I/O 1 75 W standard card power connector (IO1 PWR3/J249)
15	Rear I/O module 1 power connector (IO1 PWR/J20)	16	DPU signal connector (DPU MISC/J500)
17	DPU 75 W power connector (DPU CEM/J501)	18	I/O 2 75 W standard card power connector (IO2 PWR3/J254)
19	I/O 2 75 W standard card power connector (IO2 PWR2/J253)	20	DPU 300 W power connector (DPU PWR/J77)
21	Rear I/O module 2 power connector (IO2 PWR/J21)	22	NC-SI connector (NCSI CONN/J6)

23	Built-in drive backplane signal connector (INNER BP/J14)	24	Built-in I/O module 3 fan connector (IO3 INNER FAN/ J503)
25	Built-in I/O module 2 fan connector (IO2 INNER FAN/ J502)	26	Front-drive backplane power connector (FRONT HDD PWR/ J210)
27	PSU2	28	PSU1
29	Power connector (PSU HDD/ J13)	30	OCP 2 low 8 byte MCIO connector (FlexIO2 MCIO1/J242)
Note: The configuration of connectors depends on the actual product.			

Figure 5-59 I/O expansion board of the 4-GPU model

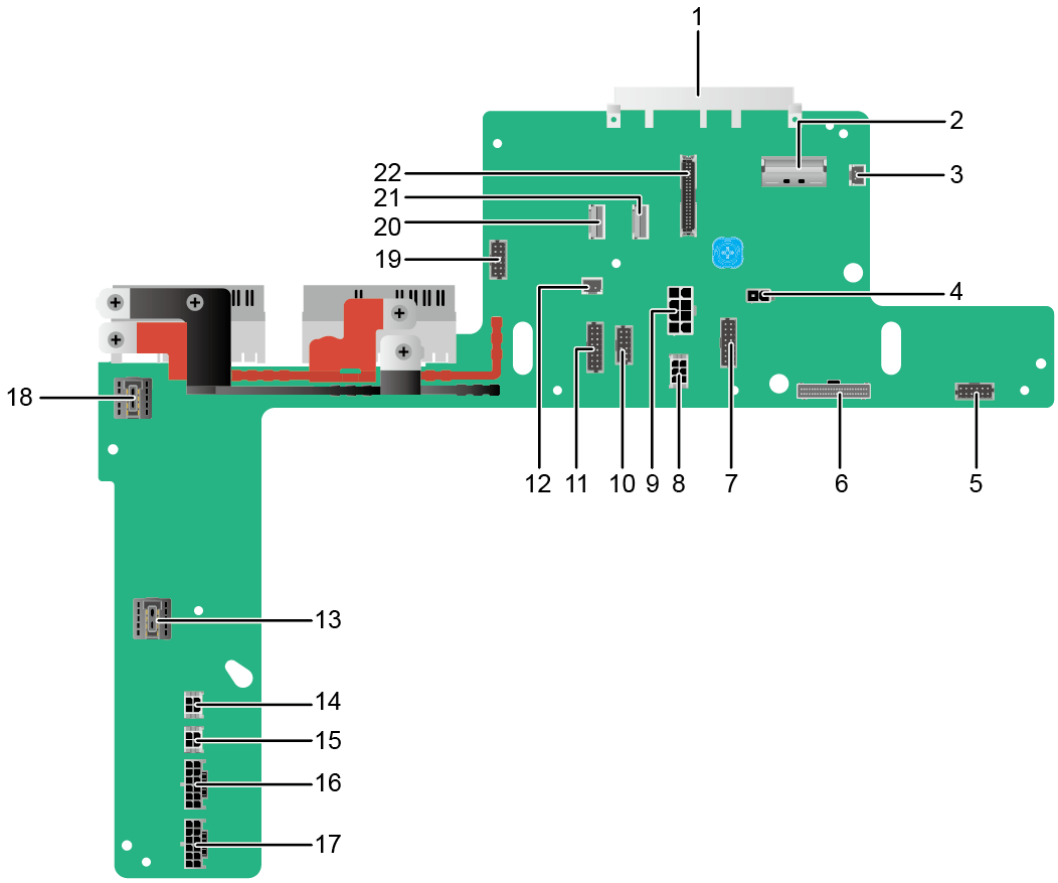


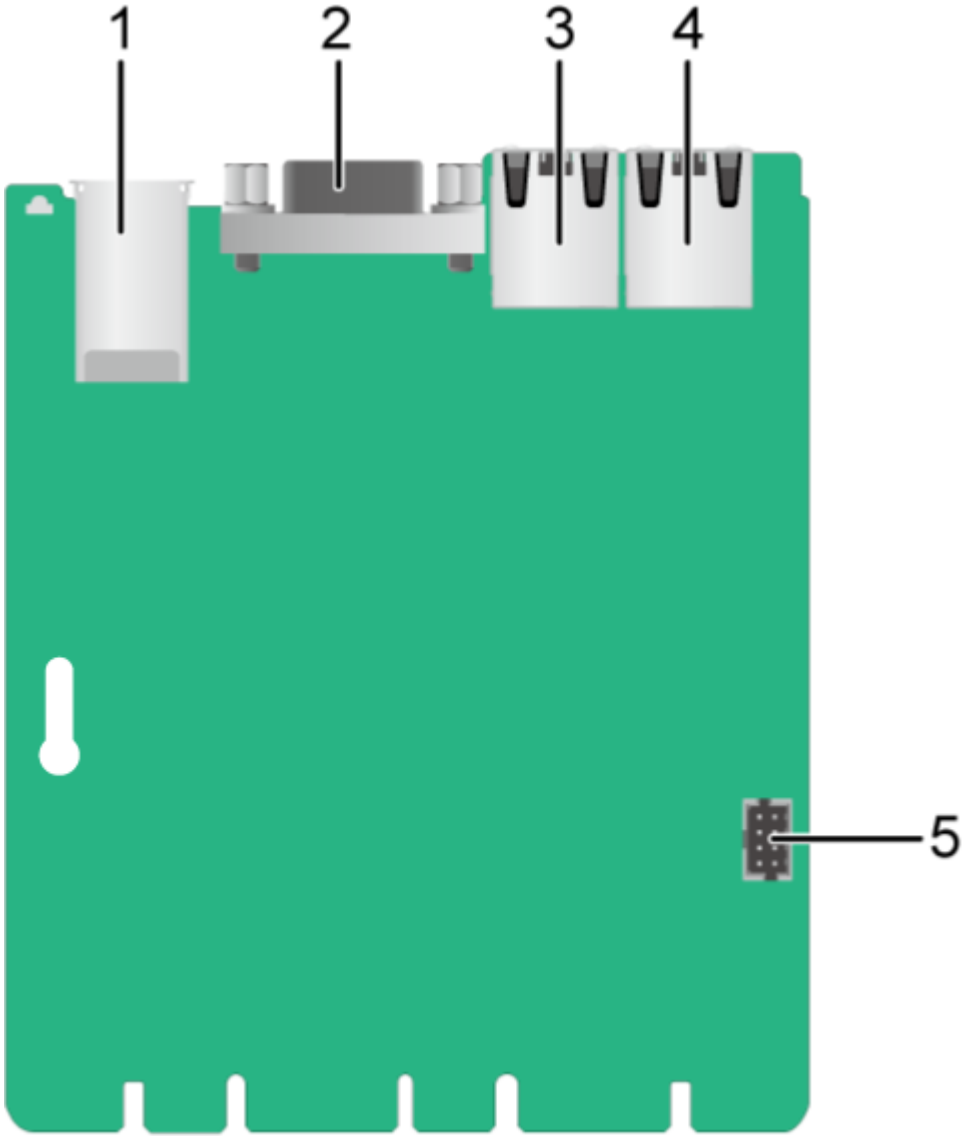
Table 5-38 Ports

1	BMC card connector (BMC CONN/J10)	2	Slimline connector between boards (MB SIGNAL1/J50)
3	Leakage detection present connector (LIQUID PRSNT/ J245)	4	DPU power connector (OCP PWR/J9002)

5	Fan board low-speed connector (FAN BOARD/J15)	6	50-pin signal connector between boards (MB SIGNAL2/J51)
7	DPU low-speed connector (DPU MISC/J500)	8	DPU 75 W power connector (DPU CEM/J501)
9	DPU 300 W power connector (DPU PWR/J77)	10	NC-SI connector (NCSI CONN/J6)
11	Built-in drive backplane signal connector (INNER BP/J14)	12	Leakage detection connector (LIQUID DET/J246)
13	Fan board power connector (FAN PWR/J76)	14	I/O 1 75 W standard card power connector (GPU CEM3/J248)
15	I/O 1 75 W power connector (GPU CEM4/J249)	16	GPU 1 power connector (GPU PWR3/J20)
17	GPU 2 power connector (GPU PWR4/J21)	18	Front-drive backplane power connector (FRONT HDD PWR/ J210)
19	Low-speed power connector (PSU HDD/J13)	20	Built-in I/O module 3 fan connector (IO3 INNER FAN/ J503)
21	Built-in I/O module 2 fan connector (IO2 INNER FAN/ J502)	22	OCP low-speed connector (OCP MISC, J9003)
Note: The configuration of connectors depends on the actual product.			

5.10.1.3 BMC Card

Figure 5-60 BMC card



1	Two USB 3.0 ports (USB3.0 CONN/J88)	2	Rear VGA port (VGA CONN/J60)
3	Serial port (COM/J6020)	4	BMC management port (BMC_GE/J6019)
5	Reserved	-	-

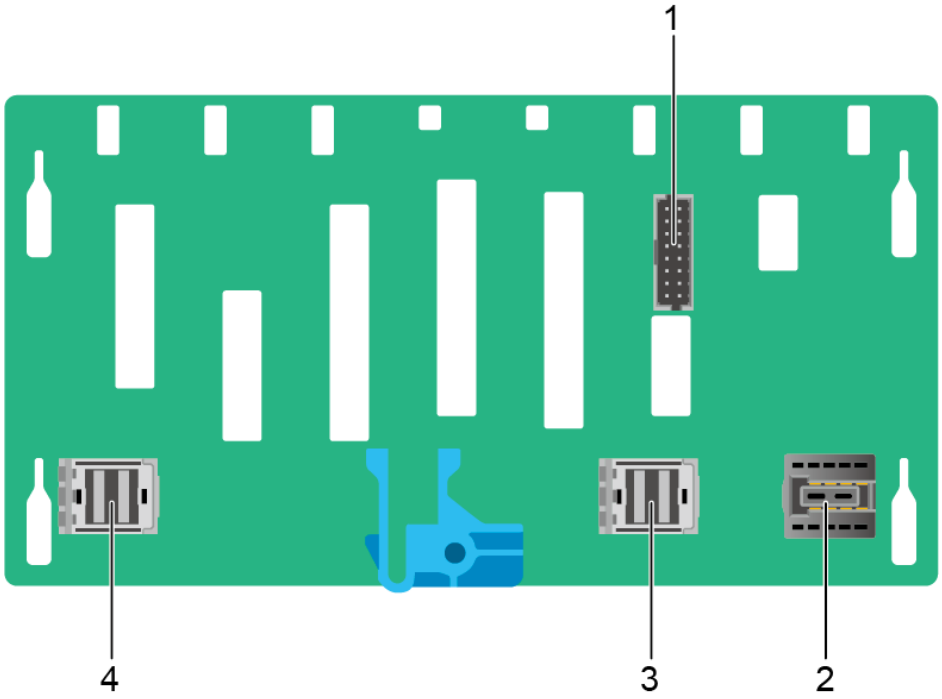
5.10.2 Drive Backplane

Front-Drive Backplane

- 8 x 2.5" drive pass-through configuration backplane

  The "Drive Configuration 1" and "Drive Configuration 2" in the **5.5.1.2.2 8 x 2.5" drive pass-through chassis** support this backplane.

  Figure 5-61 8 x 2.5" drive pass-through configuration backplane

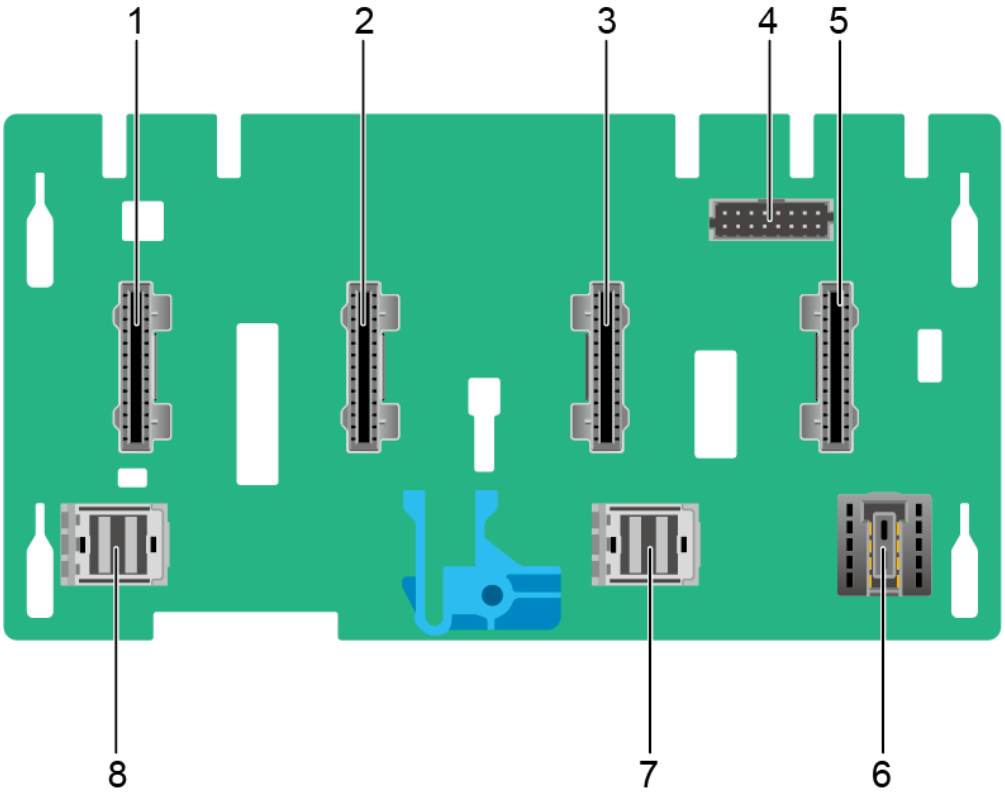


No.	Connector	Managed Drive Slot
1	Backplane signal cable connector (HDD BP/ J12)	-
2	Power connector (HDD_POWER/J14)	-
3	Mini-SAS HD connector (PORT A/J28)	Slots 0 to 3
4	Mini-SAS HD connector (PORT B/J1)	Slots 4 to 7

- 8 x 2.5" drive pass-through configuration backplane
  - The "Drive Configuration 1" and "Drive Configuration 2" in the **5.5.1.1.1 8 x 2.5" drive enclosure - supporting 8x NVMe** support this backplane.
  - The "Drive Configuration 1" and "Drive Configuration 2" in the **5.5.1.2.1 8 x 2.5" drive enclosure - supporting 8x NVMe** support this backplane.

– The "Drive Configuration 1" and "Drive Configuration 2" in the **5.5.1.2.3 8 x 2.5" drive enclosure - supporting 2 x NVMe** support this backplane.

Figure 5-62 8 x 2.5" drive pass-through configuration backplane



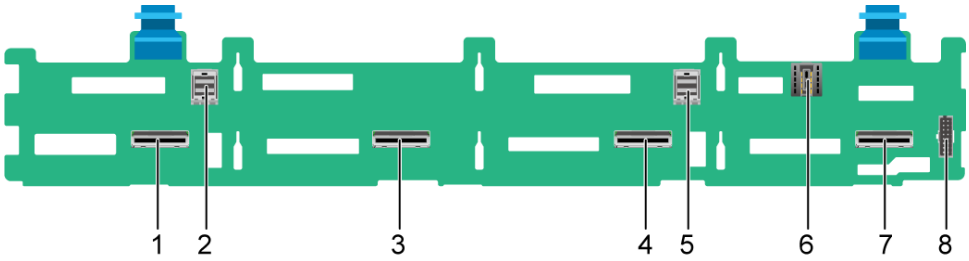
No.	Connector	Managed Drive Slot
1	UBC connector 4 (UBC4/J4)	Slots 6 and 7
2	UBC connector 3 (UBC3/J3)	Slots 4 and 5
3	UBC connector 2 (UBC2/J2)	Slots 2 and 3
4	Backplane signal cable connector (HDD_BP/ J20)	-
5	UBC connector 1 (UBC1/J1)	Slots 0 and 1
6	Power connector (HDD_POWER/J21)	-
7	Mini-SAS HD connector (PORT A/J6)	Slots 0 to 3

No.	Connector	Managed Drive Slot
8	Mini-SAS HD connector (PORT B/J7)	Slots 4 to 7
The current backplane supports PCIe 4.0 NVMe.		

- 8 x 3.5" SAS/SATA/NVMe drive backplane

  All drive configurations in **5.5.1.2.4 8 x 2.5" drive enclosure - supporting 8 x NVMe** and **5.5.1.2.5 8 x 3,5" drive enclosure - supporting 4 x NVMe drives and 4 GPUs** support this backplane.

Figure 5-63 4 x 2.5" SAS/SATA/NVMe drive backplane

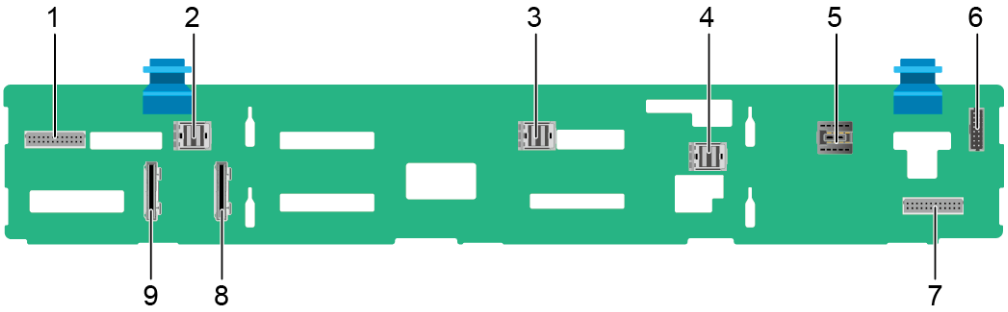


No.	Connector	Managed Drive Slot
1	MCIO high-speed connector (MCIO4/J4)	Slots 6 and 7
2	Mini-SAS HD connector (J7)	Slots 4 to 7
3	MCIO high-speed connector (J3)	Slots 4 and 5
4	MCIO high-speed connector (MCIO2/J2)	Slots 2 and 3
5	Mini-SAS HD connector (MINISAS1/J6)	Slots 0 to 3
6	Backplane power connector (HDD_POWER/J21)	-
7	MCIO high-speed connector (MCIO1/J1)	Slots 0 and 1
8	Backplane signal cable connector (HDD_BP/ J20)	-
The current backplane supports PCIe 5.0 NVMe.		

- 12 x 3.5" SAS/SATA/NVMe drives pass-through backplane

  All drive configurations in **5.5.1.2.4 8 x 2.5" drive enclosure - supporting 8 x NVMe** and **5.5.1.2.5 8 x 3,5" drive enclosure - supporting 4 x NVMe drives and 4 GPUs** support this backplane.

  Figure 5-64 12 x 3.5" SAS/SATA/NVMe drives pass-through backplane

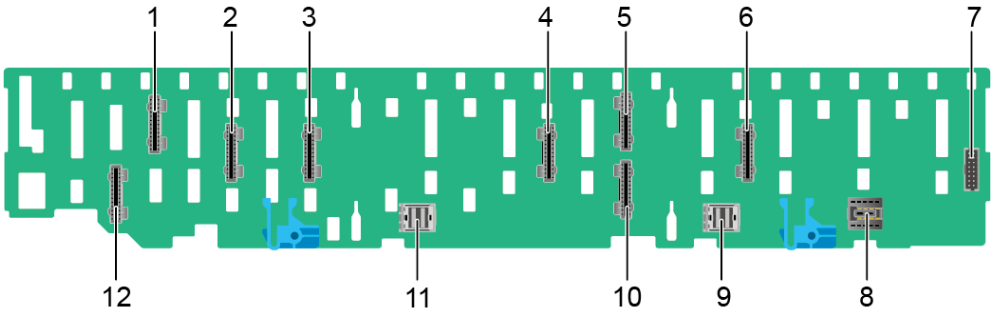


No.	Connector	Managed Drive Slot
1	Indicator signal cable connector (REAR BP0/ J17)	-
2	Mini-SAS HD connector (PORT C/J4)	Slots 8 to 11
3	Mini-SAS HD connector (PORT B/J3)	Slots 4 to 7
4	Mini-SAS HD connector (PORT A/J28)	Slots 0 to 3
5	Power connector (HDD_POWER/J21)	-
6	Backplane signal cable connector (HDD BP/ J19)	-
7	Indicator signal cable connector (REAR BP1/ J18)	-
8	UBC connector 1 (UBC1/J1)	Slots 8 and 9
9	UBC connector 2 (UBC2/J2)	Slots 10 and 11
The current backplane supports PCIe 4.0 NVMe.		

- 8 x SAS/SATA + 16 NVMe pass-through drive backplane

  All drive configurations in **5.5.1.1.3 24 x 2.5" drive enclosure - supporting 16 x NVMe drives** support this backplane.

Figure 5-65 8 x SAS/SATA + 16 NVMe pass-through drive backplane

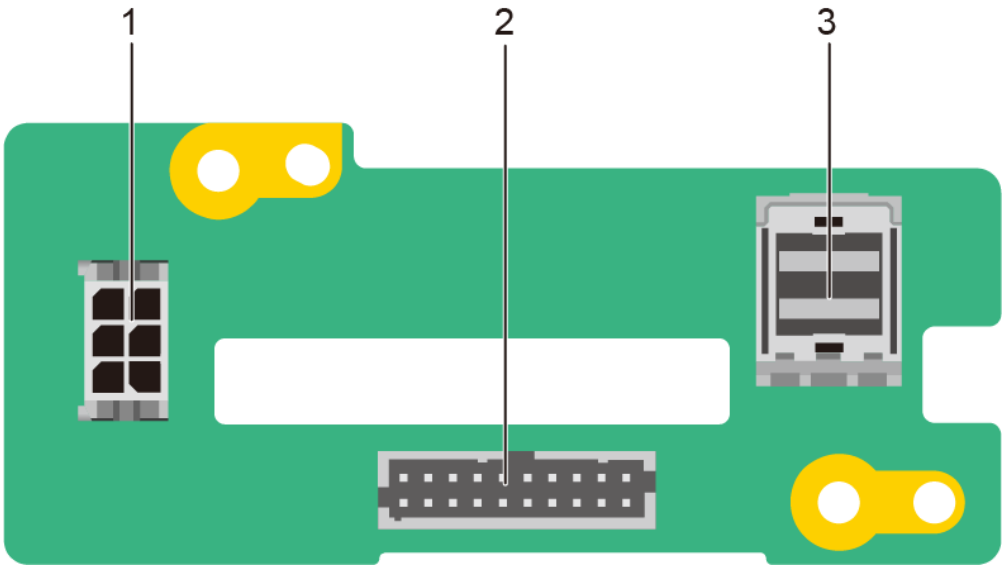


No.	Connector	Managed Drive Slot
1	UBC connector 1-E (UBC1-E/J11)	Slots 20 and 21
2	UBC connector 1-D (UBC1-D/J10)	Slots 18 and 19
3	UBC connector 1-C (UBC1-C/J9)	Slots 16 and 17
4	UBC connector 2-F (UBC2-F/J6)	Slots 10 and 11
5	UBC connector 2-E (UBC2-E/J5)	Slots 8 and 9
6	UBC connector 2-C (UBC2-C/J3)	Slots 4 and 5
7	Backplane signal cable connector (HDD BP/ J40)	-
8	Power connector (HDD_POWER/J41)	-
9	mini-SAS HD connector (PORT A/J13)	Slots 0 to 3
10	UBC connector 2-D (UBC2-D/J4)	Slots 6 and 7
11	Mini-SAS HD connector (PORT B/J14)	Slots 12 to 15
12	UBC connector 1-F (UBC1-F/J12)	Slots 22 and 23
The current backplane supports PCIe 4.0 NVMe.		

Rear-Drive Backplane

- 2 x 2.5" drive backplane

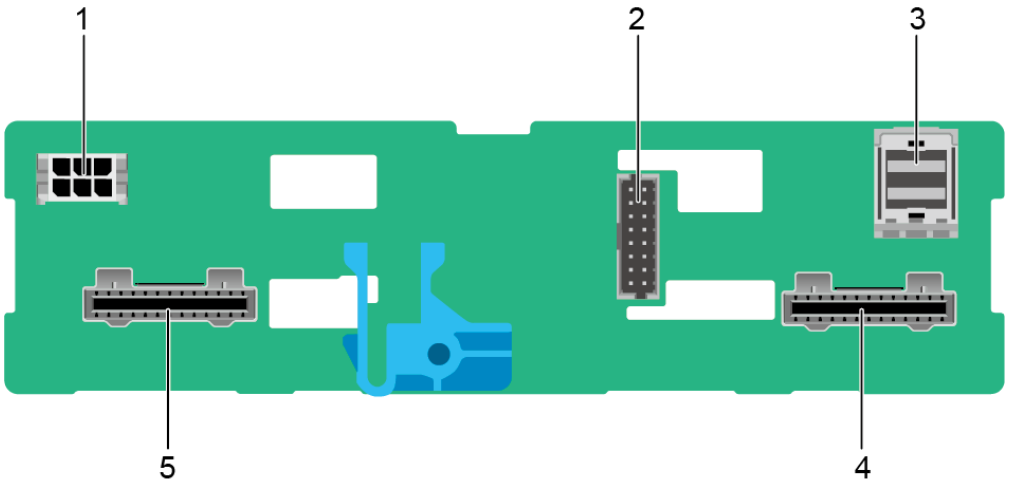
Figure 5-66 2 x 2.5" drive backplane



No.	Connector	Managed Drive Slot
1	Power connector (HDD PWR/J21)	-
2	Backplane signal cable connector (HDD BP/ J17)	-
3	Mini-SAS HD connector (PORT A/J28)	• Management slot for I/O module 1: slots 40 and 41

- 4 x 2.5" SAS/SATA/NVMe drive backplane

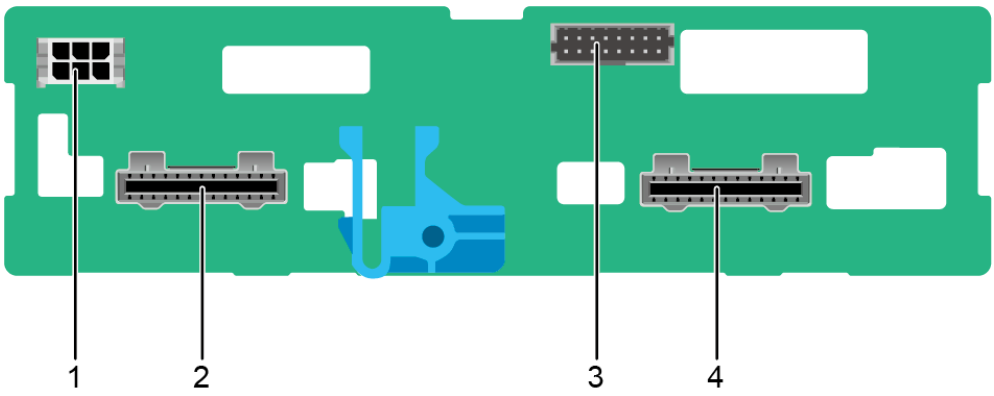
Figure 5-67 4 x 2.5" SAS/SATA/NVMe drive backplane



No.	Connector	Managed Drive Slot
1	Power connector (HDD PWR/J21)	-
2	Backplane signal cable connector (HDD BP/ J1201)	-
3	Mini-SAS HD connector (PORT A/J28)	Slots 44 to 47
4	UBC connector 1 (UBC1/J1)	Slots 44 and 45
5	UBC connector 2 (UBC2/J2)	Slots 46 and 47
The current backplane supports PCIe 4.0 NVMe.		

- 4 x 2.5" NVMe drive backplane

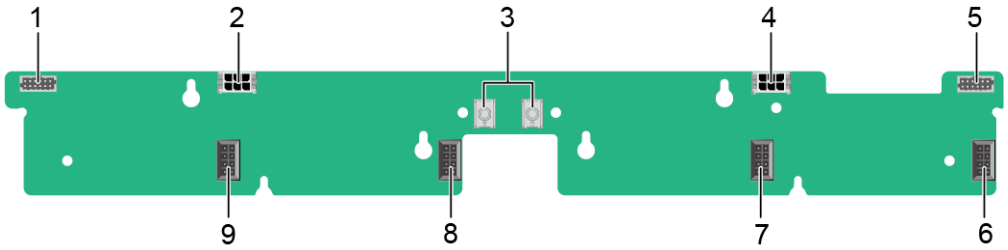
Figure 5-68 4x NVMe drives backplane



No.	Connector	Managed Drive Slot
1	Power connector (HDD_POWER/J21)	-
2	UBC connector 2 (UBC2/J2)	Slot 46 and Slot 47
3	Backplane signal cable connector (HDD BP/J1201)	-
4	UBC connector 1 (UBC1/J1)	Slot 44 and Slot 45
The current backplane supports PCIe 5.0 NVMe.		

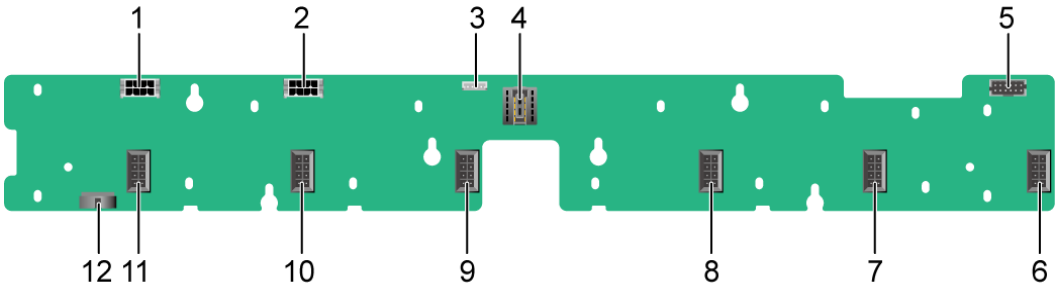
5.10.3 Fan Board

Figure 5-69 Fan board configured with 8038 or 8056 fan modules



1	Fan board signal connector (FAN_BOARD/J3)	2	Reserved and unavailable currently
3	Fan board power connector (J10 GND_BLACK/J11 POWER_RED)	4	Reserved and unavailable currently
5	Reserved and unavailable currently	6	Fan connector (FAN1/J7)
7	Fan connector (FAN2/J6)	8	Fan connector (FAN3/J5)
9	Fan connector (FAN4/J4)	-	-

Figure 5-70 Fan board configured with 6056 fan modules



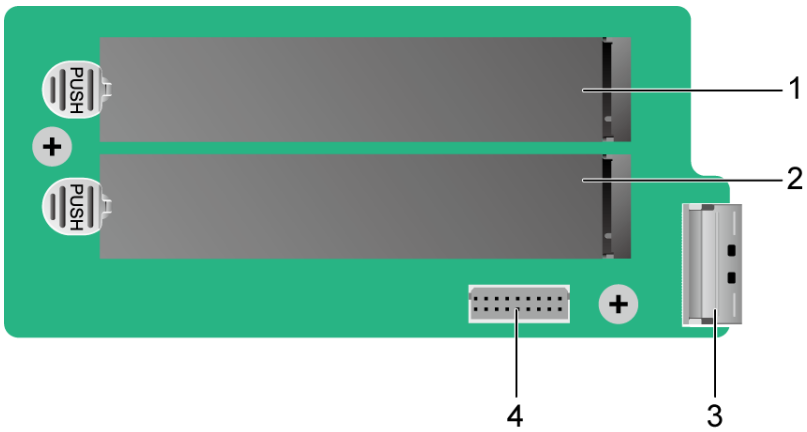
1	Reserved signal connector (LAAC2/J8)	2	Reserved signal connector (LAAC1/J9)
3	Temperature sensor interface (SENSOR/J33)	4	Fan board power input interface (FAN_PWR/J10)
5	Reserved signal connector (LAAC_CONN/J2)	6	Fan 1 connector (FAN1_CONN/J7)
7	Fan 2 connector (FAN2_CONN/J6)	8	Fan 3 connector (FAN3_CONN/J5)
9	Fan 4 connector (FAN4_CONN/J1001)	10	Fan 5 connector (FAN5_CONN/J1101)
11	Fan 6 connector (FAN6_CONN/J1201)	12	Fan board low-speed management interface (FAN_CONN/J3)

5.10.4 Built-in M.2 adapter card

NOTE

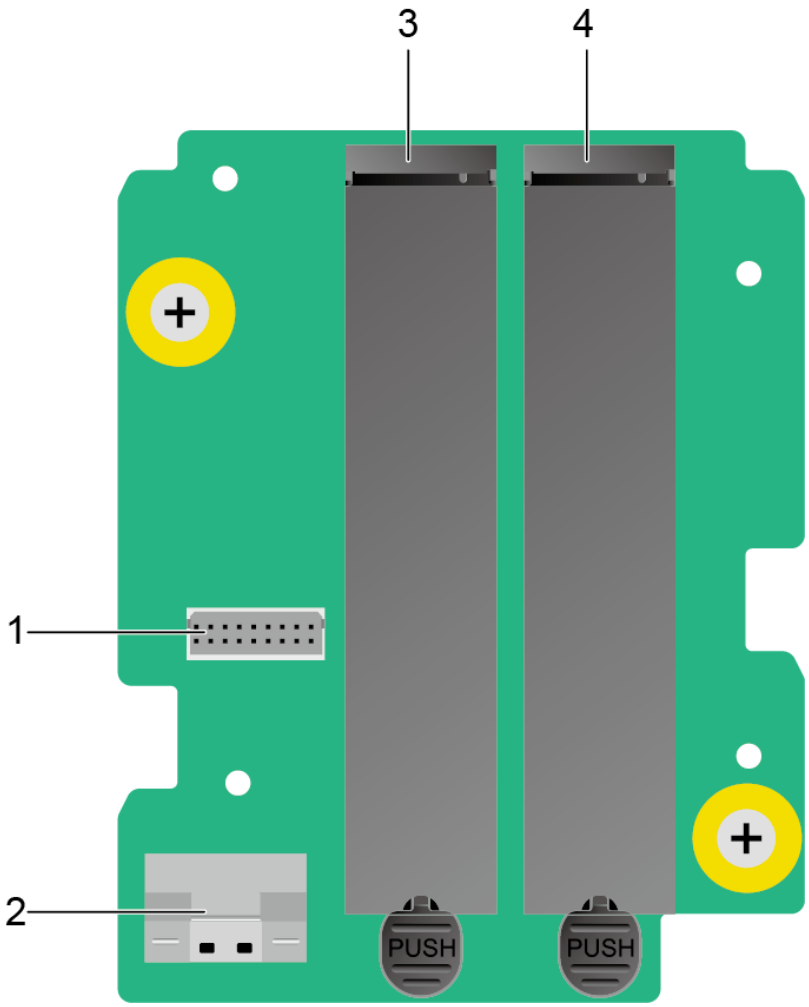
The built-in M.2 adapter card does not support RAID functionality.

Figure 5-71 PCIe-SATA M.2 adapter card



1	M.2 slot (M.2 CONN A)	2	M.2 slot (M.2 CONN B)
3	MCIO connector (J1)	4	M.2 CONN connector (J4)

Figure 5-72 CPU pass-through M.2 adapter card



1	Signal connector (J1)	2	High-speed connector (J2)
3	M.2 slot (M.2 Conn A)	4	M.2 slot (M.2 Conn B)

6 Specifications

6.1 Technical Specifications

Table 6-1 Technical specifications

Component	Specifications
Form factor	2U 1-socket rack server
Processor	Supports one processor. ● The server supports the 4th generation AMD EPYC®™ 9004 series (Genoa) processors or 5th generation AMD EPYC®™ 9005 series (Turin) processors. ● Built-in memory controller and 12 memory channels per processor ● Built-in PCIe controller, supporting PCIe 5.0 and 128 lanes per processor ● Up to 192 cores ● Max. 5 GHz turbo frequency ● Max. 512 MB L3 cache per CPU ● Max. 550 W thermal design power (TDP) **NOTE** The preceding information is for reference only. For details, see "Search Parts" in the compatibility list on the technical support website.

Component	Specifications
Memory	The server supports 12 DIMM slots. ● Up to 12 DDR5 DIMMs. – RDIMM or RDIMM-3DS support. – Genoa has a maximum memory transfer rate of 5600 MT/s, and Turin has a maximum memory transfer rate of 6400 MT/s. – DDR5 memory modules of different types (RDIMM and RDIMM-3DS) and specifications (capacity, bit width, rank, and height) cannot be used together. – A server must use DDR5 DIMMs of the same P/N code. **NOTE** The preceding information is for reference only. For details, see "Search Parts" in the compatibility list on the technical support website.

Component	Specifications
Storage	Supports a variety of drive configurations. For details, see **5.5.1 Drive Configuration and Drive Numbering Format Modification**. ● Supports two M.2 SSDs. – Supports two CPU direct out SATA M.2 SSDs. RAID is not supported. **NOTE** ● The M.2 SSD is used only as a boot device for installing the OS. Small-capacity (32 GB or 64 GB) M.2 SSDs do not support logging due to poor endurance. If a small-capacity M.2 SSD is used as the Boot device, a dedicated log drive or log server is required for logging. For example, you can dump VMware logs in either of the following ways: ● Redirect **/scratch**. For details, see **https://kb.vmware.com/s/article/1033696**. ● Configure syslog. For details, see **https://kb.vmware.com/s/article/2003322**. ● The M.2 SSD cannot be used to store service data due to poor endurance. In write-intensive applications, the M.2 SSD will wear out in a short time. If you want to use SSDs or HDDs as data storage devices, use enterprise-level SSDs or HDDs with high DWPD. ● The M.2 SSD is not recommended for write-intensive service software due to poor endurance. ● Do not use M.2 SSDs for cache. ● Supports hot swap of SAS/SATA/NVMe U.2 drives. ● A variety of RAID controller cards. For details, see "Search Parts" in the Compatibility List on the support website. – The RAID controller card supports RAID configuration, RAID level migration, and drive roaming. – The RAID controller card supports a supercapacitor for power-off protection to ensure user data security. – The PCIe RAID controller card occupies one PCIe slot. For details about the RAID controller card, see the server *RAID Controller Card User Guide*.

Component	Specifications
Network	OCP 3.0 NICs provide network expansion capabilities. ● Two OCP 3.0 NICs, which can be configured as required. ● Orderly hot swap is supported. ● Supports multiple OCP 3.0 network cards. For details, see "Component Compatibility" in the compatibility list on the technical support website.
I/O expansion	Supports 10 PCIe slots. ● Two FlexIO expansion slots dedicated for OCP 3.0 NICs and three standard PCIe expansion slots. For details, see **5.7.2 PCIe Slots** and **5.7.3 PCIe Slot Description**. **NOTE** The preceding information is for reference only. For details, see "Search Parts" in the compatibility list on the technical support website.
Ports	Supports a variety of ports. ● Ports on the front panel: – One USB Type-C iBMC direct connect management port – Two USB 3.0 ports – One DB15 VGA port ● Ports on the rear panel: – Two USB 3.0 ports – One DB15 VGA port – One RJ45 serial port – One RJ45 management network port **NOTE** You are not advised to install the OS on the USB storage media.
Graphics card	An SM750 video chip with 32 MB display memory is integrated on the mainboard. The maximum display resolution is 1920 x 1200 at 60 Hz with 16M colors. 32 MB **NOTE** The integrated video card can provide the maximum display resolution (1920 x 1200) only after the video card driver matching the OS version is installed. Otherwise, only the default resolution supported by the OS is provided.
System management	● UEFI ● iBMC ● NC-SI ● Integration with third-party management systems

Component	Specifications
Security feature	• Power-on password • Administrator password • TPM (for China and outside China)/TCM (only for China) • Secure boot • Front bezel (optional) • Chassis cover opening detection

6.2 Environmental Specifications

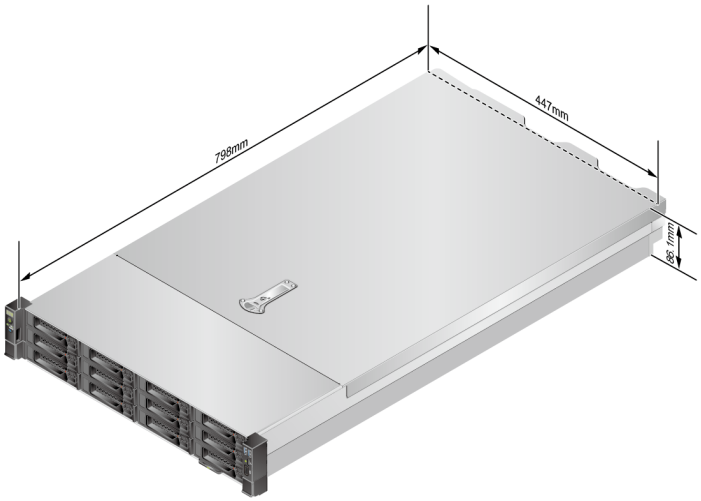
Table 6-2 Environmental specifications

Item	Specifications
Temperature	• Operating temperature: 5ºC to 45ºC (41ºF to 113ºF) (ASHRAE Classes A1 to A4 compliant) • Storage temperature (within three months): –30°C to +60°C (–22°F to +140°F) • Storage temperature (within six months): –15°C to +45°C (5°F to 113°F) • Storage temperature (within one year): –10°C to +35°C (14°F to 95°F) • Maximum temperature change rate: 20°C (36°F) per hour and 5°C (9°F) per 15 minutes **NOTE** The operating temperature limitation varies depending on the server configuration. For details, see **A.3 Operating Temperature Limitations**.
Relative humidity (RH, non-condensing)	• Operating humidity: 8% to 90% • Storage humidity (within three months): 8% to 85% • Storage humidity (within six months): 8% to 80% • Storage humidity (within one year): 20% to 75% • Maximum change humidity rate: 20% per hour • Operational climatic range category 8% RH with -12°C (10.4°F) minimum dew point to 90% RH with 24°C (75.2°F) maximum dew point (ASHRAE Classes A4 compliant)
Air volume	≥ 96 CFM

Item	Specifications
Operating altitude	≤ 3050 m (10,006.56 ft) ● When the server configuration complies with ASHRAE Classes A1 and A2 and the altitude is above 900 m (2952.76 ft), the highest operating temperature decreases by 1ºC (1.8°F) for every increase of 300 m (984.25 ft). ● When the server configuration complies with ASHRAE Class A3 and the altitude is above 900 m (2952.76 ft), the highest operating temperature decreases by 1ºC (1.8°F) for every increase of 175 m (574.15 ft). ● When the server configuration complies with ASHRAE Class A4 and the altitude is above 900 m (2952.76 ft), the highest operating temperature decreases by 1ºC (1.8°F) for every increase of 125 m (410.10 ft). ● HDDs cannot be used at an altitude of over 3050 m (10,006.56 ft).
Corrosive airborne contaminants	Maximum growth rate of the corrosion product thickness: ● Copper corrosion rate test: 300 Å/month (meeting level G1 requirements of the ANSI/ISA-71.04-2013 standard on gaseous corrosion) ● Silver corrosion rate test: 200 Å/month
Particle contaminant	● Meets the requirements of ISO 14664-1 Class 8. ● There is no explosive, conductive, magnetic, or corrosive dust in the equipment room. **NOTE** It is recommended that the particulate pollution in the equipment room be monitored by a professional agency.
Acoustic noise	The declared A-weighted sound power levels (LWAd) and declared average bystander position A-weighted sound pressure levels (LpAm) listed are measured at 23°C (73.4°F) in accordance with ISO 7779 (ECMA 74) and declared in accordance with ISO 9296 (ECMA 109). ● Idle: – LWAd: 5.23 Bels – LpAm: 40.3 dBA ● Operating: – LWAd: 5.23 Bels – LpAm: 40.3 dBA **NOTE** Actual sound levels generated during operation vary depending on the configuration, load, and ambient temperature.

6.3 Physical Specifications

Table 6-3 Physical specifications

Category	Description
Dimensions (H x W x D)	• 3.5" drive enclosure (universal model): 86.1 mm × 447 mm × 798 mm • 3.5" drive enclosure (GPU model): 86.1 mm × 447 mm × 802 mm • Chassis with 2.5" drives: 86.1 mm x 447 mm x 798 mm (3.39 in. x 17.60 in. x 31.42 in.) **Figure 6-1** Physical dimensions (example: a chassis with 3.5" drives)  **NOTE** • See **Figure 6-1** for methods of measuring physical dimensions of the chassis. • The image is for illustration purposes using a 3.5-inch hard drive chassis (general-purpose server) as an example.

Category	Description
Installation space	● Requirements for cabinet installation: Cabinet compliant with the International Electrotechnical Commission (IEC) 297 standard – Cabinet width: 482.6 mm (19.00 in.) – Cabinet depth ≥ 1000 mm (39.37 in.) ● Requirements for guide rail installation: – L-shaped guide rails: apply only to our company's cabinets. – Adjustable L-shaped guide rails: apply to cabinets with a distance of 543.5 mm to 848.5 mm (21.40 in. to 33.41 in.) between the front and rear mounting bars. – Ball bearing rail kit: applies to cabinets with a distance of 609 mm to 950 mm (23.98 in. to 37.40 in.) between the front and rear mounting bars.
Weight in full configuration	● Net weight: – Maximum weight for a server with 8 x 2.5" front drives: 22.5 kg (49.60 lb) – Maximum weight for server with 8 x 3.5" drives in pass-through configuration: 28.5 kg – Maximum weight for server with 12 x 3.5" front drives: 35.5 kg (78.26 lb) – Maximum weight for server with 24 x 2.5" front drives: 25.5 kg (56.22 lb) ● Packaging materials: 5 kg (11.03 lb)
Power consumption	The power consumption parameters vary with hardware configurations (including the configurations complying with EU ErP). For details, see Power Calculator on the technical support website.

7 Software and Hardware Compatibility

For details about the OS and hardware, see the compatibility list on the technical support website.

NOTICE

- If incompatible components are used, the device may be abnormal. Such a fault is beyond the scope of technical support and warranty.
- The performance of servers is closely related to application software, basic middleware software, and hardware. The slight differences of the application software, middleware basic software, and hardware may cause performance inconsistency between the application layer and test software layer.
  - If the customer has requirements on the performance of specific application software, contact technical support to apply for proof of concept (POC) tests in the pre-sales phase to determine detailed software and hardware configurations.
  - If the customer has requirements on hardware performance consistency, specify the specific configuration requirements (for example, specific drive models, RAID controller cards, or firmware versions) in the presales phase.

8 Safety Instructions

8.1 Security

General Statement

- Comply with local laws and regulations when installing equipment. These safety instructions are only a supplement.
- Observe the safety instructions that accompany all "DANGER", "WARNING", and "CAUTION" symbols in this document.
- Observe all safety instructions provided on device labels.
- Operators of special types of work (such as electricians, operators of electric forklifts, and so on.) must be certified or authorized by the local government or authority.

⚠ WARNING

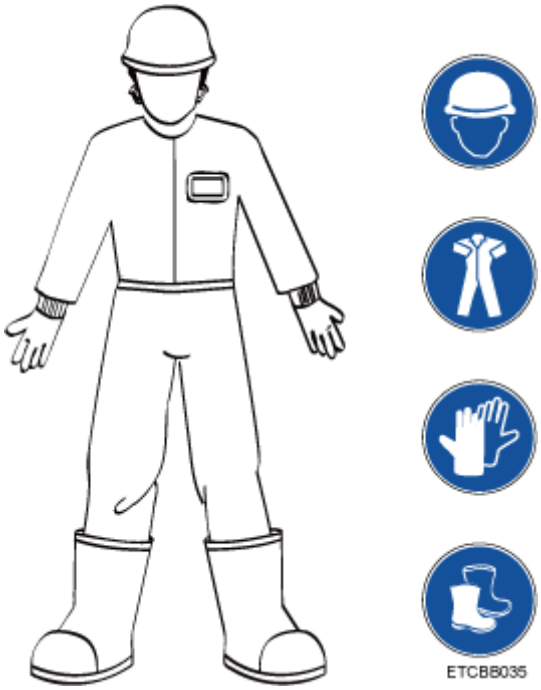
In a household scenario, operation of this device may cause radio interference.

Human Safety

- This device is not suitable for use in places where children may be present.
- Only certified or authorized personnel are allowed to install equipment.
- Discontinue any dangerous operations and take protective measures. Report anything that could cause personal injury or device damage to a project supervisor.
- Do not move devices or install cabinets and power cables in hazardous weather conditions.
- Do not carry the weight that exceeds the maximum load per person allowed by local laws or regulations. Before moving a device, check the maximum device weight and arrange required personnel.

- Wear clean protective gloves, ESD clothing, a protective hat, and protective shoes, as shown in **Figure 8-1**.

Figure 8-1 Safety work wear



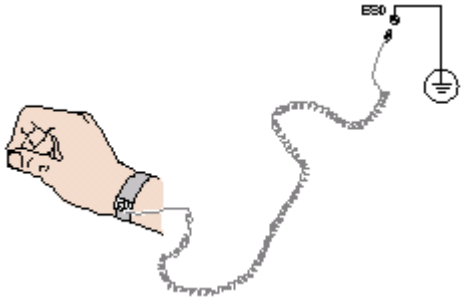
- Before touching a device, wear ESD clothing and gloves (or wrist strap), and remove any conductive objects (such as watches and jewelry). **Figure 8-2** shows conductive objects that must be removed before you touch a device.

Figure 8-2 Removing conductive objects

Figure 8-3 shows how to wear an ESD wrist strap.

a. Secure the ESD wrist strap around your wrist.
b. Fasten the strap buckle and ensure that the ESD wrist strap is in contact with your skin.
c. Insert the ground terminal attached to the ESD wrist strap into the jack on the grounded cabinet or chassis.

Figure 8-3 Wearing an ESD wrist strap



- Exercise caution when using tools that could cause personal injury.
- If the installation position of a device is higher than the shoulders of the installation personnel, use a vehicle such as a lift to facilitate installation. Prevent the device from falling down and causing personal injury or damage to the device.
- The equipment is powered by high-voltage power sources. Direct or indirect contact (especially through damp objects) with high-voltage power sources may result in serious injury or death.
- Ground a device before powering it on. Otherwise, high voltage leakage current may cause personal injury.
- When a ladder is used, ensure that another person holds the ladder steady to prevent accidents.
- Do not look into optical ports without eye protection when installing, testing, or replacing optical cables.

Equipment Safety

- Use the recommended power cables at all times.
- Power cables are used only for dedicated servers. Do not use them for other devices.
- Before operating equipment, wear ESD clothes and gloves to prevent electrostatic-sensitive devices from being damaged by ESD.
- When moving a device, hold the bottom of the device. Do not hold the handles of the installed modules, such as the PSUs, fan modules, drives, and the mainboard. Handle the equipment with care.
- Exercise caution when using tools that could cause damage to devices.
- Connect the primary and secondary power cables to different power distribution units (PDUs) to ensure reliable system operation.
- Ground a device before powering it on. Otherwise, high voltage leakage current may cause device damage.

Transportation Precautions

Improper transportation may damage equipment. Contact the manufacturer for precautions before attempting transportation.

Transportation precautions include but are not limited to:

- The logistics company engaged to transport the device must be reliable and comply with international standards for transporting electronics. Ensure that the

equipment being transported is always kept upright. Take necessary precautions to prevent collisions, corrosion, package damage, damp conditions and pollution.

- Transport each device in its original packaging.
- If the original packaging is unavailable, package heavy, bulky parts (such as chassis and blades) and fragile parts (such as PCIe cards and optical modules) separately.

  NOTE

  For details about components supported by the server, see "Search Parts" in the compatibility list on the technical support website.
- Power off all devices before transportation.

Maximum Weight Carried by a Person

CAUTION

The maximum weight allowed to be carried by a single person is subject to local laws or regulations. The markings on the device and the descriptions in the documentation are for reference only.

Table 8-1 lists the maximum weight one person is permitted to carry as stipulated by a number of organizations.

Table 8-1 Maximum weight carried per person

Organization	Weight (kg/lb)
European Committee for Standardization (CEN)	25/55.13
International Organization for Standardization (ISO)	25/55.13
National Institute for Occupational Safety and Health (NIOSH)	23/50.72
Health and Safety Executive (HSE)	25/55.13
General Administration of Quality Supervision, Inspection and Quarantine of the People's Republic of China (AQSIQ)	• Male: 15/33.08 • Female: 10/22.05

For more information about security instructions, see the server *Safety Information*.

8.2 Maintenance and Warranty

For details about maintenance, visit the **Technical Support Website** > **Service Support Center** > **Customer Support Service**.

For details about warranty, visit the **Technical Support Website** > **Service Support Center** > **Warranty**.

9 System Management

This product integrates the new-generation Intelligent Baseboard Management Controller (iBMC), which complies with Intelligent Platform Management Interface 2.0 (IPMI 2.0) specifications and provides reliable hardware monitoring and management.

The iBMC intelligent management system has the following features:

- Various management interfaces

  The iBMC provides the following standard interfaces to meet various system integration requirements:

  – DCMI 1.5 interface
  – IPMI 1.5/IPMI 2.0 interface
  – Command-line interface (CLI)
  – Redfish interface
  – Hypertext Transfer Protocol Secure (HTTPS) interface
  – Simple Network Management Protocol (SNMP) interface

- Fault monitoring and diagnosis

  The iBMC detects hidden risks and ensures stable, uninterrupted 24/7 system operation by providing the following features:

  – The iBMC allows screenshots and videos to be created when the system breaks down, facilitating cause analysis of the system breakdown.
  – The iBMC offers screen snapshots and videos, simplifying routine preventive maintenance, recording, and auditing.
  – The iBMC supports the reporting of alarms through syslog packets, trap packets, and emails, helping the upper-layer NMS to collect the fault information about the server.
  – The LCD can directly obtain device information from the iBMC.

- Security management

  – The iBMC uses image mirroring to improve system security. Even if the running software breaks down, the system can start from the backup image.
  – Diversified user security control interfaces are provided to ensure user login security.

  - The iBMC supports import and replacement of multiple types of certificates to ensure data transmission security.
- System maintenance interface
  - The iBMC supports keyboard, video, and mouse (KVM) and virtual media to facilitate remote maintenance.
  - The iBMC supports out-of-band monitoring and configuration of RAID, improving RAID configuration efficiency and management.
  - Smart Provisioning provides a convenient operation interface for installing the OS, configuring RAID, and performing the upgrade without a CD-ROM.
- Diversified network protocols
  - The iBMC supports the Network Time Protocol (NTP) to facilitate time settings and ensure time synchronization.
  - The iBMC supports domain management and directory services to simplify network management.
- Intelligent power management
  - The iBMC uses power capping to improve deployment density.
  - The iBMC uses dynamic power saving to reduce operational expenditure (OPEX).
- License management

  By managing licenses, you can use the features of the iBMC advanced edition in authorization mode.

  The advanced edition of the iBMC provides the following features:
  - Deploy OS through the Redfish interface.
  - Collect the original data of intelligent diagnosis using Redfish.

10 Certifications

Country/Region	Certification	Standard
Europe	WEEE	2012/19/EU
Europe	REACH	EC NO. 1907/2006
Europe	CE	Safety: EN 62368-1:2014+A11:2017 EMC: EN 55032:2015+A11:2020 EN IEC 61000-3-2:2019+A1:2021 EN 61000-3-3:2013+A2:2021 EN 55035:2017+A11:2020 CISPR 32:2015+A1:2019 CISPR 35:2016 ETSI EN 300 386 V2.2.1:2022 RoHS: EN IEC 63000:2018 ErP: Commission Regulation(EU) No 2019/424
China	CCC	GB 17625.1-2022 GB 4943.1-2022 GB/T 9254.1-2021
China	RoHS	SJ/T-11364 GB/T 26572
Global	CB	IEC 62368-1:2014 IEC 62368-1:2018

11 Waste Product Recycling

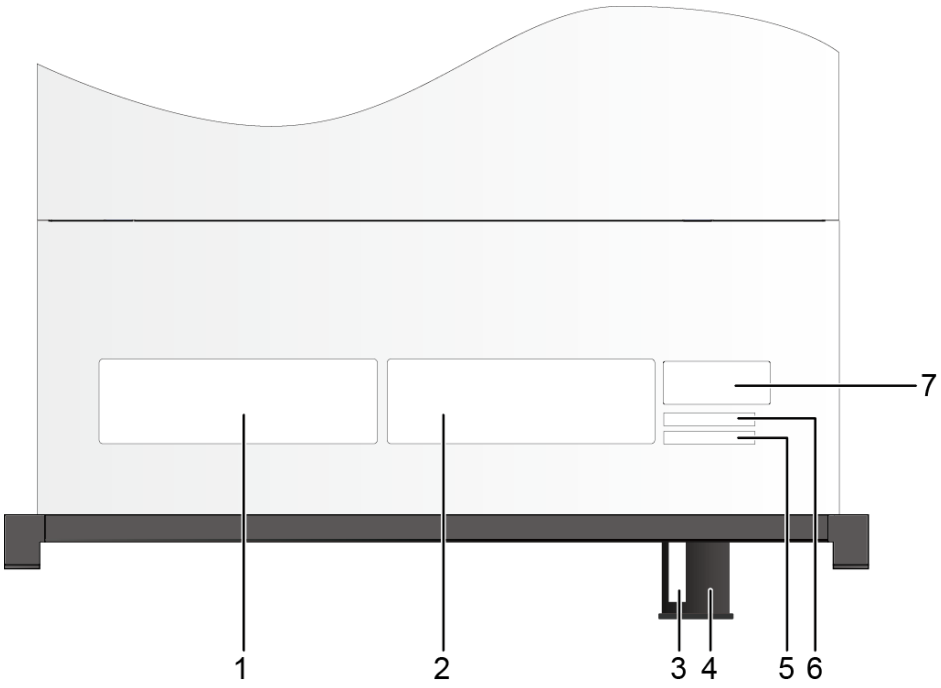
To obtain the product recycling service from xFusion after products are scrapped, contact 400-009-8999 for technical support.

A Appendix

A.1 Chassis Label Information

A.1.1 Chassis Head Label

Figure A-1 Chassis head label



1	Nameplate	2	Certificate and Quick Access Label

3	Product SN **NOTE** For details, see **A.2 Product SN**.	4	Slide-out label plate **NOTE** The location of the slide-out label plate varies depending on the server model or configuration. For details, see **5.1.1 Appearance**.
5	Product SN **NOTE** For details, see **A.2 Product SN**.	6	Reserved space for the customized label
7	Pressure-proof label **NOTE** This label warns users not to place any objects on top of a rack-mounted device.	-	-

A.1.1.1 Nameplate

Figure A-2 Nameplate example

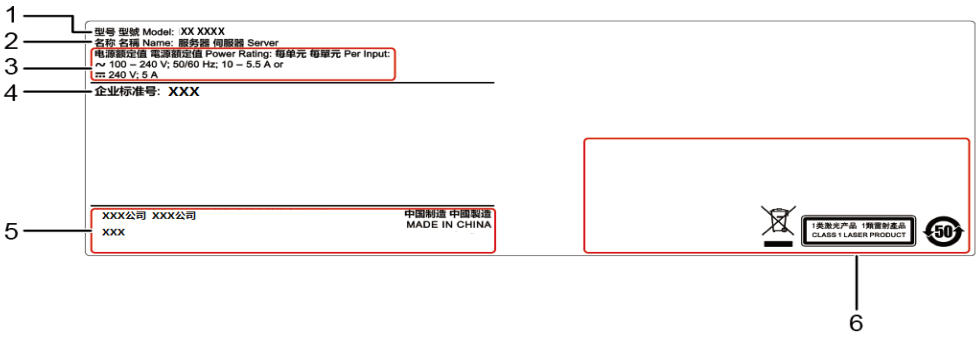


Table A-1 Nameplate description

No.	Description
1	Server model **NOTE** For details, see **A.4 Nameplate**.
2	Device name
3	Power supply requirements
4	Enterprise standard number
5	Vendor information
6	Certification marks

A.1.1.2 Certificate

Figure A-3 Certificate example

Table A-2 Certificate description

No.	Description
1	Order
2	No. **NOTE** For details, see **Figure A-4** and **Table A-3**.
3	QC inspector
4	Production date
5	No. barcode

Figure A-4 Certificate number example

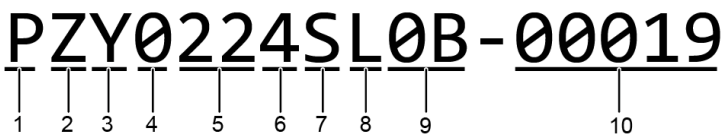


Table A-3 Certificate number description

No.	Description
1	**P**: a fixed value for this digit
2	**Z**: a fixed value for this digit
3	• **Y**: a server • **B**: a semi-finished server • **N**: a spare part

No.	Description
4	**0**: a value for the reserved digit
5	Year (two characters)
6	Month (one character) ● Digits 1 to 9 indicate January to September respectively. ● Letters A to C indicate October to December respectively.
7	Day (one character) ● Digits 1 to 9 indicate the 1st to 9th. ● Letters A to H indicate the 10th to 17th. ● Letters J to N indicate the 18th to 22nd. ● Letters P to Y indicate the 23rd to 31st.
8	Hour (one character) ● Digits 0 to 9 indicate 0:00 to 9:00. ● Letters A to H indicate 10:00 to 17:00. ● Letters J to N indicate 18:00 to 22:00. ● Letters P to Q indicate 23:00 to 24:00.
9	Serial number (two characters)
10	Manufacturing serial number (five characters)

A.1.1.3 Quick Access Label

Figure A-5 Quick access label example

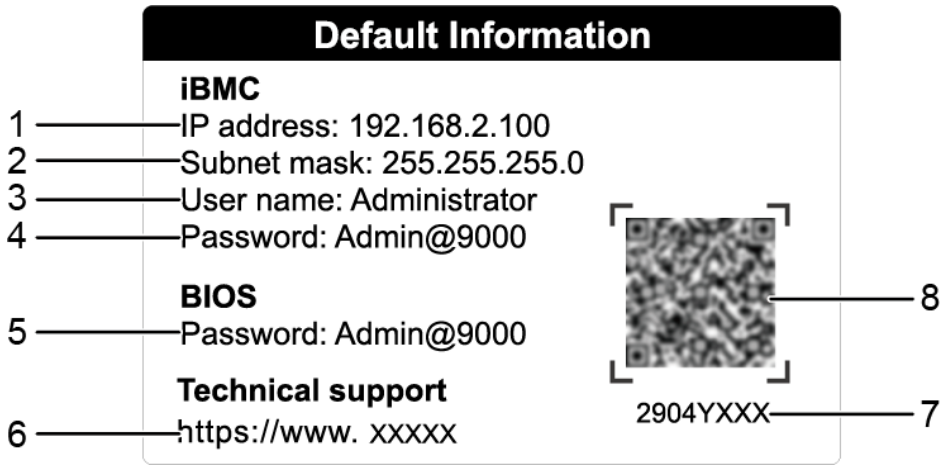
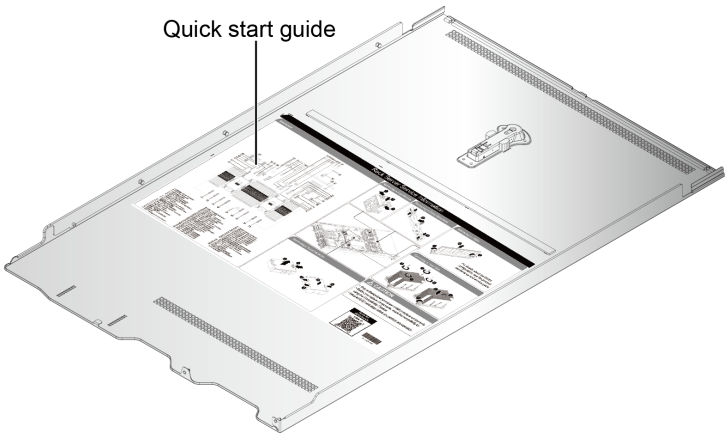


Table A-4 Quick access label description

No.	Description
1	IP address of the iBMC management network port
2	Subnet mask of the iBMC management network port
3	Default iBMC user name
4	Default iBMC password
5	Default BIOS password
6	Technical support website
7	P/N code
8	QR code **NOTE** Scan the QR code to obtain technical support resources.

A.1.2 Chassis Internal Label

Figure A-6 Chassis internal label

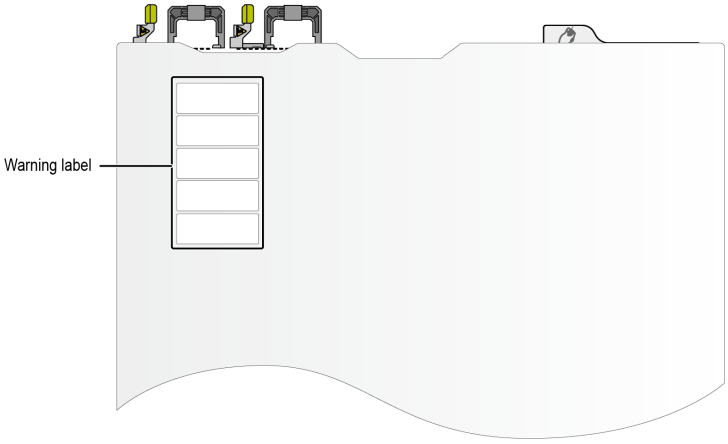


NOTE

- The quick start guide is located on the inside of the chassis cover. It describes how to remove the mainboard components, important components of the chassis, precautions, and QR codes of technical resources. The pictures are for reference only. For details, see the actual product.
- The quick start guide is optional. For details, see the actual product.

A.1.3 Chassis Tail Label

Figure A-7 Chassis tail label



NOTE

For details about the warning label, see the server *Safety Information*.

A.2 Product SN

The serial number (SN) on the label plate uniquely identifies a server. The SN is required when users contact xFusion technical support. SNs can be in three forms, as shown in **SN Sample 1**, **SN Sample 2**, and**SN Sample 3**.

- SN example 1

Figure A-8 SN example 1

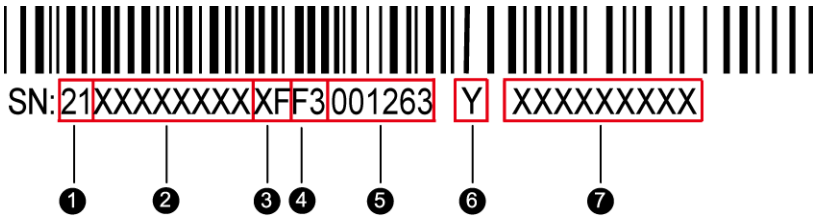


Table A-5 SN description

No.	Description
1	SN ID (two characters), which is **21**.
2	Material identification code (eight characters), that is, the processing code.
3	Vendor code (two characters), that is, the code of the processing place.

No.	Description
4	Year and month (two characters) ● The first character indicates the year. – Digits 1 to 9 indicate years 2001 to 2009 respectively. – Letters A to H indicate years 2010 to 2017 respectively. – Letters J to N indicate years 2018 to 2022 respectively. – Letters P to Y indicate years 2023 to 2032 respectively. **NOTE** The years from 2010 are represented by upper-case letters excluding I, O, and Z because the three letters are similar to the digits 1, 0, and 2. ● The second character indicates the month. – Digits 1 to 9 indicate January to September respectively. – Letters A to C indicate October to December respectively.
5	Serial number (six characters)
6	RoHS compliance status (one character). **Y** indicates RoHS compliant.
7	Internal model, that is, product name.

- SN example 2

Figure A-9 SN example 2

Table A-6 SN example 2

No.	Description
1	SN ID (two characters), which is **21**.
2	Material identification code (eight characters), that is, the processing code.
3	Vendor code (two characters), that is, the code of the processing place.

No.	Description
4	Year and month (two characters) ● The first character indicates the year. – Digits 1 to 9 indicate years 2001 to 2009 respectively. – Letters A to H indicate years 2010 to 2017 respectively. – Letters J to N indicate years 2018 to 2022 respectively. – Letters P to Y indicate years 2023 to 2032 respectively. **NOTE** The years from 2010 are represented by upper-case letters excluding I, O, and Z because the three letters are similar to the digits 1, 0, and 2. ● The second character indicates the month. – Digits 1 to 9 indicate January to September respectively. – Letters A to C indicate October to December respectively.
5	Serial number (six characters)
6	RoHS compliance status (one character). **Y** indicates RoHS compliant.
7	Product nameplate model (7 digits).
8	Serial number. The number of digits depends on the actual product.

- SN example 3

Figure A-10 Label example

Table A-7 Label example description

No.	Description
1	QR code. For details, see **Figure A-12**.
2	BOM code (10 digits).
3	Product model (13 characters).
4	Product SN (12 characters). For details, see **Table A-8**.
5	RoHS compliance code (one character).

Figure A-11 SN example

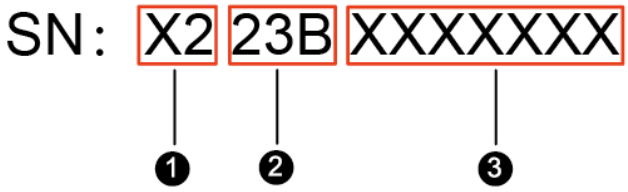


Table A-8 SN description

No.	Description
1	Manufacturer code (two characters).
2	Year and month (three characters). • The first and second characters indicate the year. **NOTE** A four-digit year is indicated by the last two digits of the year. For example, 23 indicates the year 2023. • The third character indicates the month. – Digits 1 to 9 indicate January to September respectively. – Letters A to C indicate October to December respectively.
3	Serial number (seven characters).

Figure A-12 QR code scanning result example

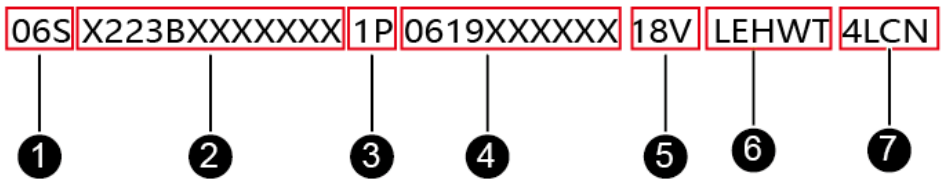


Table A-9 QR code scanning result example description

No.	Description
1	Fixed representation symbol (three characters).
2	Product SN (12 characters). For details, see **Table A-8**.
3	Data identifier for the material code (two characters).
4	BOM code (10 digits).

No.	Description
5	Data identifier of manufacturer (three characters).
6	Code of device manufacturer (five characters).
7	Data identifier of origin (four characters).

A.3 Operating Temperature Limitations

Table A-10 Configure the Genoa processor operating temperature limitations

Configuration	Maximum Operating Temperature 30℃ (86°F)	Maximum Operating Temperature 35°C (95°F)	Maximum Operating Temperature 40ºC (104°F)	Maximum Operating Temperature 45ºC (113ºF)
Chassis with 8 x 2.5" Drives	All configurations supported	All configurations supported	• GPUs are not supported • OCP 3.0 NICs with 100GE or higher speeds are not supported.	• Rear HDDs and NVMe drives are not supported. • OCP 3.0 NICs with 25GE or higher speeds are not supported. • OCP 3.0 NICs with 100GE or higher speeds are not supported. • Supercapacitors are not supported. • GPUs are not supported.

Configuration	Maximum Operating Temperature 30℃ (86°F)	Maximum Operating Temperature 35°C (95°F)	Maximum Operating Temperature 40ºC (104°F)	Maximum Operating Temperature 45ºC (113ºF)
Chassis with 12 x 3.5" drive	All configurations supported	All configurations supported	• Rear HDDs and NVMe drives are not supported. • OCP 3.0 NICs with 25GE or higher speeds are not supported. • OCP 3.0 NICs with 100GE or higher speeds are not supported. • Supercapacitors are not supported. • GPUs are not supported.	Not supported.

Configuration	Maximum Operating Temperature 30℃ (86°F)	Maximum Operating Temperature 35°C (95°F)	Maximum Operating Temperature 40ºC (104°F)	Maximum Operating Temperature 45ºC (113ºF)
24 x 2.5" drive chassis	• All configurations supported	• All configurations supported	• Rear HDDs and NVMe drives are not supported. • OCP 3.0 NICs with 25GE or higher speeds are not supported. • OCP 3.0 NICs with 100GE or higher speeds are not supported. • Supercapacitors are not supported. • GPUs are not supported.	• Not supported.

Table A-11 Limitations on configuring the Turin processor operating temperature

Configuration	Maximum Operating Temperature 30℃ (86°F)	Maximum Operating Temperature 35°C (95°F)	Maximum Operating Temperature 40ºC (104°F)	Maximum Operating Temperature 45ºC (113ºF)
Chassis with 8 x 2.5" Drives	● All configurations supported	● All configurations supported	● GPUs are not supported ● OCP 3.0 NICs with 100GE or higher speeds are not supported.	● CPUs with TDP exceeding 400 W are not supported. ● Rear HDDs and NVMe drives are not supported. ● OCP 3.0 NICs with 25GE or higher speeds are not supported. ● OCP 3.0 NICs with 100GE or higher speeds are not supported. ● Supercapacitors are not supported. ● GPUs are not supported

Configuration	Maximum Operating Temperature 30℃ (86°F)	Maximum Operating Temperature 35°C (95°F)	Maximum Operating Temperature 40ºC (104°F)	Maximum Operating Temperature 45ºC (113ºF)
Chassis with 8 x 3.5" Drives	● All configurations supported	● All configurations supported	● GPUs are not supported ● OCP 3.0 NICs with 100GE or higher speeds are not supported.	● CPUs with TDP exceeding 400 W are not supported. ● Rear HDDs and NVMe drives are not supported. ● OCP 3.0 NICs with 25GE or higher speeds are not supported. ● OCP 3.0 NICs with 100GE or higher speeds are not supported. ● Supercapacitors are not supported. ● GPUs are not supported

Configuration	Maximum Operating Temperature 30℃ (86°F)	Maximum Operating Temperature 35°C (95°F)	Maximum Operating Temperature 40ºC (104°F)	Maximum Operating Temperature 45ºC (113ºF)
8 x 3.5" drive enclosure - supporting 4 x GPU	• All configurations supported	• All configurations supported	• GPUs are not supported • OCP 3.0 NICs with 100GE or higher speeds are not supported.	• CPUs with TDP exceeding 400 W are not supported. • OCP 3.0 NICs with 25GE or higher speeds are not supported. • PCIes with 100GE or higher speeds are not supported. • Supercapacitors are not supported. • GPUs are not supported

Configuration	Maximum Operating Temperature 30℃ (86°F)	Maximum Operating Temperature 35°C (95°F)	Maximum Operating Temperature 40ºC (104°F)	Maximum Operating Temperature 45ºC (113ºF)
Chassis with 12 x 3.5" drive	• Full-length GPU cards are not supported.	• NICs with 200GE or higher speeds are not supported. • Full-length GPU cards are not supported.	• CPUs with TDP exceeding 400 W are not supported. • Rear HDDs and NVMe drives are not supported. • OCP 3.0 NICs with 25GE or higher speeds are not supported. • PCIes with 100GE or higher speeds are not supported.	• Not supported.

Configuration	Maximum Operating Temperature 30℃ (86°F)	Maximum Operating Temperature 35°C (95°F)	Maximum Operating Temperature 40ºC (104°F)	Maximum Operating Temperature 45ºC (113ºF)
			• Supercapacitors are not supported. • GPUs are not supported	

NOTE

- When a single fan is faulty, the highest operating temperature is 5°C (41°F) lower than the rated value.
- When a single fan is faulty, the system performance may be affected.
- It is recommended that servers be deployed at an interval of 1U to reduce server noise and improve server energy efficiency.
- Liquid-cooled processors are not supported.

A.4 Nameplate

Certified Model	Remarks
2158H V8	Global

A.5 Names and Content of Hazardous Substances

Table A-12 Names and Content of Hazardous Substances

Component		PCBA	Cables	Metal parts
Hazardous	Pb	X	X	X
	Hg	O	O	O

Substances	**Cd**	O	O	O
	Cr(VI)	O	O	O
	PBBS	O	O	O
	PBDES	O	O	O
	DBP	O	O	O
	DIBP	O	O	O
	BBP	O	O	O
	DEHP	O	O	O

- Note 1:
  - O: Indicate that the content of the hazardous substance contained in all of the homogenous materials in the component is within the limits of the national standard for hazardous substances in electric and electronic products.
  - X: Indicate that the content of the hazardous substance contained in at least one homogenous material exceeds the limits of the national standard for hazardous substances in electric and electronic products.
- Note 2: For components not listed above, their hazardous substance content is within the limits of national standard of hazardous substances in electrical and electronic products.

A.6 Sensor List

Sensor	Description	Component
1711 Core Temp	Core temperature of the 1711 chip	BMC card
ACPI State	ACPI status	N/A
BMC Boot Up	BMC startup event	N/A
BMC Time Hopping	Time hopping	N/A
Boot Error	Boot error	N/A
CPU Power	Power consumption of CPU 1 when the server is powered on (available only for custom model)	N/A
CPU Usage	CPU usage	N/A

Sensor	Description	Component
CPU VRD 5V	The 5 V voltage supplied by the mainboard to the components around the CPU	Mainboard
CPU1 1.8V	12 V voltage that the mainboard supplies to CPU1	Mainboard
CPU1 12V	12 V voltage that the mainboard supplies to CPU1	CPU
CPU1 12V	12 V voltage that the mainboard supplies to CPU1	CPU
CPU1 Core Temp	CPU core temperature	CPU
CPU1 MEM Temp	Temperature of DIMMs mapping to a CPU	CPU
CPU1 Memory	Memory module status	CPU
CPU1 Prochot	CPU Prochot	CPU
CPU1 Status	CPU status detection	CPU
CPU1 VDD11 S3	PSU voltage of CPU1 DRAM IO port	CPU
CPU1 VDDCR SOC	Power supply voltage of CPU1 FCH/Ethernet/ SATA, NBIO, SMU, and DDR	CPU
CPU1 VDDCR0	Core voltage on the notched side at the top of CPU1	CPU
CPU1 VDDCR1	Core voltage on the other notched side at the top of CPU1	CPU
CPU1 VDDIO	Power supply voltage of CPU1 DRAM IO port	CPU
CPU1 VRD Temp	CPU VRD temperature	CPU
Critical INT	PCIe bus error status	N/A
DIMM000	DIMM status	DIMM 000
DIMM010	DIMM status	DIMM 010
DIMM020	DIMM status	DIMM 020

Sensor	Description	Component
DIMM030	DIMM status	DIMM 030
DIMM040	DIMM status	DIMM 040
DIMM050	DIMM status	DIMM 050
DIMM060	DIMM status	DIMM 060
DIMM070	DIMM status	DIMM 070
DIMM080	DIMM status	DIMM 080
DIMM090	DIMM status	DIMM 090
DIMM0A0	DIMM status	DIMM 0A0
DIMM0B0	DIMM status	DIMM 0B0
Disk BP$ Power	Total power of the drive backplane	Drive backplane
Disk BP$ Temp	Drive backplane temperature	Drive backplane
DISK$	Drive status	Drive
Disks Temp	Maximum drive temperature	Drive
FAN 12V	12 V voltage supplied by the mainboard to the fan board	Mainboard
FAN Power	Total memory power consumption when the server is powered on (available only for custom model)	Fan module
FAN1 F Speed	Fan speed	Fan module *1*
FAN1 Presence	Fan presence	Fan module *1*
FAN1 R Speed	Fan speed	Fan module *1*
FAN1 Status	Fan fault status	Fan module *1*
FAN2 F Speed	Fan speed	Fan module *2*
FAN2 Presence	Fan presence	Fan module *2*
FAN2 R Speed	Fan speed	Fan module *2*
FAN2 Status	Fan fault status	Fan module *2*
FAN3 F Speed	Fan speed	Fan module *3*
FAN3 Presence	Fan presence	Fan module *3*

Sensor	Description	Component
FAN3 R Speed	Fan speed	Fan module *3*
FAN3 Status	Fan fault status	Fan module *3*
FAN4 F Speed	Fan speed	Fan module *4*
FAN4 Presence	Fan presence	Fan module *4*
FAN4 R Speed	Fan speed	Fan module *4*
FAN4 Status	Fan fault status	Fan module *4*
FAN5 F Speed	Fan speed	Fan Module 5
FAN5 Presence	Fan presence	Fan Module 5
FAN5 R Speed	Fan speed	Fan Module 5
FAN5 Status	Fan fault status	Fan Module 5
FAN6 F Speed	Fan speed	Fan Module 6
FAN6 Presence	Fan presence	Fan Module 6
FAN6 R Speed	Fan speed	Fan Module 6
FAN6 Status	Fan fault status	Fan Module 6
GPU$ LIMIT Temp	GPULIMIT card temperature	GPU
GPU$ Power	GPU power	GPU
GPU$ Temp	GPU temperature	GPU
HDD BP Status	Drive backplane health status	Drive backplane
Disk Power	Total power consumption of product drives	Drive
IB$ Temp	IB NIC temperature	IB card
Inlet Temp	Air inlet temperature	Right mounting ear
IO STBY 3.3V	I/O board standby 3.3 V voltage	I/O board
IO STBY 5V	I/O board standby 5V voltage	I/O board
IO VCC 12V	I/O board 12V voltage	I/O board
IO VCC 3.3V	3.3 V voltage supplied by the mainboard to the riser card	I/O board

Sensor	Description	Component
M2 Adapter Temp	M.2 adapter card temperature	M.2 riser card
M2 Temp0(PCIe$)	M.2 drive temperature	M.2 drive
M2 Temp1(PCIe$)	M.2 drive temperature	M.2 drive
MEM Power	Total memory power consumption when the server is powered on (available only for custom model)	N/A
Memory Usage	Memory usage	N/A
Mngmnt Health	Management subsystem health status	Management module
NTP Sync Failed	NTP synchronization failure and recovery events	N/A
OCP$ OP Temp	OCP card optical module temperature	OCP 3.0 NIC
OCP$ Temp	OCP card chip temperature	OCP 3.0 NIC
Outlet Temp	Air outlet temperature	BMC card
P4GPU$ Temp	GPU temperature	GPU
PCIe FC$ Temp	PCIe card chip temperature	PCIe card
PCIe NIC$ Temp	PCIe card chip temperature	PCIe card
PCIe RAID$ Temp	PCIe RAID controller card temperature	PCIe RAID controller card
PCIE Status	Incorrect PCIe status	PCIe card
PCIe$ Card BBU	BBU of the screw-in RAID controller card	PCIe RAID controller card
PCIe$ OP Temp	PCIe card optical module temperature	PCIe card
PCIe$ Temp	PCIe card chip temperature	PCIe card
Power Button	Power button pressed	Mainboard and power button
Power1	Power 1 input power	PSU 1

Sensor	Description	Component
Power2	PSU input power	PSU 2
ProductID Status	Product identification status	N/A
PS Redundancy	Redundancy failure due to PSU removal	PSU
PS$ Fan Status	PSU fan fault status	PSU
PS$ IIn	PSU input current	PSU
PS$ Inlet Temp	PSU air inlet temperature	PSU
PS$ Iout	Single Supply Input Current	PSU
PS$ POut	Single PSU output power	PSU
PS$ Status	Single PSU fault status	PSU
PS$ Temp	Maximum internal temperature of the PSU	PSU
PS$ VIN	Single PSU input voltage	PSU
PwrOk Sig. Drop	Voltage dip status	Mainboard
PwrOn TimeOut	Power-on timeout	Mainboard
Raid$ BBU Temp	Temperature of the RAID controller card backup PSUs	RAID controller card
Riser 12V	12 V voltage supplied by the mainboard to the riser card	Mainboard
Riser 3.3V	3.3 V voltage supplied by the mainboard to the riser card	Mainboard
Riser$ 12V	12 V voltage supplied by the mainboard to the riser card	Mainboard
Riser$ Temp	Riser card temperature	Riser card
RTC Battery	RTC battery status. An alarm is generated when the voltage is lower than 1 V.	RTC battery on the mainboard
SEL Status	SEL full or events being cleared	N/A

Sensor	Description	Component
SNIC 12V	The 12V voltage supplied by the I/O Board to the DPU card	I/O board
SNIC$ Power	DPU power	Intelligent NICs
SSD Disk$ Temp	SSD temperature	SSD
SSD Max Temp	Maximum SSD temperature (reported by BMA)	SSD
SSD$ Temp	SSD card temperature	SSD
STBY 1.8V	Mainboard standby 1.8 V voltage	Mainboard
STBY 12V	I/O board standby 12V voltage	I/O board
STBY 5V	Mainboard standby 5 V voltage	Mainboard
SYS 3.3V	The 3.3 V voltage supplied by the mainboard to the CLK BUFFER	Mainboard
SysFWProgress	Software processes and system startup errors	N/A
SysRestart	System restart causes	N/A
System Error	System suspension or restart. Check the background logs.	N/A
System Notice	Hot restart reminder and fault diagnosis program information collection	N/A
Total Power	Total PSU input power	PSU
UID Button	UID button status	Mainboard
Watchdog2	Watchdog	Mainboard

B Glossary

B.1 A-E

B

BMC	The baseboard management controller (BMC) complies with the Intelligent Platform Management Interface (IPMI). It collects, processes, and stores sensor signals, and monitors the operating status of components. The BMC provides the hardware status and alarm information about the managed objects to the management system so that the management system can implement unified management of the devices.

E

ejector lever	A part on the panel of a device used to facilitate installation or removal of the device.
Ethernet	A baseband local area network (LAN) architecture developed by Xerox Corporation by partnering with Intel and DEC. Ethernet uses the Carrier Sense Multiple Access/Collision Detection (CSMA/CD) access method and allows data transfer over various cables at 10 Mbit/s. The Ethernet specification is the basis for the IEEE 802.3 standard.

B.2 F-J

G

Gigabit Ethernet (GE)	An extension and enhancement of traditional shared media Ethernet standards. It is compatible with 10 Mbit/s and 100 Mbit/s Ethernet and complies with IEEE 802.3z standards.

H

hot swap	Replacing or adding components without stopping or shutting down the system.

B.3 K-O

K

KVM	A hardware device that provides public keyboard, video and mouse (KVM).

B.4 P-T

P

panel	An external component (including but not limited to ejector levers, indicators, and ports) on the front or rear of the server. It seals the front and rear of the chassis to ensure optimal ventilation and electromagnetic compatibility (EMC).
Peripheral Component Interconnect Express (PCIe)	A computer bus PCI, which uses the existing PCI programming concepts and communication standards, but builds a faster serial communication system. Intel is the main sponsor for PCIe. PCIe is used only for internal interconnection. A PCI system can be transformed to a PCIe system by modifying the physical layer instead of software. PCIe delivers a faster speed and can replace almost all AGP and PCI buses.

R

redundancy	A mechanism that allows a backup device to automatically take over services from a faulty device to ensure uninterrupted running of the system.
redundant array of independent disks (RAID)	A storage technology that combines multiple physical drives into a logical unit for the purposes of data redundancy and performance improvement.

S

server	A special computer that provides services for clients over a network.
Standby 12V Out (SV12)	Standby 12V output of the PSU.
system event log (SEL)	Event records stored in the system used for subsequent fault diagnosis and system recovery.

B.5 U-Z

U

U	A unit defined in International Electrotechnical Commission (IEC) 60297-1 to measure the height of a cabinet, chassis, or subrack. 1U = 44.45 mm (1.75 in).
UltraPath Interconnect (UPI)	A point-to-point processor interconnect developed by Intel.

B.6 U-Z (AMD)

U

U	A unit defined in International Electrotechnical Commission (IEC) 60297-1 to measure the height of a cabinet, chassis, or subrack. 1U = 44.45 mm (1.75 in).

C Acronyms and Abbreviations

C.1 A-E

A

AC	alternating current
AES	Advanced Encryption Standard New Instruction Set
ARP	Address Resolution Protocol
AVX	Advanced Vector Extensions

B

BBU	backup battery unit
BIOS	Basic Input/Output System
BMC	baseboard management controller

C

CCC	China Compulsory Certification
CD	calendar day
CE	Conformite Europeenne
CIM	Common Information Model
CLI	command-line interface

D

DC	direct current
DDR5	Double Data Rate 5
DDDC	double device data correction
DEMT	Dynamic Energy Management Technology
DIMM	dual in-line memory module
DRAM	dynamic random-access memory
DVD	digital video disc

E

ECC	error checking and correcting
ECMA	European Computer Manufacturer Association
EDB	Execute Disable Bit
EID	enclosure ID
EN	European Efficiency
ERP	enterprise resource planning
ETS	European Telecommunication Standards

C.2 F-J

F

FB-DIMM	Fully Buffered DIMM
FC	Fiber Channel
FCC	Federal Communications Commission
FCoE	Fibre Channel over Ethernet
FTP	File Transfer Protocol

G

GE	Gigabit Ethernet

GPIO	General Purpose Input/Output
GPU	graphics processing unit

H

HA	high availability
HBM	high bandwidth memory
HDD	hard disk drive
HPC	high-performance computing
HTTP	Hypertext Transfer Protocol
HTTPS	Hypertext Transfer Protocol Secure

I

iBMC	intelligent baseboard management controller
IC	Industry Canada
ICMP	Internet Control Message Protocol
IDC	Internet Data Center
IEC	International Electrotechnical Commission
IEEE	Institute of Electrical and Electronics Engineers
IGMP	Internet Group Message Protocol
IOPS	input/output operations per second
IP	Internet Protocol
IPC	Intelligent Power Capability
IPMB	Intelligent Platform Management Bus
IPMI	Intelligent Platform Management Interface

C.3 K-O

K

KVM	keyboard, video, and mouse

L

LC	Lucent Connector
LRDIMM	load-reduced dual in-line memory module
LED	light emitting diode
LOM	LAN on motherboard

M

MAC	media access control
MMC	module management controller

N

NBD	next business day
NC-SI	Network Controller Sideband Interface

O

OCP	Open Compute Project

C.4 P-T

P

PCIe	Peripheral Component Interconnect Express
PDU	power distribution unit
PHY	physical layer
PMBUS	power management bus
POK	Power OK
PWM	pulse-width modulation
PXE	Preboot Execution Environment

R

RAID	redundant array of independent disks
RAS	reliability, availability and serviceability
RDIMM	registered dual in-line memory module
REACH	Registration Evaluation and Authorization of Chemicals
RJ45	registered jack 45
RoHS	Restriction of the Use of Certain Hazardous Substances in Electrical and Electronic Equipment

S

SAS	Serial Attached Small Computer System Interface
SATA	Serial Advanced Technology Attachment
SCM	supply chain management
SDDC	single device data correction
SERDES	serializer/deserializer
SGMII	serial gigabit media independent interface
SMI	serial management interface
SMTP	Simple Mail Transfer Protocol
SNMP	Simple Network Management Protocol
SOL	serial over LAN
SONCAP	Standards Organization of Nigeria-Conformity Assessment Program
SSD	solid-state drive
SSE	Streaming SIMD Extension

T

TACH	tachometer signal
TBT	Turbo Boost Technology
TCG	Trusted Computing Group
TCM	trusted cryptography module
TCO	total cost of ownership

TDP	thermal design power
TELNET	Telecommunication Network Protocol
TET	Trusted Execution Technology
TFM	TransFlash module
TFTP	Trivial File Transfer Protocol
TOE	TCP offload engine
TPM	trusted platform module

C.5 U-Z

U

UBC	Union Bus Connector
UBC DD	Union Bus Connector Double Density
UDIMM	unbuffered dual in-line memory module
UEFI	Unified Extensible Firmware Interface
UID	unit identification light
UL	Underwriter Laboratories Inc.
UPI	UltraPath Interconnect
USB	Universal Serial Bus

V

VCCI	Voluntary Control Council for Interference by Information Technology Equipment
VGA	Video Graphics Array
VLAN	virtual local area network
VRD	voltage regulator-down
VROC	Virtual RAID on CPU

W

WEEE	waste electrical and electronic equipment

WSMAN	Web Service Management

C.6 U-Z (AMD)

U

UBC	Union Bus Connector
UBC DD	Union Bus Connector Double Density
UDIMM	unbuffered dual in-line memory module
UEFI	Unified Extensible Firmware Interface
UID	unit identification light
UL	Underwriter Laboratories Inc.
UPI	UltraPath Interconnect
USB	Universal Serial Bus

V

VCCI	Voluntary Control Council for Interference by Information Technology Equipment
VGA	Video Graphics Array
VLAN	virtual local area network
VRD	voltage regulator-down

W

WEEE	waste electrical and electronic equipment
WSMAN	Web Service Management

